



# VSC8641

## 10/100/1000BASE-T PHY with RGMII and GMII MAC Interface

### Datasheet

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VMDS-10211

Revision 4.3

August 2009

Vitesse  
Corporate Headquarters  
741 Calle Plano  
Camarillo, California 93012  
United States

[www.vitesse.com](http://www.vitesse.com)

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# Revision History

This section describes the changes that were implemented in this document. The changes are listed by revision, starting with the most current publication.

## Revision 4.3

Revision 4.3 of this datasheet was published in August 2009. The following is a summary of the changes implemented in the datasheet:

- VSC8641XJF device information was added.
- Three design considerations were added:

**Voltage Overshoot When Using On-Chip Switching Regulator** The device's on-chip switching regulator generates notable voltage overshoot, which may lead to device performance issues such as CRC errors, jitter, or both.

**Long Link-Up Times Caused by Noise on the Twisted Pair Interface** Normally, the VSC8641 device successfully links during auto-negotiation when there is signal noise coming from the link partner. However, on rare occasions when the VSC8641 device uses the same cable as the link partner, the link-up time can be significantly increased for successful auto-negotiation.

**High VDD33 and Low VDDIOMAC Supply** If VDD33 is set to the maximum allowed 3.3 V supply and VDDIOMAC is set to the minimum allowed 3.3 V supply, the VSC8641 device can experience performance issues.

For more information about the design considerations and their workarounds, see ["Design Considerations,"](#) page 118.

## Revision 4.2

Revision 4.2 of this datasheet was published in May 2008. The following is a summary of the changes implemented in the datasheet:

- The delay setting for register 23, bit 8 was corrected from 2 ns to 1.7 ns. Additionally, the RGMII clock skew function was updated to clarify that CMODE pin 2, bit 1, and 0 will set both register 23, bit 8 and register 28E, bits 15:12.
- A note was added to the serial management interface pin descriptions to clarify that the NRESET pin is referenced to VDD33. Additionally, referenced VDD33 pins OSCEN, PLLMODE, REG\_EN, and REF\_CLK were added to the pin identifications.
- Four design guidelines were added to the design considerations:

**Default 10Base-T Settings are Marginal and Cause MAU Test Failure** The default settings are marginal for PHY silicon and magnetic module variations and may cause the output 10Base-T signal to violate the IEEE waveform template.

**On-Chip Pull-up Resistor Violation** An on-chip pull-up resistor included on the

VSC8641 device violates IEEE specification 802.3. The VSC8641 requires an off-chip and an on-chip pull-up resistor for the interface to work properly.

**Setting the Internal RGMII Timing Compensation Value** There are two inter-related registers that control the internal RGMII skew timing compensation in which register 23.8 can potentially overwrite register 28E.

**10BASE-T Harmonics at 30 MHz and 50 MHz Marginally Violates Specification** The IEEE 802.3 specification states that in 10BASE-T mode, when the DO circuit is driven by an all-ones, Manchester-encoded signal, any harmonic measured on the TD circuit must be at least 27 dB below the fundamental. In VSC8641, this specification is marginally violated at 30 MHz and 50 MHz when this measurement is made under corner conditions.

## Revision 4.1

Revision 4.1 of this datasheet was published in July 2007. The following is a summary of the changes implemented in the datasheet:

- VSC8641-03 is now available. It has an extended operating temperature range of –40 °C ambient to 90 °C case.
- A design guideline was added regarding delays in the link-up process while in the forced 100BASE-TX mode with the automatic crossover detection feature enabled.
- The following design guidelines were removed, because they no longer apply to the device: Remote Fault Status; DSP Optimization Script Required; Default Port Type Incorrect; and Core 1.2 V Supply Needs to Meet Specific Range.

## Revision 4.0

Revision 4.0 of this datasheet was published in December 2006. The following is a summary of the changes implemented in the datasheet:

- The VSC8641KO package was removed from the datasheet. VSC8641XKO remains available.
- In the jumbo packet register settings (28E.11:10), the packet lengths were updated.
- In several current consumption specifications, the values for total power at 2.5 V were corrected. The previous values were slightly elevated.
- In the DC characteristics for  $V_{DDIO}$  at 3.3 V, both the input and output leakage current parameters ( $I_{ILEAK}$  and  $I_{OLEAK}$ ) were increased from  $\pm 36 \mu A$  to  $\pm 43 \mu A$ .
- In the DC characteristics for  $V_{DDIO}$  at 2.5 V, the minimum input high voltage ( $V_{IH}$ ) was increased from 1.7 V to 2.0 V for all pins, except for GMII input pins, which remain at 1.7 V minimum. Both the input and output leakage current parameters ( $I_{ILEAK}$  and  $I_{OLEAK}$ ) were increased from  $\pm 25 \mu A$  to  $\pm 35 \mu A$ .
- Current consumption specifications were added for both the power-down mode and the reset state.

- In the AC characteristics for the CLKOUT pin, the duty cycle (%<sub>DUTY</sub>) was modified from 40% minimum to 44% minimum and from 60% maximum to 56% maximum. Also, the total jitter ( $J_{CLK}$ ) was raised from 491 ps maximum to 600 ps maximum, with the qualifier “time interval error” added to the condition.
- In the SMI specifications, the MDC rise and fall times were corrected from minimum values to maximum values.
- For the device reset rise time specification, a condition was added that it is measured from a 10% level to a 90% level.
- In the AC characteristics for RGMII uncompensated, the 1000BASE-T duty cycle ( $t_{DUTY1000}$ ) was separated into two sets of values. In the first set, the values remain the same, but the added condition is: at room temperature and nominal supply and register 28E.13:12 set to 10 or 11. In the second set, the minimum is 40% and the maximum is 60% and the condition is: register 28E.13:12 set to 00 or 01.
- In the AC characteristics for RGMII compensated, all of the setup and hold times were modified from 0 ns to 3 ns.
- The electrostatic discharge voltage values were added. For charged device model, it is  $\pm 500$  V. For human body model, it is  $\pm 1750$  V.
- In the description of pin MDIO, the type was corrected from open drain (OD) to input and output (I/O).
- The PLLMODE pin description was updated with additional clocking information. If a crystal or an external 25 MHz clock is used, PLLMODE must be pulled low. If an external 125 MHz clock is used, PLLMODE must be pulled high.
- The moisture sensitivity is now specified as level 3.
- A design guideline was added regarding writes from the serial management interface (SMI) after a software reset.

## Revision 2.3

Revision 2.3 of this datasheet was published in July 2006. The following is a summary of the changes implemented in the datasheet:

- In the inline powered Ethernet switch diagram, a reference to “SGMII interface” was corrected to “RGMII interface.”
- In the description of CRC counters, the CRC good counter's highest value was corrected from 10,000 to 9,999 packets, after which the counter clears.
- The device revision number definition was updated from 0000 to 0001 in the identifier 2 register (address 3) and the JTAG device identification.
- In the DC Characteristics for  $V_{DD33}$ ,  $V_{DDIOMAC}$ , or  $V_{DDIOMICRO}$  at 3.3 V, the output leakage ( $I_{OLEAK}$ ) was changed to match the same values as the input leakage ( $I_{ILEAK}$ ) with the same condition (internal resistor included). Specifically, the values were changed from  $-10$   $\mu$ A minimum and 10  $\mu$ A maximum to  $-36$   $\mu$ A minimum and 36  $\mu$ A maximum.

- In the DC Characteristics for  $V_{DDIOMAC}$  or  $V_{DDIOMICRO}$  at 2.5 V, the output leakage ( $I_{OLEAK}$ ) was changed to match the same values as the input leakage ( $I_{ILEAK}$ ) with the same condition (internal resistor included). Specifically, the values were changed from  $-10\ \mu A$  minimum and  $10\ \mu A$  maximum to  $-25\ \mu A$  minimum and  $25\ \mu A$  maximum.
- In the DC characteristics for  $V_{DDIOMAC}$  or  $V_{DDIOMICRO}$  at 2.5 V, the output high voltage parameter ( $V_{OH}$ ) incorrectly stated  $I_{OH} = 1.0\ mA$  as a condition. It is now corrected to the condition  $I_{OH} = -1.0\ mA$ .
- For all the current consumption specifications with the on-chip switching regulator enabled, the specification values for  $I_{VDD12}$  and  $I_{VDD12A}$  were removed because they were inadvertently added in a prior revision of this document. The  $I_{VDD12}$  and  $I_{VDD12A}$  values are kept for current consumption with the regulator disabled.
- For the 100BASE current consumption specifications, all references to the speed were corrected from 100BASE-X to 100BASE-TX.
- In the AC characteristics for the CLKOUT pin, the total jitter specifications were added. They are 217 ps typical and 491 ps maximum.
- For device reset, both the reset characteristics and timing diagram were updated to include new parameters: reset rise time ( $t_{RST\_RISE}$ ) and supply stable time ( $t_{VDDSTABLE}$ ).
- The MII transmit timing figure was updated to be more accurate and to imply when the MAC must display valid data to the VSC8641.
- In the stress ratings, the power supply voltage parameter was removed because it was redundant.
- In the pin description for TX\_CLK, the rate was clarified to be 2.5 MHz for 10 Mbps mode, 25 MHz for 100 Mbps mode, or 125 MHz for 1000 Mbps mode.
- The errata item "RX\_CLK Can Reach as High as 55% Duty Cycle" remains in effect but all other errata items no longer apply to the latest part revision.

## Revision 2.2

Revision 2.2 of this datasheet was published in March 2006. In revision 2.2 of the document, in the list of GMII/RGMII MAC interface pins, two pin numbers were corrected. The pin number for NSRESET was corrected from 32 to 50. The pin number for OSCEN/CLKOUT was corrected from 43 to 66.

## Revision 2.1

Revision 2.1 of this datasheet was published in February 2006. The following is a summary of the changes implemented in the datasheet:

- In the high-level block diagram, representation of the XTAL pin was corrected from "XTAL 1/2" to "XTAL1" and "XTAL2."
- New information was added about how to manually force the device to use MDI/MDI-X.

- The VSC8641 device switches between the low-power state and LP wake-up state every two seconds; the rate is not programmable, as was originally stated.
- In the link partner wake-up state, the device sends FLP bursts for two seconds; they are not limited to three bursts, as was originally stated.
- In the description of the PHY address for the serial management interface (SMI), a statement was removed that bits 2:0 represent the PHY of the device being addressed.
- For the enhanced LED method, controlled by MII Register 16E, two of the LED modes have changed. Mode 11, TX activity, and mode 13, RX activity, are now both reserved.
- In the description of the far-end loopback testing feature, the controlling register bit was corrected from 23.3 to 27E.10.
- For the JTAG interface instructions EXTEST and SAMPLE/PRELOAD, the values for register width were modified from TBD to 69.
- For the Mode Control register (address 0), when bit 11 (power-down) is set, RGMII in-band signaling will not function.
- In the Identifier 2 register (address 3), which enables device identification, the default for bits 9:4 was modified from TBD to 000011.
- In the LED Control register (address 27), the name for bits 2 and 1 was corrected from "link/activity" to simply "activity."
- In the ActiPHY Control (address 20E), bit 5 was reassigned from being reserved to being the MAC RX\_CLK disable parameter.
- In the Extended PHY Control 5 register (address 27E), the settings have changed for bits 8:6 and 5:3 (100BASE-TX and 1000BASE-T transmitter amplitude control). For bits 8:6 (100BASE-TX), the setting 011 changed from +5 amplitude to reserved, making bit setting 010 (+4 amplitude) the largest. For bits 5:3 (1000BASE-T), the setting 011 changed from +3 amplitude to reserved, making bit setting 010 (+2 amplitude) the largest.
- For added clarity, the table that lists device functions and related CMODE pins now references the associated register and bit for each function.
- For the EEPROM Configuration Contents table, some address locations were added and the introductory text was corrected.
- For the DC electrical specifications with VDDIO at 3.3 V and with VDDIO at 2.5 V, an additional condition was added. The specifications may be considered valid only when VDDREG = 3.3 V.
- The current consumption specifications were replaced with a new set of specifications.
- In the recommended operating conditions, the minimum and maximum values were modified for the VDDIOMICRO, VDDIOMAC, and VDD33 parameters at 3.3 V. For all of these parameters, the minimum changed from 3.13 V to 3.0 V and the maximum changed from 3.47 V to 3.6 V. The VDDREG parameter was added to the recommended operating conditions.

- In the stress ratings, a new rating was added for the VDDREG parameter.
- In the section describing the device pins associated with the GMII/RGMII MAC interface, the term “GMII” was missing. It is now included in the heading and throughout this section.
- In the ordering information, the pin count was corrected from 64 pins to 100 pins.
- An errata section was added.

## **Revision 2.0**

Revision 2.0 of this datasheet was published in December 2005. This was the first publication of the document.

# 1 Introduction

This document consists of descriptions and specifications for both functional and physical aspects of the VSC8641 device.

In addition to the datasheet, Vitesse maintains an extensive device-specific library of support and collateral materials that you may find useful in developing your own product. Depending upon the Vitesse device, this library may include:

- Software Development Kits with sample commands and scripts
- Reference designs showing the Vitesse device built in to applications in ways intended to exploit its relative strengths
- Presentations highlighting the operational features and specifications of the device to assist in developing your own product road map
- Input/Output Buffer Information specification (IBIS) models to help you create and support the interfaces available on the particular Vitesse product
- Application notes that provide detailed descriptions of the use of the particular Vitesse product to solve real-world problems
- White papers published by industry experts that provide ancillary and background information useful in developing products that take full advantage of Vitesse product designs and capabilities
- User guides that describe specific techniques for interfacing to the particular Vitesse products

Visit and register as a user on the Vitesse Web site to keep abreast of the latest innovations from research and development teams and the most current product and application documentation. The address of the Vitesse Web site is [www.vitesse.com](http://www.vitesse.com).

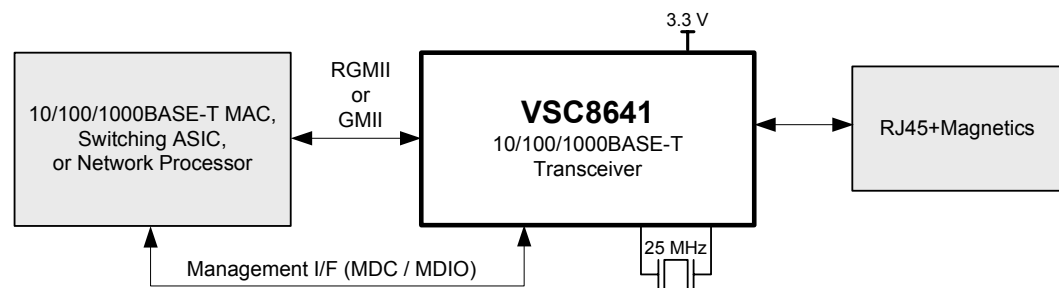
## 2 Product Overview

The VSC8641 device is a low-power Gigabit Ethernet (GbE) transceiver ideal for Gigabit LAN-on-Motherboard applications. The device's compact, plastic low-profile quad flat package (LQFP) or quad flat no-lead (QFN) package with an exposed pad is optimal for footprint-sensitive applications.

Vitesse's mixed signal and digital signal processing (DSP) architecture assures robust performance. It supports both half-duplex and full-duplex 10BASE-T, 100BASE-TX, and 1000BASE-T communication speeds over Category 5 (Cat5) unshielded twisted pair (UTP) cable at distances greater than 140 m, displaying excellent tolerance to NEXT, FEXT, echo, and other types of ambient environment and system electronic noise.

The following illustration shows a high-level, generic view of a VSC8641 application.

**Figure 1. Typical Application**



### 2.1 Features

This section lists key aspects of the VSC8641 device functionality and design that distinguish it from similar products:

- 10/100/1000BASE-T PHY with industry's lowest power consumption.
- Compliant with IEEE 802.3 (10BASE-T, 100BASE-TX, 1000BASE-T) specifications.
- Supports RGMII versions 1.3 and 2.0 and GMII/MII (2.5 V, 3.3 V) MAC interfaces.
- Low EMI line driver with integrated line side termination resistors.
- Up to 16 kB jumbo frame support in all speeds.
- Four programmable direct drive LEDs.
- Suite of test modes, including loopback paths, Ethernet packet generators, and CRC counters.
- The VeriPHY<sup>®</sup> suite provides extensive network cable information such as cable length, termination status, and open/short fault location.
- ActiPHY<sup>™</sup> power saving modes.
- Advanced power management complies with Wake-on-LAN<sup>™</sup> and PCI2.2 power requirements.

- Legacy Power-over-Ethernet (POE) support.
- Powered by a single 3.3 V supply by using the optional on-chip switching regulator.
- IEEE 1149.1 JTAG boundary-scan support.
- 10 mm × 10 mm, 88-pin, plastic QFN package with an exposed pad.
- 12 mm × 12 mm, 100-pin, plastic LQFP package with an exposed pad.

## 2.2 Applications

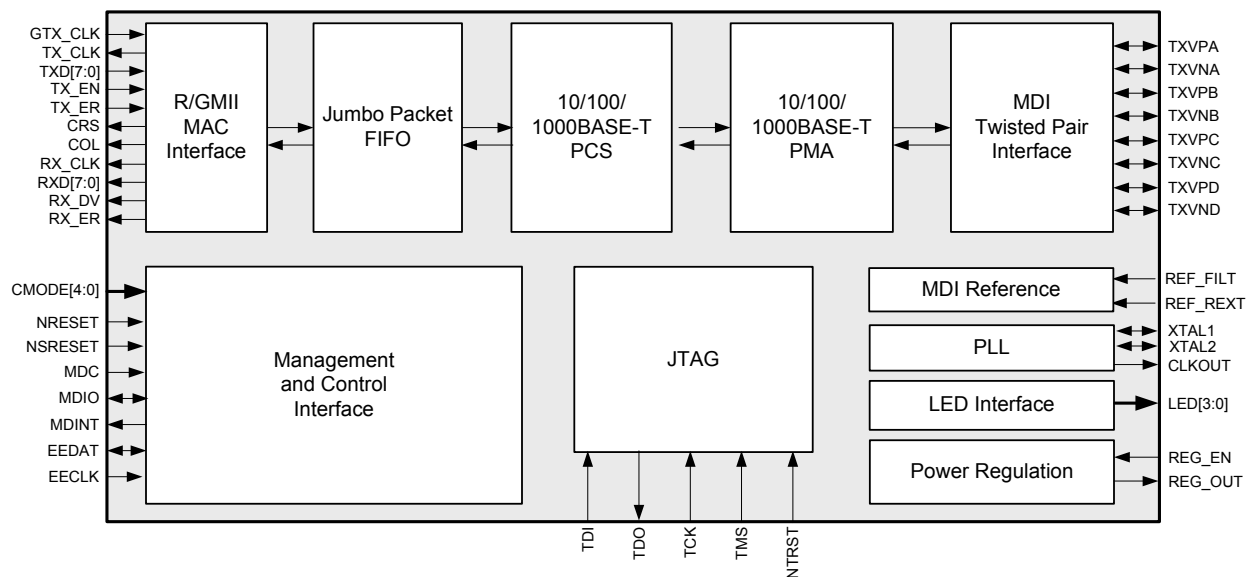
Suggested applications for the VSC8641 device include:

- LAN-on-Motherboards, NICs, and mobile PCs
- iSCSI and TOE applications
- Workgroup and desktop switches and routers
- Gigabit Ethernet SAN, NAS, and MAN systems
- Network-enabled devices such as printers, IP phones, and gaming appliances
- ATCA™ 3.0 and PICMG™ 2.16 Ethernet backplane applications

## 2.3 Block Diagram

The following illustration shows the primary functional blocks of the VSC8641 device.

**Figure 2. High-level Block Diagram**



## 3 Functional Descriptions

This section provides detailed information about how the VSC8641 device works, what configurations and operational features are available, and how to test its functions. It includes descriptions of the various device interfaces and how to set them up.

### 3.1 Operating Modes

The following table and illustration show the device operating modes and supported media.

**Table 1. Operating Modes**

| Operating Mode | MAC Interface | Supported Media   |
|----------------|---------------|-------------------|
| RGMII — Cat5   | RGMII         | 10/100/1000BASE-T |
| GMII — Cat5    | GMII / MII    | 10/100/1000BASE-T |

**Figure 3. RGMII or GMII to Cat5 Block Diagram**



### 3.2 MAC Interface

The VSC8641 supports RGMII versions 1.3 and 2.0 and GMII/MII (2.5 V, 3.3 V) MAC interfaces.

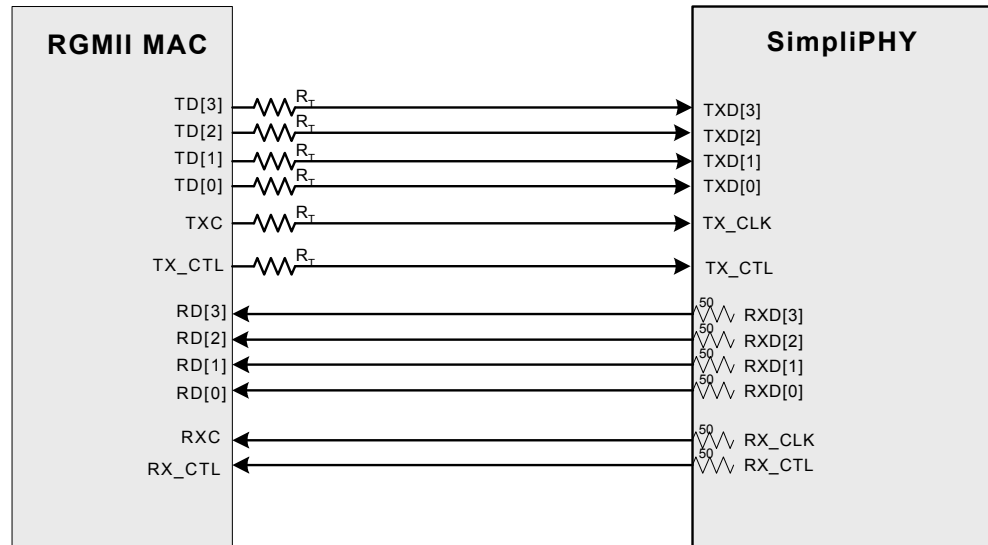
#### 3.2.1 MAC Resistor Calibration

To simplify board design, the VSC8641 MAC interface uses SimpliPIN™ outputs that can self-calibrate to a desired impedance characteristic to eliminate the need for series termination resistors. By default, these RX output pins calibrate to 50 Ω. In addition, MII Register 19E, bits 15:14 can be used to select different target impedances. For more information, see ["MAC Resistor Calibration Control,"](#) page 62.

#### 3.2.2 RGMII MAC Interface Mode

The RGMII interface can support all three speeds (10 Mbps, 100 Mbps, and 1000 Mbps) and is used as an interface to an RGMII-compatible MAC.

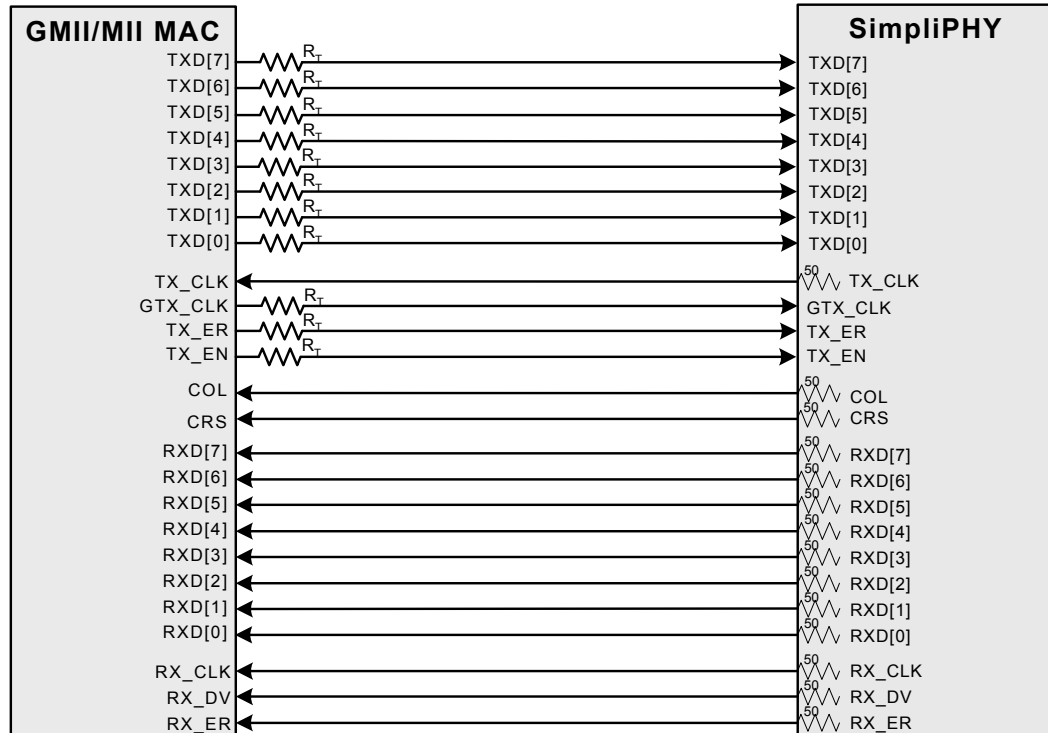
**Figure 4. RGMII MAC Interface**



### 3.2.3 GMII/MII MAC Interface Mode

The GMII/MII interface can support all three speeds (10 Mbps, 100 Mbps, and 1000 Mbps) and is used as an interface to a GMII/MII-compatible MAC.

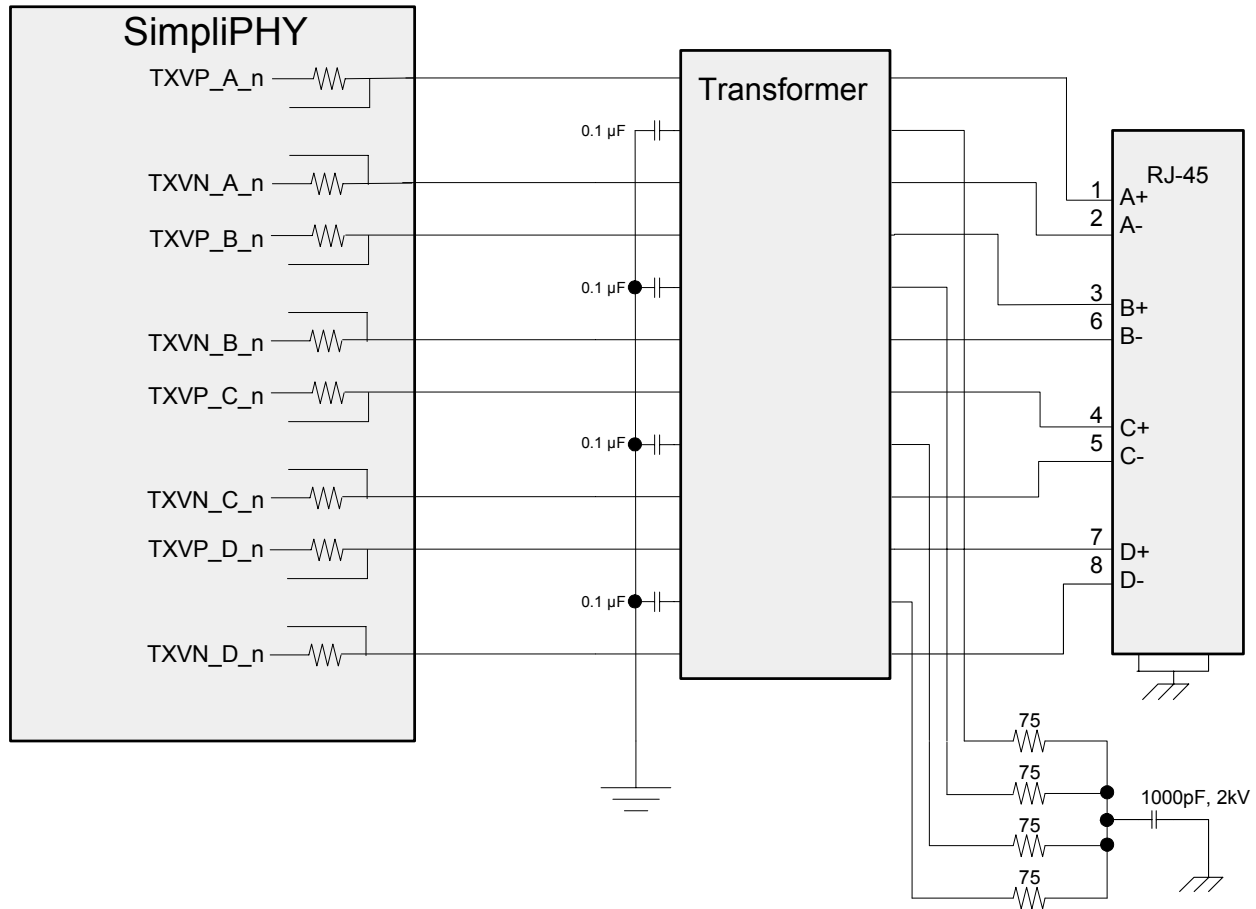
**Figure 5. GMII/MII MAC Interface**



### 3.3 Cat5 Media Interface

The twisted pair interface on the VSC8641 is compliant with the IEEE802.3-2000 specifications for Cat5 media. The VSC8641, unlike other Gigabit PHYs, has all passive components (required to connect the PHY's Cat5 interface to an external 1:1 transformer) fully integrated into the device. The connection of the twisted pair interface is shown in the following illustration.

**Figure 6. Cat5 Media Interface**



### 3.4 Cat5 Auto-Negotiation

The VSC8641 device supports twisted pair auto-negotiation as defined by clause 28 of the IEEE standard 802.3-2000.

The auto-negotiation process consists of the evaluation of the advertised capabilities of the PHY and its link partner to determine the best possible operating mode, throughput speed, duplex configuration, and master or slave operating modes in the case of 1000BASE-T setups. Auto-negotiation also allows a connected MAC to communicate with its link partner MAC through the VSC8641 device using the optional “next pages,” which set attributes that may not otherwise be defined by the IEEE standard.

In installations where the Cat5 link partner does not support auto-negotiation, the VSC8641 automatically switches to use parallel detection to select the appropriate link speed.

Clearing VSC8641 device register 0, bit 12 disables clause 28 twisted-pair auto-negotiation. If auto-negotiation is disabled, the state of register bits 0.6, 0.13, and 0.8 determine the device operating speed and duplex mode. For more information about configuring auto-negotiation, see [“IEEE Standard and Main Registers,”](#) page 41.

## 3.5 Manual MDI/MDI-X Setting

As an alternative to automatic MDI/MDI-X detection (using HP Auto-MDIX technology), you can force the PHY to select MDI or MDI-X using the following scripts.

### Format:

```
Phywrite ( register(dec), data(hex) )
```

```
Phywritemask ( register(dec), data(hex), mask(hex) )
```

### To force MDI:

```
Phywrite ( 31, 0x2A30 )
```

```
Phywritemask ( 5, 0x0010, 0x0018 )
```

```
Phywrite ( 31, 0x0000 )
```

### To force MDI-X:

```
Phywrite ( 31, 0x2A30 )
```

```
Phywritemask ( 5, 0x0018, 0x0018 )
```

```
Phywrite ( 31, 0x0000 )
```

### To resume MDI/MDI-X setting based on register 18, bits 7 and 5:

```
Phywrite ( 31, 0x2A30 )
```

```
Phywritemask ( 5, 0x0000, 0x0018 )
```

```
Phywrite ( 31, 0x0000 )
```

## 3.6 Automatic Crossover and Polarity Detection

For trouble-free configuration and management of Ethernet links, the VSC8641 device includes a robust, automatic, media-dependent and crossed media-dependent detection feature, HP Auto-MDIX, in all of its three available speeds (10BASE-T, 100BASE-T, and 1000BASE-T). The function is fully compliant with clause 40 of the IEEE standard 802.3-2002.

Additionally, the device detects and corrects polarity errors on all MDI pairs—a useful capability that exceeds the requirements of the standard.

Both HP Auto-MDIX detection and polarity correction are enabled in the device by default. The default settings are adjustable using device register bits 18.5:4. Status bits for each of these functions are located in register 28.

The VSC8641 device's algorithm for HP Auto-MDIX successfully detects, corrects, and operates with any of the MDI wiring pair combinations listed in the following table.

**Table 2. Supported MDI Pair Combinations**

| RJ-45 Pin Pairings |      |      |      |                                             |
|--------------------|------|------|------|---------------------------------------------|
| 1, 2               | 3, 6 | 4, 5 | 7, 8 | Mode                                        |
| A                  | B    | C    | D    | Normal MDI                                  |
| B                  | A    | D    | C    | Normal MDI-X                                |
| A                  | B    | D    | C    | Normal MDI with pair swap on C and D pair   |
| B                  | A    | C    | D    | Normal MDI-X with pair swap on C and D pair |

**Note** The VSC8641 device can be configured to perform HP Auto-MDIX even when its auto-negotiation feature is disabled (setting register 0.12 to 0) and the link is forced into 10/100 speeds. To enable this feature, set register 27E.15 = 0.

## 3.7 Link Speed Downshift

For operation in cabling environments that are incompatible with 1000BASE-T, the VSC8641 device provides an automatic link speed “downshift” option. When enabled, the device automatically changes its 1000BASE-T auto-negotiation advertisement to the next slower speed after a set number of failed attempts at 1000BASE-T.

This is useful in networks using older cable installations that may include only pairs A and B and not pairs C and D.

To configure and monitor link speed downshifting, use register bits 20E.4:1. For more information, see [“Extended PHY Control Set 1,”](#) page 53.

## 3.8 Transformerless Ethernet

The Cat5 media interface supports 10/100/1000BT Ethernet for backplane applications such as those specified by the PICMG™ 2.16 and ATCA™ 3.0 specifications for eight-pin channels. With proper AC coupling, the typical Cat5 transformer can be removed and replaced with capacitors.

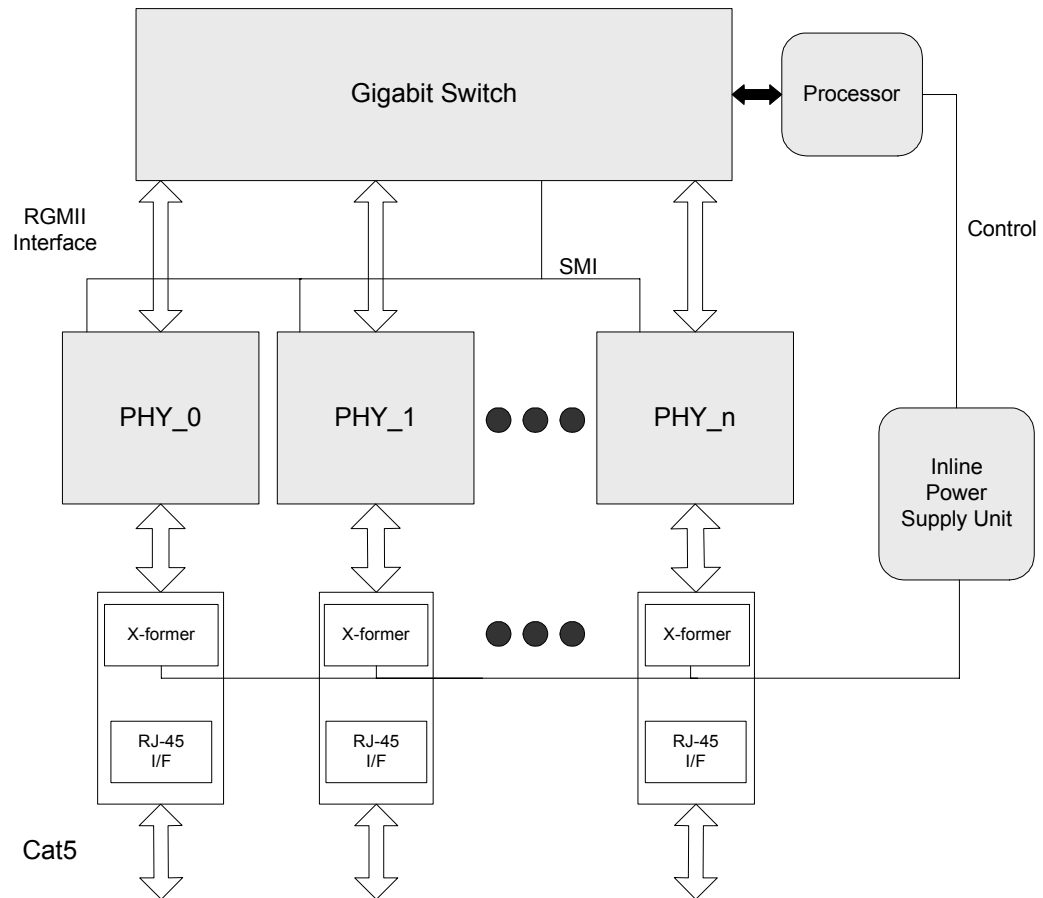
## 3.9 Ethernet Inline Powered Devices

The VSC8641 device can detect inline powered devices in Ethernet network applications. Its inline powered detection capability can be part of a system that allows for IP-phone and other devices, such as wireless access points, to receive power directly from their Ethernet cable, similar to office digital phones receiving power from a Private Branch Exchange (PBX) office switch over the telephone cabling. This can eliminate the need for an IP-phone to have an external power supply. It also enables the inline powered device to remain active during a power outage (assuming the Ethernet switch is connected to an uninterrupted power supply, battery, back-up power generator, or some other uninterruptible power source).

For more information about inline powered device detection, visit the Cisco Web site at [www.cisco.com](http://www.cisco.com).

The VSC8641 device is compatible with switch designs that are intended for use in systems that supply power to Data Terminal Equipment (DTE) using the MDI or twisted pair cable, as described in clause 33 of the IEEE standard 802.3af. The following illustration shows an example of this type of application.

**Figure 7. Inline Powered Ethernet Switch Diagram**



The following procedure describes the process that an Ethernet switch must perform to process inline power requests made by a link partner (LP) that is, in turn, capable of receiving inline power:

1. Enable the inline powered device detection mode on each VSC8641 PHY using its serial management interface. Set register bit 23E.10 to 1.
2. Ensure that the VSC8641 device auto-negotiation enable bit (register 0.12) is also set to 1. In the application, the device sends a special Fast Link Pulse (FLP) signal to the LP. Reading register bit 23E.9:8 returns 00 during the search for devices that require Power-over-Ethernet (PoE).
3. The VSC8641 PHY monitors its inputs for the FLP signal looped back by the LP. An LP capable of receiving PoE will loopback the FLP pulses when it is in a powered-down state. This is reported when VSC8641 device register bit 23E.9:8 reads back 01. It can also be verified as an inline power detection interrupt by reading VSC8641 device register bit 26.9, which should be a 1, and which is subsequently

cleared and the interrupt de-asserted after the read.

If an LP device does not loop back the FLP after a specific time, VSC8641 device register bit 23E.9:8 automatically resets to 10.

4. If the VSC8641 PHY reports that the LP needs PoE, the Ethernet switch must enable inline power on this port, externally of the PHY.
5. The PHY automatically disables inline powered device detection if the VSC8641 device register bit 23E.9:8 automatically resets to 10, and then automatically changes to its normal auto-negotiation process. A link is then auto-negotiated and established when the link status bit is set (register bit 1.2 is set to 1).
6. In the event of a link failure (indicated when VSC8641 device register bit 1.2 reads 0), the inline power should be disabled to the inline powered device external to the PHY. The VSC8641 PHY disables its normal auto-negotiation process and re-enables its inline powered device detection mode.

## 3.10 ActiPHY Power Management

In addition to the IEEE-specified power-down control bit (device register bit 0.11), the device also includes an ActiPHY™ power management mode for each PHY. This mode enables support for power-sensitive applications such as laptop computers with Wake-on-LAN™ capability. It utilizes a signal-detect function that monitors the media interface for the presence of a link to determine when to automatically power-down the PHY. The PHY “wakes up” at a programmable interval and attempts to “wake up” the link partner PHY by sending a burst of FLP over copper media.

The ActiPHY power management mode in the VSC8641 device can be enabled during normal operation at any time by setting register bit 23.5 to 1.

There are three operating states possible when ActiPHY mode is enabled:

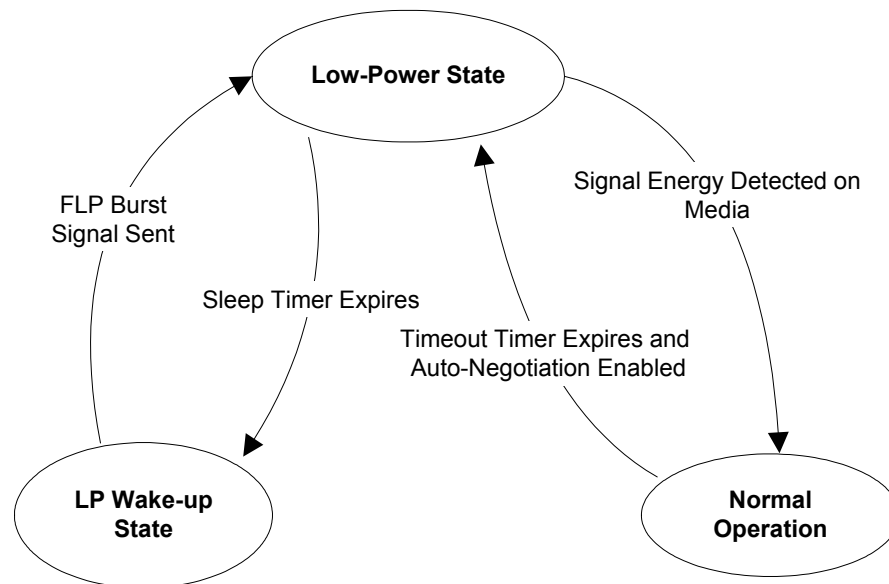
- Low-power state
- LP wake-up state
- Normal operating state (link-up state)

The VSC8641 device switches between the low-power state and LP wake-up state every two seconds until signal energy is detected on the media interface pins. When signal energy is detected, the PHY enters the normal operating state. If the PHY is in its normal operating state and the link fails, the PHY returns to the low-power state after the link status time-out timer has expired. After reset, the PHY enters the low-power state.

When auto-negotiation is enabled in the PHY, the ActiPHY state machine operates as described. If auto-negotiation is disabled and the link is forced to 10BT or 100BTX modes while the PHY is in its low-power state, the PHY continues to transition between the low-power and LP wake-up states until signal energy is detected on the media pins. At that time, the PHY transitions to the normal operating state and stays in that state even when the link is dropped. If auto-negotiation is disabled while the PHY is in the normal operation state, the PHY stays in that state when the link is dropped and does not transition back to the low-power state.

The following illustration shows the relationship between ActiPHY states and timers.

**Figure 8. ActiPHY State**



### 3.10.1 Low-Power State

In the low-power state, all major digital blocks are powered down. However, the following functionality is provided:

- SMI interface (MDC, MDIO, MDINT)
- CLKOUT

In this state, the PHY monitors the media interface pins for signal energy. The PHY comes out of low-power state and transitions to the normal operating state when signal energy is detected on the media. This happens when the PHY is connected to one of the following:

- Auto-negotiation capable link partner
- Auto-negotiation incapable (blink/forced) link partner (100BASE-TX or 10BASE-T)
- Another PHY in ActiPHY LP wake-up state

In the absence of signal energy on the media pins, the PHY transitions from the low-power state to the LP wake-up state periodically based on the programmable sleep timer (register bits 20E.14:13). The actual sleep time duration is randomized from – 80 ms to +60 ms to avoid two linked PHYs in ActiPHY Mode entering a lock-up state during operation.

### 3.10.2 Link Partner Wake-Up State

In this state, the PHY attempts to wake up the link partner. FLP bursts are sent on alternating pairs A and B of the Cat5 media for a duration of two seconds.

In this state, the following functionality is provided:

- SMI interface (MDC, MDIO, MDINT)
- CLKOUT

After sending signal energy on the relevant media, the PHY returns to the low-power state.

### 3.10.3 Normal Operating State

In this state, the PHY establishes a link with a link partner. When the media is unplugged or the link partner is powered down, the PHY waits for the duration of the programmable link status time-out timer, which is set using register bit 28.7 and bit 28.2. It then enters the low-power state.

## 3.11 Serial Management Interface

The VSC8641 device includes an IEEE 802.3-compliant serial management interface (SMI) that is affected by use of its MDC and MDIO pins. The SMI provides access to device control and status registers. The register set that controls the SMI consists of 32 16-bit registers, including all required IEEE-specified registers. Also, there are additional pages of registers accessible by means of device register 31.

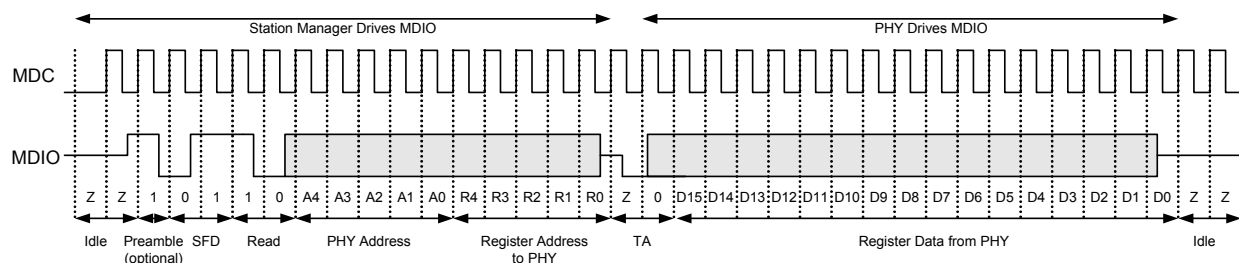
For more information, see [“Extended Page Registers,”](#) page 58.

The SMI is a synchronous serial interface with bidirectional data on the MDIO pin that is clocked on the rising edge of the MDC pin. The interface can be clocked at a rate from 0 MHz to 25 MHz, depending upon the total load on MDIO. An external, 2 kΩ pull-up resistor is required on the MDIO pin.

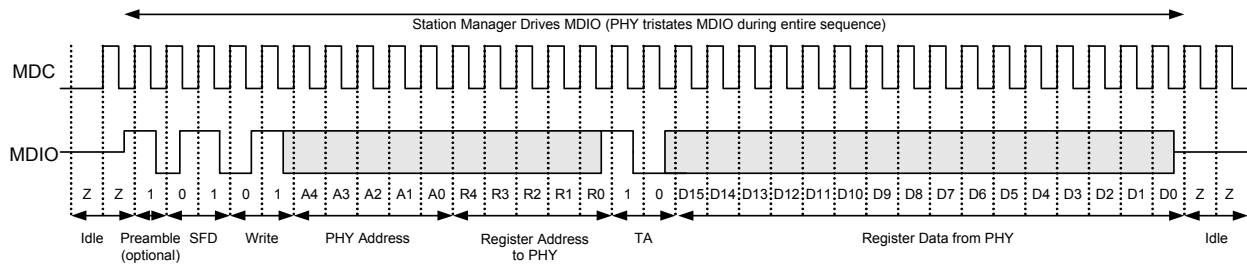
### 3.11.1 SMI Frames

Data is transferred over the SMI using 32-bit frames with an optional and arbitrary length preamble. The following illustrations show the SMI frame format for the read operation and write operation.

**Figure 9. SMI Read Frame**



**Figure 10. SMI Write Frame**



The following provides additional information about the terms used in the illustrations.

**Idle** During idle, the MDIO node goes to a high-impedance state. This allows an external pull-up resistor to pull the MDIO node up to a logical 1 state. Because the idle mode should not contain any transitions on MDIO, the number of bits is undefined during idle.

**Preamble** By default, preambles are not expected nor required. The preamble is a string of ones. If it exists, the preamble must be at least one bit; otherwise, it may be of an arbitrary length.

**Start of Frame (SFD)** A pattern of 01 indicates the start of frame. If the pattern is not 01, all following bits are ignored until the next preamble pattern is detected.

**Read or Write Opcode** A pattern of 10 indicates a read. A pattern of 01 indicates a write. If these bits are not either 01 or 10, all following bits are ignored until the next preamble pattern is detected.

**PHY Address** The VSC8641 responds to a message frame only when the received PHY address matches its physical address. The physical address is five bits long (4:0). The bits are set by the CMODE pins.

**Register Address** The next five bits are the register address.

**Turn-around** The two bits used to avoid signal contention when a read operation is performed on the MDIO are called the turn-around (TA) bits. During read operations, the VSC8641 device drives the second TA bit, which is a logical 0.

**Data** The 16-bits read from or written to the device are considered the data or data stream. When data is read from a PHY, it is valid at the output from one rising edge of MDC to the next rising edge of MDC. When data is being written to the PHY, it must be valid around the rising edge of MDC.

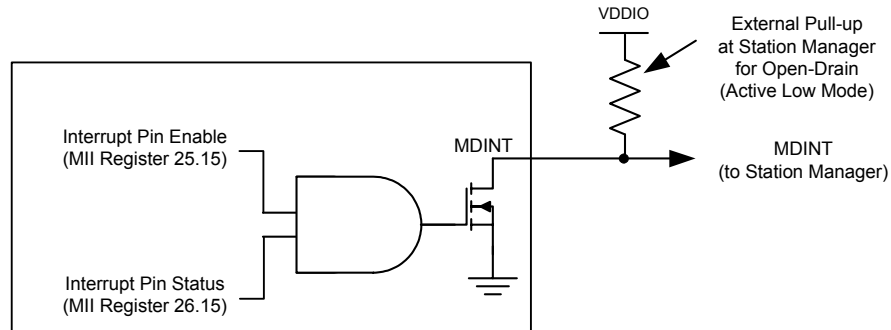
**Idle** The sequence is repeated.

### 3.11.2 SMI Interrupts

The SMI also includes an output interrupt signal, MDINT, for signaling the station manager when certain events occur in the PHY.

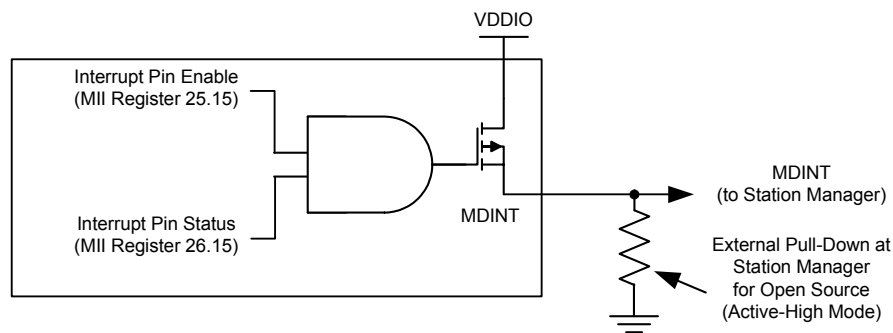
The MDINT pin can be configured for open-drain (active-low) by tying the pin to a pull-up resistor and to VDDIO. The following illustration shows this configuration.

**Figure 11. MDINT Configured as an Open-Drain (Active-Low) Pin**



Alternatively, each MDINT pin can be configured for open-source (active-high) by tying the pin to a pull-down resistor and to VSS. The following illustration shows this configuration.

**Figure 12. MDINT Configured as an Open-Source (Active-High) Pin**



When a PHY generates an interrupt, the MDINT pin is asserted (driven high or low, depending on resistor connection) if the interrupt pin enable bit (MII Register 25.15) is set.

## 3.12 LED Interface

The VSC8641 device drives up to four LEDs directly. All LED outputs are active-low and are driven using 3.3 V from the VDD33 power supply. When active, the pins are mainly used to sink current of the cathode side of an LED, but the pins can also supply source power to the anode portion of LEDs when they are not in the active state. This allows for two LED pins to be used to drive a multi-status, bi-colored LED.

### 3.12.1 Simple or Enhanced LED Method

The VSC8641 provides two methods for controlling its LEDs: simple or enhanced. The simple LED method is backward-compatible to the LED control found in prior Vitesse Ethernet PHY devices. The simple LED method eases software backward compatibility for customers switching to the VSC8641. The simple LED method is controlled by MII Register 27 and is enabled by default.

For added flexibility, the VSC8641 LED can be controlled using the enhanced LED method. The enhanced LED method is enabled by setting MII Register 17E.4 = 1. When enabled, then the LEDs are controlled by MII Registers 16E and 17E. In this method, the MII Register 27 settings are ignored.

**Simple LED Method** When MII Register 17E.4 = 0, the LEDs are controlled by the simple LED method. This LED method is enabled on power-up and is controlled by MII Register 27. In this method, MII Register 27 controls the LEDs. For more information, see [“LED Control,”](#) page 56.

**Enhanced LED Method** When MII Register 17E.4 = 1, the LEDs are controlled by the enhanced LED method. In this method, MII Register 16E and 17E control the LEDs. For more information, see [“Enhanced LED Method Select,”](#) page 59 and [“Enhanced LED Behavior,”](#) page 60.

### 3.12.2 LED Modes

If you are using the enhanced LED method, there are several LED modes available. They are found in MII Register 16E. Each LED pin can be configured to display different status information. Set the LED mode either by using register 16E or with the CMODE pin setting. The following table summarizes the LED functions.

**Note** The modes listed in the following table are equivalent to the setting used in register 16E to configure each LED pin. For the LED states listed, 1 = pin held high (de-asserted), 0 = pin held low (asserted), and blink/pulse-stretch is dependent on the LED behavior setting in register 17E.

**Table 3. LED Mode and Function Summary**

| Mode | Function Name         | LED State and Description                                                                                                                                                                                     |
|------|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0    | Link/activity         | 1 = No link in any speed on any media interface.<br>0 = Valid link at any speed on any media interface.<br>Blink or pulse-stretch = Valid link at any speed on any media interface and with activity present. |
| 1    | Link1000/activity     | 1 = No link in 1000BASE-T.<br>0 = Valid 1000BASE-T link.<br>Blink or pulse-stretch = Valid 1000BASE-T link with activity present.                                                                             |
| 2    | Link100/activity      | 1 = No link in 100BASE-TX.<br>0 = Valid 100BASE-TX link.<br>Blink or pulse-stretch = Valid 100BASE-TX link with activity present.                                                                             |
| 3    | Link10/activity       | 1 = No link in 10BASE-T.<br>0 = Valid 10BASE-T link.<br>Blink or pulse-stretch = Valid 10BASE-T link with activity present.                                                                                   |
| 4    | Link100/1000/activity | 1 = No link in 100BASE-TX or 1000BASE-T.<br>0 = Valid 100BASE-TX or 1000BASE-T link.<br>Blink or pulse-stretch = Valid 100BASE-TX or 1000BASE-T link with activity present.                                   |
| 5    | Link10/1000/activity  | 1 = No link in 10BASE-T or 1000BASE-T.<br>0 = Valid 10BASE-T or 1000BASE-T link.<br>Blink or pulse-stretch = Valid 10BASE-T or 1000BASE-T link with activity present.                                         |

**Table 3. LED Mode and Function Summary (continued)**

| Mode | Function Name          | LED State and Description                                                                                                                                                                                   |
|------|------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6    | Link10/100/activity    | 1 = No link in 10BASE-T or 100BASE-TX.<br>0 = Valid 10BASE-T or 100BASE-TX link.<br>Blink or pulse-stretch = Valid 10BASE-T or 100BASE-TX link with activity present.                                       |
| 7    | Reserved               |                                                                                                                                                                                                             |
| 8    | Duplex/collision       | 1 = Link established in half-duplex mode, or no link established.<br>0 = Link established in full-duplex mode.<br>Blink or pulse-stretch = Link established in half-duplex mode but collisions are present. |
| 9    | Collision              | 1 = No collision detected.<br>Blink or pulse-stretch = Collision detected.                                                                                                                                  |
| 10   | Activity               | 1 = No activity present.<br>Blink or pulse-stretch = Activity present (becomes TX activity present if register bit 30.14 is set to 1).                                                                      |
| 11   | Reserved               |                                                                                                                                                                                                             |
| 12   | Auto-negotiation fault | 1 = No auto-negotiation fault present.<br>0 = Auto-negotiation fault occurred.                                                                                                                              |
| 13   | Reserved               |                                                                                                                                                                                                             |
| 14   | Force LED off          | 1 = De-asserts the LED.                                                                                                                                                                                     |
| 15   | Force LED on           | 0 = Asserts the LED.                                                                                                                                                                                        |

### 3.12.3 LED Behavior

Several LED behaviors can be programmed into the VSC8641 device. Use the settings in register 17E to program LED behavior, which includes the following:

**LED Combine** Enables an LED to display status for a combination of primary and secondary modes. This can be enabled or disabled for each LED pin. For example, a copper link running in 1000BASE-T mode and activity present can be displayed with one LED by configuring an LED pin to Link1000/Activity mode. The LED asserts when linked to a 1000BASE-T partner and also blinks or pulse-stretches when activity is either transmitted by the PHY or received by the link partner. The combine feature when disabled only allows status of the primary function selected. In this example, only Link1000 asserts the LED, and the secondary mode, activity, does not display if the combine feature is disabled.

**LED Blink or Pulse-Stretch** This behavior is used for activity and collision indication. This can be uniquely configured for each LED pin. Activity and collision events can occur randomly and intermittently throughout the link-up period. For activity or collision to be visually seen, these two modes are provided. Blink is a 50% duty cycle oscillation of asserting and de-asserting an LED pin. Pulse-stretch guarantees that an LED is asserted and de-asserted for a specific period of time when activity is either present or not present. These rates can also be configured using a register setting.

**Rate of LED Blink or Pulse-Stretch** This controls the LED blink rate or pulse-stretch length when blink/pulse-stretch is enabled on an LED pin. The blink rate, which alternates between a high and low voltage level at a 50% duty cycle, can be set to 2.5 Hz, 5 Hz, 10 Hz, or 20 Hz. For pulse-stretch, this can be set to 50 ms, 100 ms, 200 ms, or 400 ms.

**LED Pulsing Enable** To provide additional power savings, the LEDs (when asserted) can be pulsed at 5 kHz, 20% duty cycle.

## 3.13 Testing Features

The VSC8641 device includes several testing features designed to make it easier to perform system-level debugging and in-system production testing. This section describes the available features.

### 3.13.1 Ethernet Packet Generator (EPG)

The device EPG can be used at each of the 10/100/1000BASE-T speed settings to isolate problems between the MAC and the VSC8641 device, or between a locally connected PHY and its remote link partner. Enabling the EPG feature effectively disables all MAC interface transmit pins and selects the EPG as the source for all data transmitted onto the twisted pair interface.

**Note** The EPG is intended for use with laboratory or in-system testing equipment only. Do not use the EPG testing feature when the VSC8641 device is connected to a live network.

To enable the VSC8641 device EPG feature, set the device register bit 29E.15 to 1.

When the EPG is enabled, packet loss occurs during transmission of packets from the MAC to the PHY. However, the PHY receive output pins to the MAC are still active when the EPG is enabled. If it is necessary to disable the MAC receive pins as well, set register bit 0.10 to 1.

When the device register bit 29E.14 is set to 1, the PHY begins transmitting Ethernet packets based on the settings in registers 29E and 30E. These registers set:

- Source and destination addresses for each packet
- Packet size
- Inter-packet gap
- FCS state
- Transmit duration
- Payload pattern

If register bit 29E.13 is set to 0, register bit 29E.14 is cleared automatically after 30,000,000 packets are transmitted.

### 3.13.2 CRC Counters

Two separate cyclical redundancy checking (CRC) counters are available in the VSC8641 device. There is a 14-bit CRC good counter available in register bits 18E.13:0 and a separate 8-bit CRC error counter available in register bits 23E.7:0.

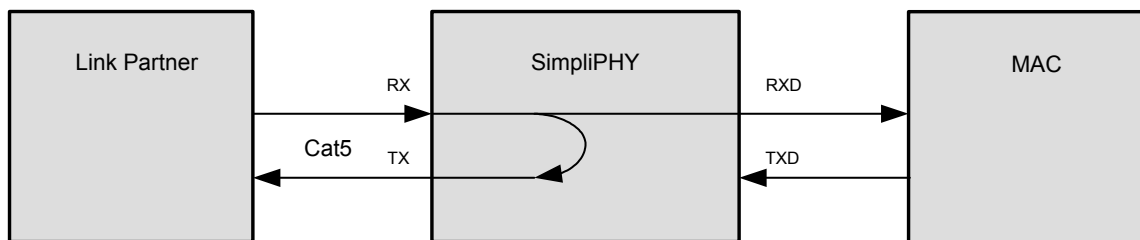
The device CRC counters operate in 10/100/1000BASE-T testing as follows:

- After receiving a packet on the media interface, register bit 18E.15 is set and cleared after being read. The packet then is counted by either the CRC good counter or the CRC error counter. Both CRC counters are also automatically cleared when read.
- The CRC good counter's highest value is 9,999 packets. Upon receiving the next packet, the counter clears and continues to count additional packets beyond that value. The CRC error counter saturates when it reaches its maximum counter limit of 255 packets.

### 3.13.3 Far-end Loopback

The far-end loopback testing feature is enabled by setting register bit 27E.10 to 1. When enabled, it forces incoming data from a link partner on the current media interface to be retransmitted back to the link partner on the media interface as shown in the following illustration. In addition, the incoming data also appears on the receive data pins of the MAC interface. Data present on the transmit data pins of the MAC interface is ignored when using this testing feature.

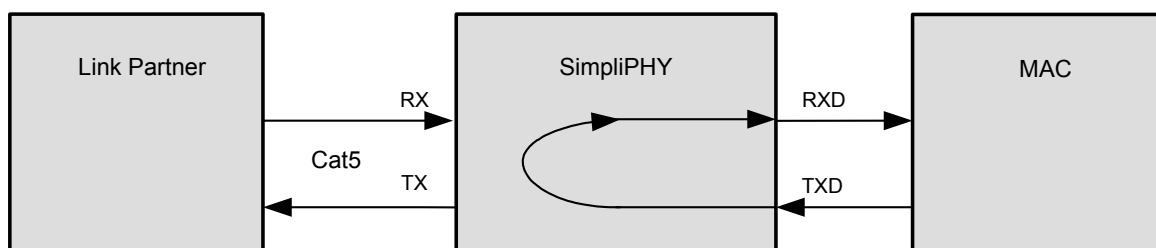
**Figure 13. Far-End Loopback**



### 3.13.4 Near-End Loopback

When the near-end loopback testing feature is enabled (by setting the device register bit 0.14 to 1), data on the transmit data pins (TXD) is looped back onto the device received data pins (RXD) as shown in the following illustration. When using this testing feature, no data is transmitted over the network.

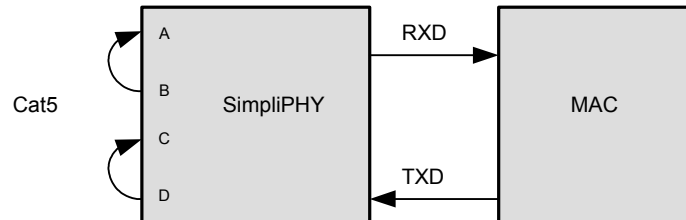
**Figure 14. Near-End Loopback**



### 3.13.5 Connector Loopback

The connector loopback testing feature allows for the twisted pair interface to be looped back externally. When using this feature, the PHY must be connected to a loopback connector or a loopback cable. Pair A should be connected to pair B and pair C to pair D, as shown in the following illustration. The connector loopback feature functions at all available interface speeds.

**Figure 15. Connector Loopback**



When using the connector loopback testing feature, the device auto-negotiation, speed, and duplex configuration is set using device registers 0, 4, and 9. For 1000BASE-T connector loopback, only the following additional writes are required. Execute the additional writes in the following order:

1. Enable the 1000BASE-T connector loopback. Set register bit 24.0 to 1.
2. Disable the pair swap correction. Set register bit 18.5 to 1.

### 3.13.6 VeriPHY Cable Diagnostics

The VSC8641 device includes a comprehensive suite of cable diagnostic functions that are available using SMI reads and writes. These functions enable a variety of cable operating conditions and status to be accessed and checked. The VeriPHY suite has the ability to identify the cable length and operating conditions and to isolate a variety of common faults that can occur on the Cat5 twisted pair cabling.

For more information, see the *PHY API Software and Programmers Guide* on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

**Note** If a link is established on the twisted pair interface in 1000BASE-T mode, VeriPHY can run without disrupting the link or any data transfer. However, if a link is established in 100BASE-TX or 10BASE-T, VeriPHY causes the link to drop while the diagnostics are running. After the diagnostics are finished, the link is then re-established.

The following diagnostic functions are part of the VeriPHY suite:

- Detection of coupling between cable pairs
- Detection of cable pair termination
- Determination of cable length

**Coupling Between Cable Pairs** Shorted wires, improper termination, or high crosstalk resulting from an incorrect wire map can cause error conditions, such as

anomalous coupling between cable pairs. These conditions can all prevent the device from establishing a link at any speed.

**Cable Pair Termination** Proper termination of Cat5 cable requires 100- $\Omega$  differential impedance between the positive and negative cable terminals. The IEEE standard 802.3 allows for a termination of as high as 115  $\Omega$  or as low as 85  $\Omega$ . If the termination falls outside of this range, it is reported by the VeriPHY diagnostics as an anomalous termination. The diagnostics can also determine the presence of an open or shorted cable pair.

**Cable Length** When the Cat5 cable in an installation is properly terminated, VeriPHY reports the approximate cable length in meters.

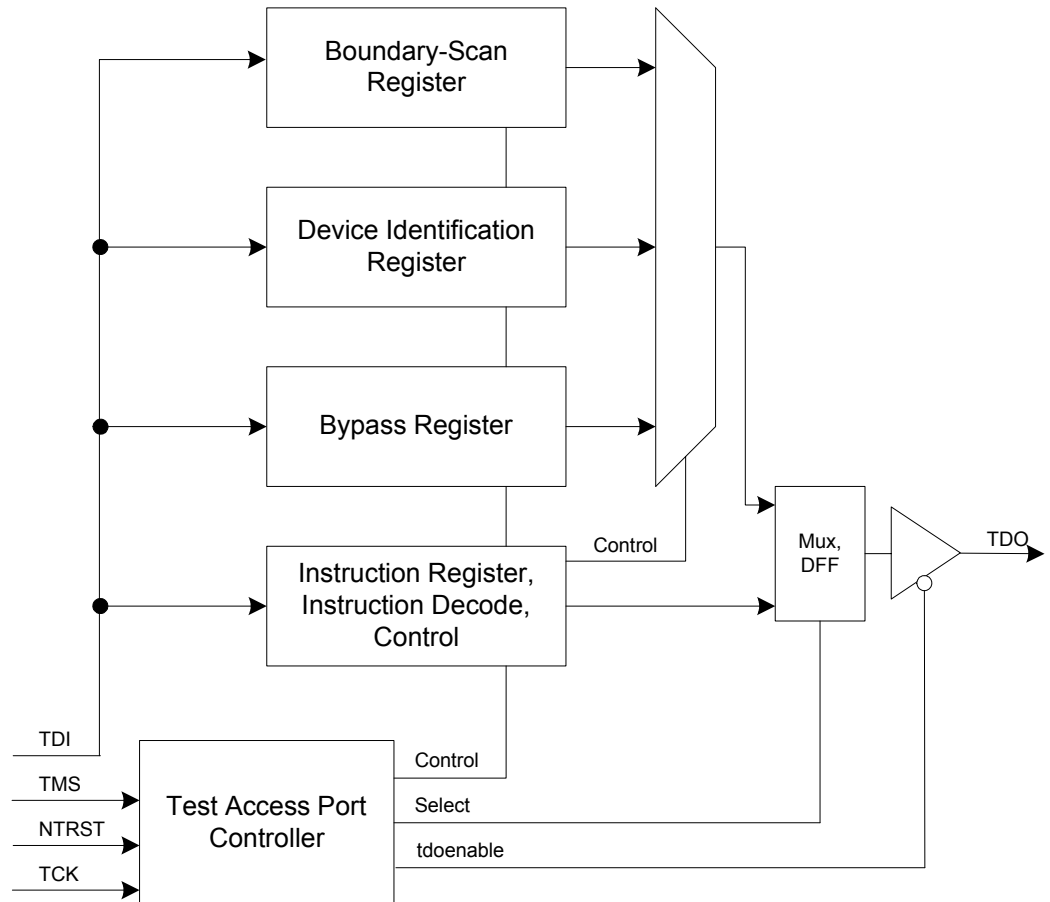
### 3.13.7 IEEE 1149.1 JTAG Boundary Scan

The VSC8641 device supports the Test Access Port (TAP) and boundary-scan architecture described in the IEEE standard 1149.1. The device includes an IEEE 1149.1-compliant test interface, often referred to as a "JTAG TAP Interface."

The JTAG boundary-scan logic on the VSC8641 device, accessed using its TAP interface, consists of a boundary-scan register and other logic control blocks. The TAP controller includes all IEEE-required signals (TMS, TCK, TDI, and TDO), in addition to the optional asynchronous reset signal NTRST.

The following illustration shows the TAP and boundary-scan architecture.

**Figure 16. Test Access Port and Boundary-Scan Architecture**



After a TAP reset, the Device Identification register is serially connected between TDI and TDO by default. The TAP Instruction register is loaded either from a shift register (when a new instruction is shifted in) or, if there is no new instruction in the shift register, a default value of 0110 (IDCODE) is loaded. Using this method, there is always a valid code in the instruction register, and the problem of toggling instruction bits during a shift is avoided. Unused codes are mapped to the BYPASS instruction.

### 3.13.8 JTAG Instruction Codes

The VSC8641 device supports the following instruction codes.

**EXTEST** Allows testing of off-chip circuitry and board-level interconnections by sampling input pins and loading data onto output pins. Outputs are driven by the contents of the boundary-scan cells, which have to be updated with valid values (with the PRELOAD instruction) prior to the EXTEST instruction.

**SAMPLE/PRELOAD** Allows a snapshot of inputs and outputs during normal system operation to be taken and examined. It also allows data values to be loaded into the boundary-scan cells prior to the selection of other boundary-scan test instructions.

**IDCODE** Provides the version number (bits 31:28), part number (bits 27:12), and the manufacturer identity (bits 11:1) to be serially read from the device.

The following table provides information about the meaning of IDCODE binary values stored in the device JTAG registers.

**Table 4. JTAG Device Identification Register Description**

| Description  | Device Version Number | Model Number        | Manufacturing Identity | LSB |
|--------------|-----------------------|---------------------|------------------------|-----|
| Bit field    | 31 through 28         | 27 through 12       | 11 through 1           | 0   |
| Binary value | 0001                  | 1000 0110 0100 0001 | 000 0111 0100          | 1   |

**CLAMP** Allows the state of the signals driven from the component pins to be determined from the boundary-scan register while the bypass register is selected as the serial path between TDI and TDO. While the CLAMP instruction is selected, the signals driven from the component pins do not change.

**HIGHZ** Places the component in a state in which all of its system logic outputs are placed in a high impedance state. In this state, an in-circuit test system may drive signals onto the connections normally driven by a component output without incurring a risk of damage to the component. This makes it possible to use a board where not all of the components are compatible with the IEEE 1149.1 standard.

**BYPASS** The bypass register contains a single shift-register stage and is used to provide a minimum-length serial path (one TCK clock period) between TDI and TDO to bypass the device when no test operation is required.

The following table provides more information about the location and IEEE compliance of the JTAG instruction codes used in the VSC8641.

**Table 5. JTAG Interface Instruction Codes**

| Instruction    | Code                           | Selected Register     | Register Width | IEEE 1149.1 Specification |
|----------------|--------------------------------|-----------------------|----------------|---------------------------|
| EXTEST         | 0000                           | Boundary-scan         | 69             | Mandatory                 |
| SAMPLE/PRELOAD | 0001                           | Boundary-scan         | 69             | Mandatory                 |
| IDCODE         | 0110                           | Device identification | 32             | Optional                  |
| CLAMP          | 0010                           | Bypass register       | 1              | Optional                  |
| HIGHZ          | 0011                           | Bypass register       | 1              | Optional                  |
| BYPASS         | 1111                           | Bypass register       | 1              | Mandatory                 |
| RESERVED       | 0100, 0101,<br>0111, 1000-1110 |                       |                |                           |

### 3.13.9 Boundary-Scan Register Cell Order

All inputs and outputs are observed in the boundary-scan register cells. All outputs are additionally driven by the contents of boundary-scan register cells. Bidirectional pins have all three related boundary-scan register cells: input, output, and control.

The complete boundary-scan cell order is available as a BSDI file format on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

## 4 Configuration

The VSC8641 device can be configured using three different methods:

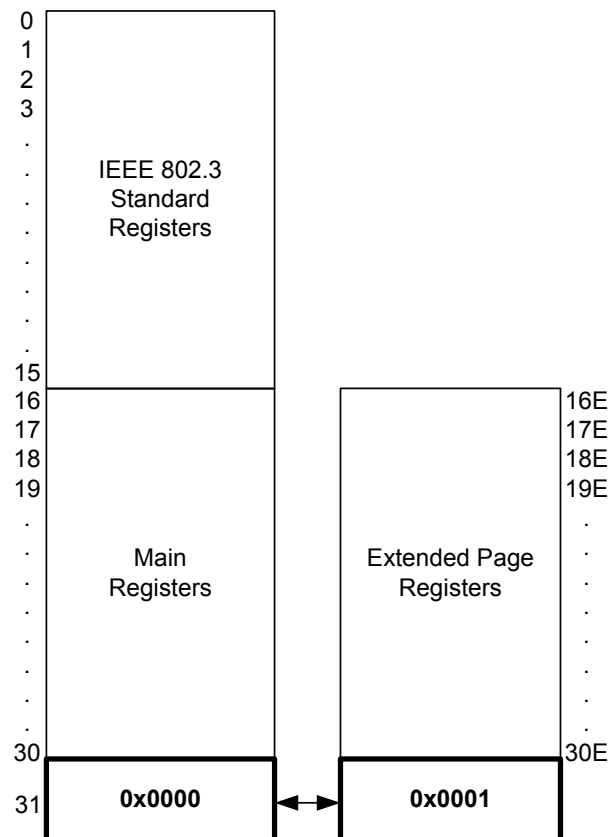
- Setting internal memory registers using the management interface.
- Setting a combination of CMODE pins and registers.
- Loading a configuration into an external EEPROM and connecting that device so that it writes configuration information at system startup.

### 4.1 Registers

This section provides information about how to configure the VSC8641 device using its internal memory registers and the management interface. For information about configuring the device using the CMODE pins, see [“CMODE,”](#) page 68. For information about setting up an external EEPROM to perform startup configuration, see [“EEPROM,”](#) page 70.

The following illustration shows the relationship between the device registers and their address spaces.

**Figure 17. Register Space Diagram**



### 4.1.1 Reserved Registers

For main registers 16 through 31 and extended page registers 16E through 30E, any bits marked as “Reserved” should be processed as read only and their states as undefined.

### 4.1.2 Reserved Bits

In writing to registers with reserved bits, use a “read-modify-then-write” technique, where the entire register is read but only the intended bits to be changed are modified. Reserved bits cannot be changed and their read state cannot be considered static or unchanging.

## 4.2 IEEE Standard and Main Registers

In the VSC8641 device, the standard registers' page space consists of the IEEE standard registers and the Vitesse standard registers. The following table lists the names of the registers associated with the addresses as dictated by the IEEE standard.

**Table 6. IEEE 802.3 Standard Registers**

| Register Address | Register Name                                   |
|------------------|-------------------------------------------------|
| 0                | Mode control                                    |
| 1                | Mode status                                     |
| 2                | PHY identifier 1                                |
| 3                | PHY identifier 2                                |
| 4                | Auto-negotiation advertisement                  |
| 5                | Auto-negotiation link partner ability           |
| 6                | Auto-negotiation expansion                      |
| 7                | Auto-negotiation next-page transmit             |
| 8                | Auto-negotiation link partner next-page receive |
| 9                | 1000BASE-T control                              |
| 10               | 1000BASE-T status                               |
| 11               | Reserved                                        |
| 12               | Reserved                                        |
| 13               | Reserved                                        |
| 14               | Reserved                                        |
| 15               | 1000BASE-T status extension 1                   |

The following table lists the names of the registers in the main page space of the device. These registers are accessible only when register address 31 is set to 0x0000.

**Table 7. Main Registers**

| Register Address | Register Name                 |
|------------------|-------------------------------|
| 16               | 100BASE-TX status extension   |
| 17               | 1000BASE-T status extension 2 |

**Table 7. Main Registers (*continued*)**

| Register Address | Register Name                 |
|------------------|-------------------------------|
| 18               | Bypass control                |
| 19               | Receive error counter         |
| 20               | False carrier sense counter   |
| 21               | Disconnect counter            |
| 22               | Extended control and status   |
| 23               | Extended PHY control 1        |
| 24               | Extended PHY control 2        |
| 25               | Interrupt mask                |
| 26               | Interrupt status              |
| 27               | LED control                   |
| 28               | Auxiliary control and status  |
| 29               | Delay skew status             |
| 30               | Reserved                      |
| 31               | Extended register page access |

### 4.2.1 Mode Control

The device register at memory address 0.00.15:0 controls several aspects of VSC8641 functionality. The following table lists the available bit settings in this register and what they control.

**Table 8. Mode Control, Address 0 (0x00)**

| Bit   | Name                    | Access | Description                                                                                                                                                                                                                                                                                            | Default |
|-------|-------------------------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15    | Software reset          | R/W    | This is a self-clearing bit that restores all serial management interface (SMI) registers to their default state, except for sticky and super sticky bits.<br>1 = Reset asserted.<br>0 = Reset de-asserted.<br>You must wait 4 $\mu$ s after setting this bit to initiate another SMI register access. | 0       |
| 14    | Loopback                | R/W    | 1 = Loopback enabled.<br>0 = Loopback disabled.<br>When loop back is enabled, the device functions at the current speed setting and with the current duplex mode setting (bit 8 of this register).                                                                                                     | 0       |
| 13, 6 | Forced speed selection  | R/W    | LSB = bit 13, MSB = bit 6.<br>00 = 10 Mbps.<br>01 = 100 Mbps.<br>10 = 1000 Mbps.<br>11 = Reserved.                                                                                                                                                                                                     | 10      |
| 12    | Auto-negotiation enable | R/W    | 1 = Auto-negotiation enabled.<br>0 = Auto-negotiation disabled.                                                                                                                                                                                                                                        | 1       |

**Table 8. Mode Control, Address 0 (0x00) (continued)**

| Bit | Name                     | Access | Description                                                                                                                                                      | Default |
|-----|--------------------------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 11  | Power-down               | R/W    | 1 = Power-down enabled.<br>If power-down is enabled, the RGMII's in-band signaling is disabled. When this bit is set, RGMII in-band signaling does not function. | 0       |
| 10  | Isolate                  | R/W    | 1 = Disable MAC interface outputs and ignore MAC interface inputs.                                                                                               | 0       |
| 9   | Restart auto-negotiation | R/W    | This is a self-clearing bit.<br>1 = Restart auto-negotiation on media interface.                                                                                 | 0       |
| 8   | Duplex                   | R/W    | 1 = Full-duplex.<br>0 = Half-duplex.                                                                                                                             | 0       |
| 7   | Collision test enable    | R/W    | 1 = Collision test enabled.                                                                                                                                      | 0       |
| 6   | MSB for speed selection  | R/W    | See bit 13 above.                                                                                                                                                | 1       |
| 5:0 | Reserved                 |        |                                                                                                                                                                  | 000000  |

## 4.2.2 Mode Status

The register at 1.01.15:0 in the device main registers space displays the currently enabled mode setting. The following table lists possible readouts of this register.

**Table 9. Mode Status, Address 1 (0x01)**

| Bit | Name                            | Access | Description                                                   | Default |
|-----|---------------------------------|--------|---------------------------------------------------------------|---------|
| 15  | 100BASE-T4 capability           | RO     | 1 = 100BASE-T4 capable.                                       | 0       |
| 14  | 100BASE-X FDX capability        | RO     | 1 = 100BASE-X FDX capable.                                    | 1       |
| 13  | 100BASE-X HDX capability        | RO     | 1 = 100BASE-X DDX capable.                                    | 1       |
| 12  | 10BASE-T FDX capability         | RO     | 1 = 10BASE-T FDX capable.                                     | 1       |
| 11  | 10BASE-T HDX capability         | RO     | 1 = 10BASE-T HDX capable.                                     | 1       |
| 10  | 100BASE-T2 FDX capability       | RO     | 1 = 100BASE-T2 FDX capable.                                   | 0       |
| 9   | 100BASE-T2 HDX capability       | RO     | 1 = 100BASE-T2 HDX capable.                                   | 0       |
| 8   | Extended status enable          | RO     | 1 = Extended status information present in register 15.       | 1       |
| 7   | Reserved                        | RO     |                                                               | 0       |
| 6   | Preamble suppression capability | RO     | 1 = MF preamble may be suppressed.<br>0 = MF always required. | 1       |
| 5   | Auto-negotiation complete       | RO     | 1 = Auto-negotiation complete.                                | 0       |

**Table 9. Mode Status, Address 1 (0x01) (continued)**

| Bit | Name                        | Access | Description                                              | Default |
|-----|-----------------------------|--------|----------------------------------------------------------|---------|
| 4   | Remote fault                | RO     | This bit latches high.<br>1 = Far-end fault detected.    | 0       |
| 3   | Auto-negotiation capability | RO     | 1 = Auto-negotiation capable.                            | 1       |
| 2   | Link status                 | RO     | This bit latches low.<br>1 = Link is up.                 | 0       |
| 1   | Jabber detect               | RO     | This bit latches high.<br>1 = Jabber condition detected. | 0       |
| 0   | Extended capability         | RO     | 1 = Extended register capable.                           | 1       |

### 4.2.3 Device Identification

All 16 bits in both register 2 and register 3 in the VSC8641 device are used to provide information associated with aspects of the device identification. The following tables list the possible readouts.

**Table 10. Identifier 1, Address 2 (0x02)**

| Bit  | Name                                     | Access | Description                      | Default |
|------|------------------------------------------|--------|----------------------------------|---------|
| 15:0 | Organizationally unique identifier (OUI) | RO     | OUI most significant bits (3:18) | 0x0007  |

**Table 11. Identifier 2, Address 3 (0x03)**

| Bit   | Name                   | Access | Description                        | Default |
|-------|------------------------|--------|------------------------------------|---------|
| 15:10 | OUI                    | RO     | OUI least significant bits (19:24) | 000001  |
| 9:4   | Vitesse model number   | RO     | VSC8641                            | 000011  |
| 3:0   | Device revision number | RO     |                                    | 0001    |

### 4.2.4 Auto-Negotiation Advertisement

The bits in address 4 in the main registers space control the VSC8641 device ability to notify other devices of the status of its auto-negotiation feature. The following table lists the available settings and readouts.

**Table 12. Device Auto-Negotiation Advertisement, Address 4 (0x04)**

| Bit | Name                           | Access | Description         | Default |
|-----|--------------------------------|--------|---------------------|---------|
| 15  | Next page transmission request | R/W    | 1 = Request enabled | 0       |
| 14  | Reserved                       | RO     |                     | 0       |
| 13  | Transmit remote fault          | R/W    | 1 = Enabled         | 0       |

**Table 12. Device Auto-Negotiation Advertisement, Address 4 (0x04)**

| Bit | Name                       | Access | Description                     | Default |
|-----|----------------------------|--------|---------------------------------|---------|
| 12  | Reserved technologies      | R/W    |                                 | 0       |
| 11  | Advertise asymmetric pause | R/W    | 1 = Advertises asymmetric pause | CMODE   |
| 10  | Advertise symmetric pause  | R/W    | 1 = Advertises symmetric pause  | CMODE   |
| 9   | Advertise 100BASE-T4       | R/W    | 1 = Advertises 100BASE-T4       | 0       |
| 8   | Advertise 100BASE-TX FDX   | R/W    | 1 = Advertise 100BASE-TX FDX    | CMODE   |
| 7   | Advertise 100BASE-TX HDX   | R/W    | 1 = Advertises 100BASE-TX HDX   | CMODE   |
| 6   | Advertise 10BASE-T FDX     | R/W    | 1 = Advertises 10BASE-T FDX     | CMODE   |
| 5   | Advertise 10BASE-T HDX     | R/W    | 1 = Advertises 10BASE-T HDX     | CMODE   |
| 4:0 | Advertise selector         | R/W    |                                 | 00001   |

#### 4.2.5 Link Partner Auto-Negotiation Capability

The bits in main register 5 enable you to determine if the Cat5 link partner (LP) used with the VSC8641 device is compatible with the auto-negotiation functionality.

**Table 13. Auto-Negotiation Link Partner Ability, Address 5 (0x05)**

| Bit | Name                              | Access | Description                     | Default |
|-----|-----------------------------------|--------|---------------------------------|---------|
| 15  | LP next page transmission request | RO     | 1 = Requested                   | 0       |
| 14  | LP acknowledge                    | RO     | 1 = Acknowledge                 | 0       |
| 13  | LP remote fault                   | RO     | 1 = Remote fault                | 0       |
| 12  | Reserved                          | RO     |                                 | 0       |
| 11  | LP advertise asymmetric pause     | RO     | 1 = Capable of asymmetric pause | 0       |
| 10  | LP advertise symmetric pause      | RO     | 1 = Capable of symmetric pause  | 0       |
| 9   | LP advertise 100BASE-T4           | RO     | 1 = Capable of 100BASE-T4       | 0       |
| 8   | LP advertise 100BASE-TX FDX       | RO     | 1 = Capable of 100BASE-TX FDX   | 0       |
| 7   | LP advertise 100BASE-TX HDX       | RO     | 1 = Capable of 100BASE-TX HDX   | 0       |
| 6   | LP advertise 10BASE-T FDX         | RO     | 1 = Capable of 10BASE-T FDX     | 0       |
| 5   | LP advertise 10BASE-T HDX         | RO     | 1 = Capable of 10BASE-T HDX     | 0       |
| 4:0 | LP advertise selector             | RO     |                                 | 00000   |

### 4.2.6 Auto-Negotiation Expansion

The bits in main register 6 work together with those in register 5 to indicate the status of the LP auto-negotiation. The following table lists the available settings and readouts.

**Table 14. Auto-Negotiation Expansion, Address 6 (0x06)**

| Bit  | Name                           | Access | Description                                              | Default     |
|------|--------------------------------|--------|----------------------------------------------------------|-------------|
| 15:5 | Reserved                       | RO     |                                                          | 00000000000 |
| 4    | Parallel detection fault       | RO     | This bit latches high.<br>1 = Parallel detection fault.  | 0           |
| 3    | LP next page capable           | RO     | 1 = LP is next page capable.                             | 0           |
| 2    | Local PHY next page capable    | RO     | 1 = Local PHY is next page capable.                      | 1           |
| 1    | Page received                  | RO     | This bit latches low.<br>1 = New page has been received. | 0           |
| 0    | LP is auto-negotiation capable | RO     | 1 = LP is capable of auto-negotiation.                   | 0           |

### 4.2.7 Transmit Auto-Negotiation Next Page

The settings in register 7 in the main registers space provide information about the number of pages in an auto-negotiation sequence. The following table lists the settings available.

**Table 15. Auto-Negotiation Next Page Transmit, Address 7 (0x07)**

| Bit  | Name                     | Access | Description                                                          | Default     |
|------|--------------------------|--------|----------------------------------------------------------------------|-------------|
| 15   | Next page                | R/W    | 1 = More pages follow                                                | 0           |
| 14   | Reserved                 | RO     |                                                                      | 0           |
| 13   | Message page             | R/W    | 1 = Message page<br>0 = Unformatted page                             | 1           |
| 12   | Acknowledge 2            | R/W    | 1 = Complies with request<br>0 = Cannot comply with request          | 0           |
| 11   | Toggle                   | RO     | 1 = Previous transmitted LCW = 0<br>0 = Previous transmitted LCW = 1 | 0           |
| 10:0 | Message/unformatted code | R/W    |                                                                      | 00000000001 |

### 4.2.8 Auto-Negotiation Link Partner Next Page Receive

The bits in register 8 of the main register space work together with register 7 to determine certain aspects of the LP auto-negotiation. The following table lists the possible readouts.

**Table 16. Auto-Negotiation LP Next Page Receive, Address 8 (0x08)**

| Bit | Name         | Access | Description           | Default |
|-----|--------------|--------|-----------------------|---------|
| 15  | LP next page | RO     | 1 = More pages follow | 0       |

**Table 16. Auto-Negotiation LP Next Page Receive, Address 8 (0x08) (continued)**

| Bit  | Name                          | Access | Description                                                          | Default      |
|------|-------------------------------|--------|----------------------------------------------------------------------|--------------|
| 14   | Acknowledge                   | RO     | 1 = LP acknowledge                                                   | 0            |
| 13   | LP message page               | RO     | 1 = Message page<br>0 = Unformatted page                             | 0            |
| 12   | LP Acknowledge 2              | RO     | 1 = LP complies with request                                         | 0            |
| 11   | LP toggle                     | RO     | 1 = Previous transmitted LCW = 0<br>0 = Previous transmitted LCW = 1 | 0            |
| 10:0 | LP message / unformatted code | RO     |                                                                      | 000000000000 |

## 4.2.9 1000BASE-T Control

The VSC8641 device's 1000BASE-T functionality is controlled by the bits in register 9 of the main register space. The following table lists the settings and readouts available.

**Table 17. 1000BASE-T Control, Address 9 (0x09)**

| Bit   | Name                              | Access | Description                                                                                                                                                                                                                                            | Default |
|-------|-----------------------------------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:13 | Transmitter test mode             | R/W    | 000 = Normal.<br>001 = Mode 1: Transmit waveform test.<br>010 = Mode 2: Transmit jitter test as master.<br>011 = Mode 3: Transmit jitter test as slave.<br>100 = Mode 4: Transmitter distortion test.<br>101 to 111 = Reserved: Operation not defined. | 000     |
| 12    | Master/slave manual configuration | R/W    | 1 = Master/slave manual configuration enabled.                                                                                                                                                                                                         | 0       |
| 11    | Master/slave value                | R/W    | This register is only valid when bit 9.12 is set to 1.<br>1 = Configure PHY as master during negotiation.<br>0 = Configure PHY as slave during negotiation.                                                                                            | 0       |
| 10    | Port type                         | R/W    | 1 = Multi-port device.<br>0 = Single-port device.                                                                                                                                                                                                      | 0       |
| 9     | 1000BASE-T FDX capability         | R/W    | 1 = PHY is 1000BASE-T FDX capable.                                                                                                                                                                                                                     | CMODE   |
| 8     | 1000BASE-T HDX capability         | R/W    | 1 = PHY is 1000BASE-T HDX capable.                                                                                                                                                                                                                     | CMODE   |
| 7:0   | Reserved                          | R/W    |                                                                                                                                                                                                                                                        | 0x00    |

**Note** Transmitter Test Mode (bits 15:13) operates in the manner described in IEEE standard 802.3, section 40.6.1.1.2.

### 4.2.10 1000BASE-T Status

The bits in register 10 of the main register space allow you to read the status of the 1000BASE-T communications enabled in the device. The following table lists these readouts.

**Table 18. 1000BASE-T Status, Address 10 (0x0A)**

| Bit | Name                                  | Access | Description                                                                                                                   | Default |
|-----|---------------------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------|---------|
| 15  | Master/slave configuration fault      | RO     | This bit latches high.<br>1 = Master/slave configuration fault detected.<br>0 = No master/slave configuration fault detected. | 0       |
| 14  | Master/slave configuration resolution | RO     | 1 = Local PHY configuration resolved to master.<br>0 = Local PHY configuration resolved to slave.                             | 1       |
| 13  | Local receiver status                 | RO     | 1 = Local receiver okay.                                                                                                      | 0       |
| 12  | Remote receiver status                | RO     | 1 = Remote receiver OK.                                                                                                       | 0       |
| 11  | LP 1000BASE-T FDX capability          | RO     | 1 = LP 1000BASE-T FDX capable.                                                                                                | 0       |
| 10  | LP 1000BASE-T HDX capability          | RO     | 1 = LP 1000BASE-T HDX capable.                                                                                                | 0       |
| 9:8 | Reserved                              | RO     |                                                                                                                               | 00      |
| 7:0 | Idle error count                      | RO     | This is a self-clearing bit.                                                                                                  | 0x00    |

### 4.2.11 Main Registers Reserved Addresses

In the VSC8641 device main registers page space, registers 11 through 15 (0x0B through 0x0E) are reserved.

### 4.2.12 1000BASE-T Status Extension 1

Register 15 provides additional information about the operation of the device 1000BASE-T communications. The following table lists the readouts available.

**Table 19. 1000BASE-T Status Extension 1, Address 15 (0x0F)**

| Bit  | Name                      | Access | Description                       | Default |
|------|---------------------------|--------|-----------------------------------|---------|
| 15   | 1000BASE-X FDX capability | RO     | 1 = PHY is 1000BASE-X FDX capable | 0       |
| 14   | 1000BASE-X HDX capability | RO     | 1 = PHY is 1000BASE-X HDX capable | 0       |
| 13   | 1000BASE-T FDX capability | RO     | 1 = PHY is 1000BASE-T FDX capable | 1       |
| 12   | 1000BASE-T HDX capability | RO     | 1 = PHY is 1000BASE-T HDX capable | 1       |
| 11:0 | Reserved                  | RO     |                                   | 0x000   |

### 4.2.13 100BASE-TX Status Extension

Register 16 in the main registers page space of the VSC8641 device provides additional information about the status of the device's 100BASE-TX operation.

**Table 20. 100BASE-TX Status Extension, Address 16 (0x10)**

| Bit | Name                           | Access | Description                                                                   | Default |
|-----|--------------------------------|--------|-------------------------------------------------------------------------------|---------|
| 15  | 100BASE-TX descrambler         | RO     | 1 = Descrambler locked.                                                       | 0       |
| 14  | 100BASE-TX lock error          | RO     | This is a self-clearing bit.<br>1 = Lock error detected.                      | 0       |
| 13  | 100BASE-TX disconnect state    | RO     | This is a self-clearing bit.<br>1 = PHY 100BASE-TX link disconnect detected.  | 0       |
| 12  | 100BASE-TX current link status | RO     | 1 = PHY 100BASE-TX link active.                                               | 0       |
| 11  | 100BASE-TX receive error       | RO     | This is a self-clearing bit.<br>1 = Receive error detected.                   | 0       |
| 10  | 100BASE-TX transmit error      | RO     | This is a self-clearing bit.<br>1 = Transmit error detected.                  | 0       |
| 9   | 100BASE-TX SSD error           | RO     | This is a self-clearing bit.<br>1 = Start-of-stream delimiter error detected. | 0       |
| 8   | 100BASE-TX ESD error           | RO     | This is a self-clearing bit.<br>1 = End-of-stream delimiter error detected.   | 0       |
| 7:0 | Reserved                       | RO     |                                                                               |         |

### 4.2.14 1000BASE-T Status Extension 2

The second status extension register is at address 17 in the device main registers space. It provides information about another set of parameters associated with 1000BASE-T communications. For information about the first status extension register, see [Table 20](#), page 49. The following table lists the settings available.

**Table 21. 1000BASE-T Status Extension 2, Address 17 (0x11)**

| Bit | Name                           | Access | Description                                                                  | Default |
|-----|--------------------------------|--------|------------------------------------------------------------------------------|---------|
| 15  | 1000BASE-T descrambler         | RO     | 1 = Descrambler locked.                                                      | 0       |
| 14  | 1000BASE-T lock error          | RO     | This is a self-clearing bit.<br>1 = Lock error detected.                     | 0       |
| 13  | 1000BASE-T disconnect state    | RO     | This is a self-clearing bit.<br>1 = PHY 1000BASE-T link disconnect detected. | 0       |
| 12  | 1000BASE-T current link status | RO     | 1 = PHY 1000BASE-T link active.                                              | 0       |
| 11  | 1000BASE-T receive error       | RO     | This is a self-clearing bit.<br>1 = Receive error detected.                  | 0       |
| 10  | 1000BASE-T transmit error      | RO     | This is a self-clearing bit.<br>1 = Transmit error detected.                 | 0       |

**Table 21. 1000BASE-T Status Extension 2, Address 17 (0x11) (continued)**

| Bit | Name                               | Access | Description                                                                   | Default |
|-----|------------------------------------|--------|-------------------------------------------------------------------------------|---------|
| 9   | 1000BASE-T SSD error               | RO     | This is a self-clearing bit.<br>1 = Start-of-stream delimiter error detected. | 0       |
| 8   | 1000BASE-T ESD error               | RO     | This is a self-clearing bit.<br>1 = End-of-stream delimiter error detected.   | 0       |
| 7   | 1000BASE-T carrier extension error | RO     | This is a self-clearing bit.<br>1 = Carrier extension error detected.         | 0       |
| 6   | Non-compliant BCM5400 detected     | RO     | 1 = Non-compliant BCM5400 detected.                                           | 0       |
| 5   | MDI crossover error                | RO     | 1 = MDI crossover error detected.                                             | 0       |
| 4:0 | Reserved                           | RO     |                                                                               |         |

### 4.2.15 Bypass Control

The bits in the Bypass Control register in the VSC8641 device control aspects of functionality in effect when the device is disabled so that traffic can bypass it in your design. The following table lists the settings available.

**Table 22. Bypass Control, Address 18 (0x12)**

| Bit  | Name                                            | Access | Description                                                                                      | Default |
|------|-------------------------------------------------|--------|--------------------------------------------------------------------------------------------------|---------|
| 15   | Transmit disable                                | R/W    | 1 = PHY transmitter disabled.                                                                    | 0       |
| 14:9 | Reserved                                        | RO     |                                                                                                  |         |
| 8    | 1000BASE-T transmitter test clock               | R/W    | 1 = Enabled.                                                                                     | 0       |
| 7    | Force non-compliant BCM5400 detection           | R/W    | This is a sticky bit.<br>1 = Force non-compliant BCM5400 detection.                              | 0       |
| 6    | Non-compliant BCM5400 detection disable         | R/W    | This is a sticky bit.<br>1 = Non-compliant BCM5400 detection disable.                            | 1       |
| 5    | Disable pair swap correction                    | R/W    | This is a sticky bit.<br>1 = Disable the automatic pair swap correction.                         | 0       |
| 4    | Disable polarity correction                     | R/W    | This is a sticky bit.<br>1 = Disable polarity inversion correction on each subchannel.           | 0       |
| 3    | Parallel detect control                         | R/W    | This is a sticky bit.<br>1 = Do not ignore advertised ability.<br>0 = Ignore advertised ability. | 1       |
| 2    | Reserved                                        | RO     |                                                                                                  |         |
| 1    | Disable automatic 1000BASE-T next page exchange | R/W    | This is a sticky bit.<br>1 = Disable automatic 1000BASE-T next page exchanges.                   | 0       |
| 0    | CLKOUT output enable                            | R/W    | This is a sticky bit.<br>1 = Enable clock output pin.                                            | CMODE   |

**Note** If bit 1 is set to 1 in this register, automatic exchange of next pages is disabled, and control is returned to the user through the SMI after the base page is exchanged. The user then must send the correct sequence of next pages to the link partner, determine the common capabilities, and force the device into the correct configuration following the successful exchange of pages.

#### 4.2.16 Receive Error Counter

The following table lists the readouts you can expect.

**Table 23. Receive Error Counter, Address 19 (0x13)**

| Bit  | Name                  | Access | Description                                                                                                                                                                                                                                                                                                                                                                                                                    | Default  |
|------|-----------------------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| 15:8 | Reserved              | RO     |                                                                                                                                                                                                                                                                                                                                                                                                                                | 00000000 |
| 7:0  | Receive error counter | RO     | <p>This is a self-clearing bit. Counts the number of non-collision packets with receive errors since last read. Each time the PHY detects a non-collision packet containing at least one error, these bits are incremented. The counter stops counting at 0FFh.</p> <p>This register is cleared only when read, or upon either a hardware or software reset. These bits are valid only in 100BASE-TX and 1000BASE-T modes.</p> | 00000000 |

#### 4.2.17 False Carrier Sense Counter

The following table lists the readouts you can expect.

**Table 24. False Carrier Sense Counter, Address 20 (0x14)**

| Bit  | Name                        | Access | Description                                                                                                                                                                                                                                                                                                                                                                            | Default  |
|------|-----------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| 15:8 | Reserved                    | RO     |                                                                                                                                                                                                                                                                                                                                                                                        | 00000000 |
| 7:0  | False carrier sense counter | RO     | <p>This is a self-clearing bit. Counts the number of false carrier events since last read. The PHY increments these bits each time it detects a false carrier on the receive input. The counter stops counting at 0FFh.</p> <p>This register is cleared only when read, or upon either a hardware or software reset. These bits are valid only in 100BASE-TX and 1000BASE-T modes.</p> | 00000000 |

### 4.2.18 Disconnect Counter

The following table lists the readouts you can expect.

**Table 25. Disconnect Counter, Address 21 (0x15)**

| Bit  | Name               | Access | Description                                                                                                                                                                                                                                                                                                                                    | Default  |
|------|--------------------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| 15:8 | Reserved           | RO     |                                                                                                                                                                                                                                                                                                                                                | 00000000 |
| 7:0  | Disconnect counter | RO     | This is a self-clearing bit. Counts the number of non-collision packets with receive errors after the last read. The PHY increments these bits each time the Carrier Integrity Monitor (CIM) enters the link unstable state. The counter stops counting at 0FFh. This register is cleared only when read or upon a hardware or software reset. | 00000000 |

### 4.2.19 Extended Control and Status

The bits in register 22 provide additional device control and readouts. The following table lists the settings available.

**Table 26. Extended Control and Status, Address 22 (0x16)**

| Bit   | Name                      | Access | Description                                                                                                | Default |
|-------|---------------------------|--------|------------------------------------------------------------------------------------------------------------|---------|
| 15    | Force 10BASE-T link high  | R/W    | This is a sticky bit.<br>1 = Bypass link integrity test.<br>0 = Enable link integrity test.                | 0       |
| 14    | Jabber detect disable     | R/W    | This is a sticky bit.<br>1 = Disable jabber detect.                                                        | 0       |
| 13    | Disable 10BASE-T echo     | R/W    | This is a sticky bit.<br>1 = Disable 10BASE-T echo.                                                        | 1       |
| 12    | SQE disable mode          | R/W    | 1 = Disable SQE transmit.                                                                                  | 1       |
| 11:10 | 10BASE-T squelch control  | R/W    | This is a sticky bit.<br>00 = Normal squelch.<br>01 = Low squelch.<br>10 = High squelch.<br>11 = Reserved. | 00      |
| 9     | Reserved                  |        |                                                                                                            |         |
| 8     | EOF Error                 | RO     | This bit is self-clearing.<br>1 = EOF error detected.                                                      | 0       |
| 7     | 10BASE-T disconnect state | RO     | This bit is self-clearing.<br>1 = 10BASE-T link disconnect detected.                                       | 0       |
| 6     | 10BASE-T link status      | RO     | 1 = 10BASE-T link active.                                                                                  | 0       |
| 5:0   | Reserved                  | RO     |                                                                                                            |         |

The following information applies to the extended control and status bits:

- When bit 15 is set, the link integrity state machine is bypassed and the PHY is forced into a link pass status.

- When bits 11:0 are set to 00, the squelch threshold levels are based on the IEEE standard for 10BASE-T. When set to 01, the squelch level is decreased, which may improve the bit error rate performance on long loops. When set to 10, the squelch level is increased and may improve the bit error rate in high-noise environments.

## 4.2.20 Extended PHY Control Set 1

The bits in the extended control set control the MAC auto-negotiation functioning, SGMII alignment errors, and EEPROM status. The following table lists the settings available.

**Table 27. Extended PHY Control 1, Address 23 (0x17)**

| Bit   | Name                                  | Access | Description                                                                                                                                                                                                                                                                              | Default |
|-------|---------------------------------------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:13 | Reserved                              | RO     |                                                                                                                                                                                                                                                                                          |         |
| 12    | MAC interface mode select             | R/W    | This is a super-sticky bit.<br>0 = GMII MAC interface mode.<br>1 = RGMII MAC interface mode.                                                                                                                                                                                             | CMODE   |
| 11:9  | Reserved                              | RO     |                                                                                                                                                                                                                                                                                          |         |
| 8     | RGMII skew timing compensation enable | R/W    | This is a sticky bit.<br>0 = Disabled.<br>1 = Adds 1.7 ns delay to the RX_CLK and TX_CLK pins.<br><b>Note</b> There is a design consideration associated with this register. For more information, see <a href="#">“Setting the Internal RGMII Timing Compensation Value,”</a> page 121. | CMODE   |
| 7:6   | Reserved                              | RO     |                                                                                                                                                                                                                                                                                          |         |
| 5     | ActiPHY mode enable                   | R/W    | This is a sticky bit.<br>1 = Enabled.                                                                                                                                                                                                                                                    | CMODE   |
| 4:2   | Reserved                              | RO     |                                                                                                                                                                                                                                                                                          |         |
| 1     | GMII transmit pin reversal            | R/W    | This is a sticky bit.<br>0 = GMII transmit pin order default.<br>1 = GMII transmit pin order reversed.                                                                                                                                                                                   | 0       |
| 0     | Reserved                              | RO     |                                                                                                                                                                                                                                                                                          |         |

**Note** After configuring bit 12 of the extended PHY control register set 1, a software reset (register 0, bit 15) must be written to change the device operating mode. Bit 1 allows for flexibility in printed circuit board layouts because it can reorder the TXD pins.

## 4.2.21 Extended PHY Control Set 2

The second set of extended controls is located in register 24 in the main register space for the device. The following table lists the settings and readouts available.

**Table 28. Extended PHY Control 2, Address 24 (0x18)**

| Bit   | Name                          | Access | Description                                                                                                                                                                                                                            | Default |
|-------|-------------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:13 | 100BASE-TX edge rate control  | R/W    | This is a sticky bit.<br>011 = +5 Edge rate (slowest).<br>010 = +4 Edge rate.<br>001 = +3 Edge rate.<br>000 = +2 Edge rate.<br>111 = +1 Edge rate.<br>110 = Default edge rate.<br>101 = -1 Edge rate.<br>100 = -2 Edge rate (fastest). | 110     |
| 12:4  | Reserved                      | RO     |                                                                                                                                                                                                                                        |         |
| 3:1   | Cable length status           | RO     | The following are approximate lengths:<br>000 = < 10 m.<br>001 = 10—20 m.<br>010 = 20—40 m.<br>011 = 40—80 m.<br>100 = 80—100 m.<br>101 = 100—140 m.<br>110 = 140—180 m.<br>111 = >180 m.                                              | 000     |
| 0     | 1000BASE-T connector loopback | R/W    | 1 = Enabled.                                                                                                                                                                                                                           | 0       |

## 4.2.22 Interrupt Mask

The bits in register 25 control the device interrupt mask. The following table lists the settings available.

**Table 29. Interrupt Mask, Address 25 (0x19)**

| Bit | Name                              | Access | Description                           | Default |
|-----|-----------------------------------|--------|---------------------------------------|---------|
| 15  | MDINT interrupt status enable     | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 14  | Speed state change mask           | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 13  | Link state change mask            | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 12  | FDX state change mask             | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 11  | Auto-negotiation error mask       | R/W    | 1 = Enabled.                          | 0       |
| 10  | Auto-negotiation complete mask    | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 9   | Inline powered device detect mask | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 8:3 | Reserved                          | RO     |                                       |         |

**Table 29. Interrupt Mask, Address 25 (0x19) (continued)**

| Bit | Name                               | Access | Description                           | Default |
|-----|------------------------------------|--------|---------------------------------------|---------|
| 2   | Link speed downshift detect mask   | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 1   | Master/Slave resolution error mask | R/W    | This is a sticky bit.<br>1 = Enabled. | 0       |
| 0   | Reserved                           | RO     |                                       |         |

**Note** When bit 25.15 is set, the MDINT pin is enabled. When enabled, the state of this pin reflects the state of bit 26.15. Clearing this bit only inhibits the MDINT pin from being asserted.

## 4.2.23 Interrupt Status

The status of interrupts already written to the device are available for reading from register 26 in the main registers space. The following table lists the readouts you can expect.

**Table 30. Interrupt Status, Address 26 (0x1A)**

| Bit | Name                                 | Access | Description                                            | Default |
|-----|--------------------------------------|--------|--------------------------------------------------------|---------|
| 15  | Interrupt status                     | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 14  | Speed state change status            | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 13  | Link state change status             | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 12  | FDX state change status              | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 11  | Auto-negotiation error status        | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 10  | Auto-negotiation complete status     | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 9   | Inline powered device detect status  | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 8:3 | Reserved                             | RO     |                                                        |         |
| 2   | Link speed downshift detect status   | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 1   | Master/Slave resolution error status | RO     | This is a self-clearing bit.<br>1 = Interrupt pending. | 0       |
| 0   | Reserved                             | RO     |                                                        |         |

The following information applies to the interrupt status bits:

- All set bits in this register are cleared after being read (self-clearing). If bit 26.15 is set, the cause of the interrupt can be read by reading bits 26.14:0.
- For bits 26.14 and 26.12, bit 0.12 must be set for this interrupt to assert.
- For bit 26.2, bits 4.8:5 must be set for this interrupt to assert.

## 4.2.24 LED Control

If you are using the simple LED method of control, you can control the LEDs using the following settings. If you are using the enhanced LED method, there are different register settings you can use. For information about the enhanced LED register settings, see [“Enhanced LED Method Select,”](#) page 59.

**Table 31. LED Control, Address 27 (0x1B)**

| Bit | Name                              | Access | Description                                                                                                      | Default |
|-----|-----------------------------------|--------|------------------------------------------------------------------------------------------------------------------|---------|
| 15  | Link 10 LED force on (LED3 pin)   | R/W    | This is a sticky bit.<br>1 = Forced on.<br>0 = Default.                                                          | 0       |
| 14  | Link 10 LED disable (LED3 pin)    | R/W    | This is a sticky bit.<br>1 = Disabled.<br>0 = Default.                                                           | 0       |
| 13  | Link 100 LED force on (LED2 pin)  | R/W    | This is a sticky bit.<br>1 = Forced on.<br>0 = Default.                                                          | 0       |
| 12  | Link 100 LED disable (LED2 pin)   | R/W    | This is a sticky bit.<br>1 = Disabled.<br>0 = Default.                                                           | 0       |
| 11  | Link 1000 LED force on (LED1 pin) | R/W    | This is a sticky bit.<br>1 = Forced on.<br>0 = Default.                                                          | 0       |
| 10  | Link 1000 LED disable (LED1 pin)  | R/W    | This is a sticky bit.<br>1 = Disabled.<br>0 = Default.                                                           | 0       |
| 9:8 | Reserved                          | RO     |                                                                                                                  |         |
| 7   | Activity LED force on (LED0 pin)  | R/W    | This is a sticky bit.<br>1 = Forced on.<br>0 = Default.                                                          | 0       |
| 6   | Activity LED disable (LED0 pin)   | R/W    | This is a sticky bit.<br>1 = Disabled.<br>0 = Default.                                                           | 0       |
| 5:4 | Reserved                          | RO     |                                                                                                                  |         |
| 3   | LED pulse enable                  | RW     | This is a sticky bit.<br>0 = Normal operation.<br>1 = LEDs pulse with a<br>5 KHz, 20% duty cycle<br>when active. | 0       |
| 2   | Activity LED blink enable         | RW     | This is a sticky bit.<br>1 = Enable.                                                                             | 0       |
| 1   | Activity LED blink rate           | RW     | This is a sticky bit.<br>1 = 10 Hz blink rate.<br>0 = 5 Hz blink rate.                                           | 0       |
| 0   | Reserved                          | RO     |                                                                                                                  |         |

## 4.2.25 Auxiliary Control and Status

The following table lists the settings available.

**Table 32. Auxiliary Control and Status, Address 28 (0x1C)**

| Bit | Name                           | Access | Description                                                                                                                                                                                                                                                                                                                                                                                           | Default |
|-----|--------------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15  | Auto-negotiation complete      | RO     | Duplicate of bit 1.5.                                                                                                                                                                                                                                                                                                                                                                                 | 0       |
| 14  | Auto-negotiation disabled      | RO     | Inverted duplicate of bit 0.12.                                                                                                                                                                                                                                                                                                                                                                       | 0       |
| 13  | MDI/MDI-X crossover indication | RO     | 1 = MDI/MDI-X crossover performed internally.                                                                                                                                                                                                                                                                                                                                                         | 0       |
| 12  | CD pair swap                   | RO     | 1 = CD pairs are swapped.                                                                                                                                                                                                                                                                                                                                                                             | 0       |
| 11  | A polarity inversion           | RO     | 1 = Polarity swap on pair A.                                                                                                                                                                                                                                                                                                                                                                          | 0       |
| 10  | B polarity inversion           | RO     | 1 = Polarity swap on pair B.                                                                                                                                                                                                                                                                                                                                                                          | 0       |
| 9   | C polarity inversion           | RO     | 1 = Polarity swap on pair C.                                                                                                                                                                                                                                                                                                                                                                          | 0       |
| 8   | D polarity inversion           | RO     | 1 = Polarity swap on pair D.                                                                                                                                                                                                                                                                                                                                                                          | 0       |
| 7:6 | Reserved                       | RO     |                                                                                                                                                                                                                                                                                                                                                                                                       |         |
| 5   | FDX status                     | RO     | 1 = Full duplex.<br>0 = Half duplex.                                                                                                                                                                                                                                                                                                                                                                  | 0       |
| 4:3 | Speed status                   | RO     | 00 = Speed is 10BASE-T.<br>01 = Speed is 100BASE-TX.<br>10 = Speed is 1000BASE-T.<br>11 = Reserved.                                                                                                                                                                                                                                                                                                   | 00      |
| 2   | Reserved                       | RO     |                                                                                                                                                                                                                                                                                                                                                                                                       |         |
| 1   | Sticky Reset Enable            | R/W    | This is a super-sticky bit.<br>1 = Enabled. When enabled, all MII register bits listed as sticky retain their values during a software reset.<br><br>0 = Disabled. When disabled, all MII register bits listed as sticky change to their default values during a software reset.<br><br>Note that bits listed as super sticky retain their values during a software reset regardless of this setting. | 1       |
| 0   | Reserved                       | RO     |                                                                                                                                                                                                                                                                                                                                                                                                       |         |

## 4.2.26 Delay Skew Status

The following table lists the settings available.

**Table 33. Delay Skew Status, Address = 29 (0x1D)**

| Bit   | Name              | Access | Description                   | Default |
|-------|-------------------|--------|-------------------------------|---------|
| 15    | Reserved          | RO     |                               |         |
| 14:12 | Pair A delay skew | RO     | Skew in integral symbol times | 000     |
| 11    | Reserved          | RO     |                               |         |

**Table 33. Delay Skew Status, Address = 29 (0x1D) (continued)**

| Bit  | Name              | Access | Description                   | Default |
|------|-------------------|--------|-------------------------------|---------|
| 10:8 | Pair B delay skew | RO     | Skew in integral symbol times | 000     |
| 7    | Reserved          | RO     |                               |         |
| 6:4  | Pair C delay skew | RO     | Skew in integral symbol times | 000     |
| 3    | Reserved          | RO     |                               |         |
| 2:0  | Pair D delay skew | RO     | Skew in integral symbol times | 000     |

## 4.2.27 Reserved Address Space

The bits in register 30 (0x1E) are reserved.

## 4.3 Extended Page Registers

To provide functionality beyond the IEEE802.3-specified 32 registers and main device registers, the VSC8641 device includes an extended set of registers that provide an additional 15 register spaces.

To access the extended page registers (16E through 30E), enable extended register access by writing 0x0001 to register 31. For more information, see [Table 35](#), page 59.

When extended page register access is enabled, reads and writes to registers 16 through 30 affect the extended registers 16E through 30E instead of those same registers in the IEEE-specified register space. Registers 0 through 15 are not affected by the state of the extended page register access.

Writing 0x0000 to register 31 restores the normal register access.

The following table lists the addresses and register names in the extended register page space. These registers are accessible only when the device register 31 is set to 0x0001.

**Table 34. Extended Registers Page Space**

| Register Address | Register Name                       |
|------------------|-------------------------------------|
| 16E              | Enhanced LED method select          |
| 17E              | Enhanced LED behavior               |
| 18E              | CRC good counter                    |
| 19E              | MAC resistor calibration control    |
| 20E              | Extended PHY control 3              |
| 21E              | EEPROM interface status and control |
| 22E              | EEPROM data read or write           |
| 23E              | Extended PHY control 4              |
| 24E              | Reserved                            |
| 25E              | Reserved                            |
| 26E              | Reserved                            |
| 27E              | Extended PHY control 5              |

**Table 34. Extended Registers Page Space (*continued*)**

| Register Address | Register Name                     |
|------------------|-----------------------------------|
| 28E              | RGMII skew control                |
| 29E              | Ethernet packet generator (EPG) 1 |
| 30E              | Ethernet packet generator (EPG) 2 |

### 4.3.1 Extended Page Access

The register at address 31 controls the access to the extended page registers for the VSC8641 device. The following table lists the settings available.

**Table 35. Extended Page Access, Address 31 (0x1F)**

| Bit  | Name                          | Access | Description                                                                                                                                  | Default |
|------|-------------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:0 | Extended page register access | R/W    | 0x0000 = MII register 16 through 30 accesses main register space<br><br>0x0001 = MII register 16 through 30 accesses extended register space | 0x0000  |

### 4.3.2 Enhanced LED Method Select

If you are using the enhanced LED method of control, you can control the LEDs using the following settings. If you are using the simple LED method, there are different register settings you can use. For information about the simple LED register settings, see [“LED Control,”](#) page 56.

**Table 36. Enhanced LED Method Select, Address 16E (0x10)**

| Bit   | Name             | Access | Description                                                       | Default |
|-------|------------------|--------|-------------------------------------------------------------------|---------|
| 15:12 | LED3 mode select | R/W    | This is a sticky bit.<br>Select from LED modes 0-15 listed below. | CMODE   |
| 11:8  | LED2 mode select | R/W    | This is a sticky bit.<br>Select from LED modes 0-15 listed below. | 0010    |
| 7:4   | LED1 mode select | R/W    | This is a sticky bit.<br>Select from LED modes 0-15 listed below. | 0001    |
| 3:0   | LED0 mode select | R/W    | This is a sticky bit.<br>Select from LED modes 0-15 listed below. | 1010    |

The following table shows the LED functional modes that can be programmed into any of the device's LED outputs. For more information about accessing or reading the status of the outputs, see [Table 36](#), page 59.

**Table 37. Available LED Mode Settings**

| Mode | Bit Setting | LED Indicates     |
|------|-------------|-------------------|
| 0    | 0000        | Link/Activity     |
| 1    | 0001        | Link1000/Activity |
| 2    | 0010        | Link100/Activity  |

**Table 37. Available LED Mode Settings (*continued*)**

| Mode | Bit Setting | LED Indicates         |
|------|-------------|-----------------------|
| 3    | 0011        | Link10/Activity       |
| 4    | 0100        | Link100/1000/Activity |
| 5    | 0101        | Link10/1000/Activity  |
| 6    | 0110        | Link10/100/Activity   |
| 7    | 0111        | Reserved              |
| 8    | 1000        | Duplex/Collision      |
| 9    | 1001        | Collision             |
| 10   | 1010        | Activity              |
| 11   | Reserved    |                       |
| 12   | 1100        | Autoneg_Fault         |
| 13   | Reserved    |                       |
| 14   | 1110        | Force LED off         |
| 15   | 1111        | Force LED on          |

### 4.3.3 Enhanced LED Behavior

The following table lists the settings available.

**Table 38. Enhanced LED Behavior, Address 17E (0x11)**

| Bit   | Name                              | Access | Description                                                                                                                                                                                                              | Default |
|-------|-----------------------------------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:13 | Reserved                          | RO     |                                                                                                                                                                                                                          |         |
| 12    | LED pulsing enable                | R/W    | This is a sticky bit.<br>0 = Normal operation.<br>1 = LEDs pulse with a 5 KHz, 20% duty cycle when active.                                                                                                               | 0       |
| 11:10 | LED blink / pulse-stretch rate    | R/W    | This is a sticky bit.<br>00 = 2.5 Hz blink rate / 400 ms pulse-stretch.<br>01 = 5 Hz blink rate / 200 ms pulse-stretch.<br>10 = 10 Hz blink rate / 100 ms pulse-stretch.<br>11 = 20 Hz blink rate / 50 ms pulse-stretch. | 01      |
| 9     | Reserved                          | RO     |                                                                                                                                                                                                                          |         |
| 8     | LED3 pulse-stretch / blink select | R/W    | This is a sticky bit.<br>1 = Pulse-stretch.<br>0 = Blink.                                                                                                                                                                | 1       |
| 7     | LED2 pulse-stretch / blink select | R/W    | This is a sticky bit.<br>1 = Pulse-stretch.<br>0 = Blink.                                                                                                                                                                | 1       |
| 6     | LED1 pulse-stretch / blink select | R/W    | This is a sticky bit.<br>1 = Pulse-stretch.<br>0 = Blink.                                                                                                                                                                | 1       |
| 5     | LED0 pulse-stretch / blink select | R/W    | This is a sticky bit.<br>1 = Pulse-stretch.<br>0 = Blink.                                                                                                                                                                | 1       |

**Table 38. Enhanced LED Behavior, Address 17E (0x11) (continued)**

| Bit | Name                         | Access | Description                                                                                                                                              | Default |
|-----|------------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 4   | LED mode                     | R/W    | This is a sticky bit.<br>1 = Enhanced LED method (controlled by MII register 16E and 17E).<br><br>0 = Simple LED method (controlled by MII register 27). | 0       |
| 3   | LED3 combine feature disable | R/W    | This is a sticky bit.<br>0 = Combine enabled (Link/Activity, Duplex/Collision).<br><br>1 = Disable Combination (Link only, Duplex only).                 | CMODE   |
| 2   | LED2 combine feature disable | R/W    | This is a sticky bit.<br>0 = Combine enabled (Link/Activity, Duplex/Collision).<br><br>1 = Disable Combination (Link only, Duplex only).                 | CMODE   |
| 1   | LED1 combine feature disable | R/W    | This is a sticky bit.<br>0 = Combine enabled (Link/Activity, Duplex/Collision).<br><br>1 = Disable Combination (Link only, Duplex only).                 | CMODE   |
| 0   | LED0 combine feature disable | R/W    | This is a sticky bit.<br>0 = Combine enabled (Link/Activity, Duplex/Collision).<br><br>1 = Disable Combination (Link only, Duplex only).                 | CMODE   |

**Note** Bit 4 must be set to 1 before register 16E and 17E are enabled for enhanced LED control. If set to 0, then the LED features in 16E and 17E are not relevant. If set to 1, then the LED features in register 27 are not relevant.

#### 4.3.4 CRC Good Counter

Register 31E makes it possible to read the contents of the CRC good counter; the number of CRC routines that have executed successfully. The following table lists the possible readouts.

**Table 39. CRC Good Counter, Address 18E (0x12)**

| Bit  | Name                      | Access | Description                                                                                                                                       | Default |
|------|---------------------------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15   | Packet since last read    | RO     | This is a self-clearing bit.<br>1 = Packet received since last read.                                                                              | 0       |
| 14   | Reserved                  | RO     |                                                                                                                                                   |         |
| 13:0 | CRC good counter contents | RO     | This is a self-clearing bit.<br>Counter containing the number of packets with valid CRCs. This counter does not stop counting and will roll over. | 0x000   |

### 4.3.5 MAC Resistor Calibration Control

The following table lists the settings available.

**Table 40. MAC Resistor Calibration Control, Address 19E (0x13)**

| Bit   | Name                                     | Access | Description                                                                                                   | Default |
|-------|------------------------------------------|--------|---------------------------------------------------------------------------------------------------------------|---------|
| 15:14 | MAC resistor calibration control setting | R/W    | This is a sticky bit.<br>00 = 50 $\Omega$ .<br>01 = 60 $\Omega$ .<br>10 = 30 $\Omega$ .<br>11 = 45 $\Omega$ . | CMODE   |
| 13:0  | Reserved                                 | RO     |                                                                                                               |         |

### 4.3.6 Extended PHY Control 3

Register 20E controls the ActiPHY sleep timer, its wake-up timer, the frequency of the CLKOUT signal, and its link speed downshifting feature. The following table lists the settings available.

**Table 41. Extended PHY Control 3, Address 20E (0x14)**

| Bit   | Name                                     | Access | Description                                                                                                                                                                                                                                                                                                                               | Default |
|-------|------------------------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15    | Reserved                                 | RO     |                                                                                                                                                                                                                                                                                                                                           |         |
| 14:13 | ActiPHY sleep timer                      | R/W    | This is a sticky bit.<br>00 = 1 second.<br>01 = 2 seconds.<br>10 = 3 seconds.<br>11 = 4 seconds.                                                                                                                                                                                                                                          | 01      |
| 12:11 | Reserved                                 | RO     |                                                                                                                                                                                                                                                                                                                                           |         |
| 10:9  | ActiPHY link status time-out control     | R/W    | 00 = 1 second.<br>01 = 2 second.<br>10 = 3 second.<br>11 = 4 second.                                                                                                                                                                                                                                                                      | 01      |
| 8:6   | Reserved                                 | RO     |                                                                                                                                                                                                                                                                                                                                           |         |
| 5     | MAC RX_CLK Disable                       | R/W    | 1 = RX_CLK is held low.<br>0 = RX_CLK is in normal operation.                                                                                                                                                                                                                                                                             | 0       |
| 4     | Enable link speed auto-downshift feature | R/W    | This is a sticky bit.<br>1 = Enable auto link speed downshift from 1000BASE-T.                                                                                                                                                                                                                                                            | CMODE   |
| 3:2   | Link speed auto-downshift control        | R/W    | This is a sticky bit.<br>00 = Downshift after two failed 1000BASE-T auto-negotiation attempts.<br><br>01 = Downshift after three failed 1000BASE-T auto-negotiation attempts.<br><br>10 = Downshift after four failed 1000BASE-T auto-negotiation attempts.<br><br>11 = Downshift after five failed 1000BASE-T auto-negotiation attempts. | 01      |

**Table 41. Extended PHY Control 3, Address 20E (0x14) (continued)**

| Bit | Name                             | Access | Description                                                     | Default |
|-----|----------------------------------|--------|-----------------------------------------------------------------|---------|
| 1   | Link speed auto-downshift status | RO     | 0 = No downshift.<br>1 = Downshift is required or has occurred. | 0       |
| 0   | Reserved                         | RO     |                                                                 |         |

### 4.3.7 EEPROM Interface Status and Control

Register 21E is used to affect control over device function when you have incorporated a startup EEPROM into your design.

**Table 42. EEPROM Interface Status and Control, Address 21E (0x15)**

| Bit  | Name                                | Access | Description                                                                                                     | Default    |
|------|-------------------------------------|--------|-----------------------------------------------------------------------------------------------------------------|------------|
| 15   | Reserved                            | RO     |                                                                                                                 |            |
| 14   | Re-read EEPROM after software reset | R/W    | This is a super-sticky bit.<br>1 = Contents of EEPROM to be re-read after software reset.                       | 0          |
| 13   | Enable EEPROM access                | R/W    | This is a self-clearing bit.<br>1 = Execute read or write EEPROM based on the settings of register 21E, bit 12. | 0          |
| 12   | EEPROM read or write                | R/W    | 1 = Read from EEPROM.<br>0 = Write to EEPROM.                                                                   | 1          |
| 11   | EEPROM ready                        | RO     | 1 = EEPROM is ready for read or write.                                                                          | 1          |
| 10:0 | EEPROM address                      | R/W    | Sets the address of the EEPROM to which the read or write is to be directed.                                    | 0000000000 |

### 4.3.8 EEPROM Data Read/Write

Register 22E in the extended register space enables access to the contents of the external EEPROM in your design. The following table lists the writes needed to obtain the data from the external device.

**Table 43. EEPROM Read or Write, Address 22E (0x16)**

| Bit  | Name              | Access | Description                                                             | Default |
|------|-------------------|--------|-------------------------------------------------------------------------|---------|
| 15:8 | EEPROM read data  | RO     | Eight-bit data read from EEPROM; requires setting register 21E, bit 13. | 0x00    |
| 7:0  | EEPROM write data | R/W    | Eight-bit data to be written to EEPROM.                                 | 0x00    |

### 4.3.9 Extended PHY Control 4

The register at address 23E consists of the fourth set bits that control various aspects of inline powering and the CRC error counter in the VSC8641 device.

**Table 44. Extended PHY Control 4, Address 23E (0x17)**

| Bit   | Name                                   | Access | Description                                                                                                                                                            | Default |
|-------|----------------------------------------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:11 | PHY address                            | RO     | PHY address; latched on reset.                                                                                                                                         | CMODE   |
| 10    | Inline powered device detection        | R/W    | This is a sticky bit.<br>1 = Enabled.                                                                                                                                  | 0       |
| 9:8   | Inline powered device detection status | RO     | 00 = Searching for devices.<br>01 = Device found; requires inline power.<br>10 = Device found; does not require inline power.<br>11 = Reserved.                        | 00      |
| 7:0   | CRC error counter                      | RO     | This is a self-clearing bit.<br>CRC error counter for the Ethernet packet generator. The value saturates at 0xFF and subsequently clears when read and restarts count. | 0x00    |

**Note** Bits 9:8 are only valid if bit 10 is set.

### 4.3.10 Reserved Extended Registers

The bits in the extended register page space at addresses 24E, 25E, and 26E (0x18, 0x19, and 0x1A, respectively) are reserved.

### 4.3.11 Extended PHY Control 5

The following table lists the settings available.

**Table 45. Extended PHY Control 5, Address 27E (0x1B)**

| Bit | Name                          | Access | Description                                                                                                                                                   | Default |
|-----|-------------------------------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15  | HP Auto-MDIX in forced 10/100 | R/W    | This is a sticky bit.<br>1 = Disabled.<br>For more information about HP Auto-MDIX, see <a href="#">"Automatic Crossover and Polarity Detection,"</a> page 24. | 1       |
| 14  | Reserved                      | RO     |                                                                                                                                                               |         |

**Table 45. Extended PHY Control 5, Address 27E (0x1B) (continued)**

| Bit   | Name                                     | Access | Description                                                                                                                                                                                                                                                                                                                                                                                                    | Default |
|-------|------------------------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 13:12 | CRS behavior control                     | R/W    | <p>This is a sticky bit.</p> <p>Controls the CRS Behavior. The effect of each setting depends on whether it is half-duplex or full-duplex operation.</p> <p>For half-duplex operation:<br/> 00: CRS = RX_DV + TX_EN<br/> 01: CRS = RX_DV + TX_EN<br/> 10: CRS = RX_DV<br/> 11: CRS = RX_DV.</p> <p>For full-duplex operation:<br/> 00: CRS = RX_DV<br/> 01: CRS = 0<br/> 10: CRS = RX_DV<br/> 11: CRS = 0.</p> | 00      |
| 11    | EEPROM present                           | RO     | 1 = Configuration EEPROM detected on the EECLK and EEDAT pins.                                                                                                                                                                                                                                                                                                                                                 | 0       |
| 10    | Far End loopback mode                    | R/W    | 1 = Enabled.                                                                                                                                                                                                                                                                                                                                                                                                   | 0       |
| 9     | PICMG 2.16 reduced power mode            | R/W    | <p>This is a sticky bit.</p> <p>1 = Enabled.</p>                                                                                                                                                                                                                                                                                                                                                               | 0       |
| 8:6   | 100BASE-TX transmitter amplitude control | R/W    | <p>This is a sticky bit.</p> <p>011 = Reserved.<br/> 010 = +4 amplitude setting (largest).<br/> 001 = +3 amplitude setting.<br/> 000 = +2 amplitude setting.<br/> 111 = +1 amplitude setting.<br/> 110 = Default amplitude.<br/> 101 = -1 amplitude setting.<br/> 100 = -2 amplitude setting (smallest).</p>                                                                                                   | 110     |
| 5:3   | 1000BASE-T transmitter amplitude control | R/W    | <p>This is a sticky bit.</p> <p>011 = Reserved.<br/> 010 = +2 amplitude setting (largest).<br/> 001 = +1 amplitude setting.<br/> 000 = Default amplitude.<br/> 111 = -1 amplitude setting.<br/> 110 = -2 amplitude setting.<br/> 101 = -3 amplitude setting.<br/> 100 = -4 amplitude setting (smallest)</p>                                                                                                    | 000     |
| 2:0   | 1000BASE-T edge rate control             | R/W    | <p>This is a sticky bit.</p> <p>011 = +4 edge rate (slowest).<br/> 010 = +3 edge rate.<br/> 001 = +2 edge rate.<br/> 000 = +1 edge rate.<br/> 111 = default edge rate.<br/> 110 = -1 edge rate.<br/> 101 = -2 edge rate.<br/> 100 = -3 edge rate (fastest)</p>                                                                                                                                                 | 111     |

### 4.3.12 RGMII Skew Control

The following table lists the settings available.

**Table 46. RGMII Skew Control, Address 28E (0x1C)**

| Bit   | Name                              | Access | Description                                                                                                                                                                                                                                                                   | Default |
|-------|-----------------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:14 | RGMII TX skew compensation enable | R/W    | This is a sticky bit.<br>00 = 0 ns.<br>01 = 1.4 ns.<br>10 = 1.7 ns.<br>11 = 2.0 ns.<br><b>Note</b> There is a design consideration associated with this register. For more information, see <a href="#">“Setting the Internal RGMII Timing Compensation Value,”</a> page 121. | CMODE   |
| 13:12 | RGMII RX skew compensation enable | R/W    | This is a sticky bit.<br>00 = 0 ns.<br>01 = 1.4 ns.<br>10 = 1.7 ns.<br>11 = 2.0 ns.<br><b>Note</b> There is a design consideration associated with this register. For more information, see <a href="#">“Setting the Internal RGMII Timing Compensation Value,”</a> page 121. | CMODE   |
| 11:10 | Jumbo packet mode                 | R/W    | This is a sticky bit.<br>00 = Normal IEEE 1.5 kB packet length.<br>01 = Normal IEEE 9 kB packet length.<br>10 = Normal IEEE 12 kB packet length.<br>11 = Normal IEEE 16 kB packet length.                                                                                     | 00      |
| 9     | 10BASE-T no preamble mode         | R/W    | This is a sticky bit.<br>1 = Enabled, no preamble required.<br>0 = Disabled, preamble required.                                                                                                                                                                               | 0       |
| 8:0   | Reserved                          | RO     |                                                                                                                                                                                                                                                                               |         |

### 4.3.13 Ethernet Packet Generator (EPG) Control 1

The EPG control register provides access to and control of various aspects of the EPG testing feature. There are two, separate EPG control registers. The following table lists the setting available in the first register.

**Table 47. EPG Control Register 1, Address 29E (0x1D)**

| Bit | Name                  | Access | Description                                                                                | Default |
|-----|-----------------------|--------|--------------------------------------------------------------------------------------------|---------|
| 15  | EPG enable            | R/W    | 1 = Enable EPG                                                                             | 0       |
| 14  | EPG run or stop       | R/W    | 1 = Run EPG                                                                                | 0       |
| 13  | Transmission duration | R/W    | 1 = Continuous (sends in 10,000-packet increments)<br>0 = Send 30,000,000 packets and stop | 0       |

**Table 47. EPG Control Register 1, Address 29E (0x1D) (continued)**

| Bit   | Name                                      | Access | Description                                                                            | Default |
|-------|-------------------------------------------|--------|----------------------------------------------------------------------------------------|---------|
| 12:11 | Packet length                             | R/W    | 00 = 125 bytes<br>01 = 64 bytes<br>10 = 1518 bytes<br>11 = 10,000 bytes (Jumbo packet) | 0       |
| 10    | Inter-packet gap                          | R/W    | 1 = 8,192 ns<br>0 = 96 ns                                                              | 0       |
| 9:6   | Destination address                       | R/W    | Lowest nibble of the six-byte destination address                                      | 0001    |
| 5:2   | Source address                            | R/W    | Lowest nibble of the six-byte destination address                                      | 0000    |
| 1     | Payload type                              | R/W    | 1 = Randomly generated payload pattern<br>0 = Fixed based on payload pattern           | 0       |
| 0     | Bad frame check sequence (FCS) generation | R/W    | 1 = Generate packets with bad FCS<br>0 = Generate packets with good FCS                | 0       |

The following information applies to the EPG control number 1:

- Do not run the EPG when the VSC8641 device is connected to a live network.
- Bit 29E.13 (Continuous EPG mode control): When enabled, this mode causes the device to send continuous packets. When disabled, the device continues to send packets only until it reaches the next 10,000-packet increment mark. It then ceases to send packets.
- The six-byte destination address in bits 9:6 is assigned one of 16 addresses in the range of 0xFF FF FF FF FF F0 through 0xFF FF FF FF FF FF.
- The six-byte source address in bits 5:2 is assigned one of 16 addresses in the range of 0xFF FF FF FF FF F0 through 0xFF FF FF FF FF FF.
- If any of bits 13:0 are changed while the EPG is running (bit 14 is set to 1), bit 14 must be cleared and then set back to 1 for the change to take effect and to restart the EPG.

#### 4.3.14 Ethernet Packet Generator Control 2

The register at address 30E consists of the second of bits that provide access to and control over various aspects of the EPG testing feature. For information about the first set of EPG control bits, see [Table 47](#), page 66. The following table lists the settings available.

**Table 48. EPG Control Register 2, Address 30E (0x1E)**

| Bit  | Name               | Access | Description                                                          | Default |
|------|--------------------|--------|----------------------------------------------------------------------|---------|
| 15:0 | EPG packet payload | R/W    | Data pattern repeated in the payload of packets generated by the EPG | 0x00    |

**Note** If any of bits 15:0 in this register are changed while the EPG is running (bit 14 of register 29E is set to 1), that bit (29E.14) must first be cleared and then set back to 1 for the change to take effect and to restart the EPG.

## 4.4 CMODE

The information in this section consists of a detailed description of the methods to configure the VSC8641 device using its CMODE pins. It includes descriptions of the registers that work together with the CMODE pins to control the device function.

There are five configuration mode (CMODE) pins on the VSC8641 device. For more information about the physical location of the CMODE pins, see [“Pin Diagram \(VSC8641XKO, VSC8641XKO-03\),”](#) page 104. Each CMODE pin maps to a configuration bit, which means there are 20 possible settings for the device.

### 4.4.1 CMODE Pins and Related Functions

The following table lists the pin numbers and device functionality that is controlled by each configuration bit.

**Table 49. CMODE Configuration Pins and Device Functions**

| CMODE Pin | Bit 3 (MSB) Control | Bit 2 Controls       | Bit 1 Controls             | Bit 0 (LSB) Controls       |
|-----------|---------------------|----------------------|----------------------------|----------------------------|
| 4         | MAC mode            | LED3[1]              | LED3[0]                    | LED combine/separate       |
| 3         | PHY address[3]      | PHY address[4]       | MAC calibration setting[1] | MAC calibration setting[0] |
| 2         | PHY address[2]      | ActiPHY              | RGMII clock skew[1]        | RGMII clock skew[0]        |
| 1         | PHY address[1]      | Link speed downshift | Speed/duplex modes[1]      | Speed/duplex modes[0]      |
| 0         | PHY address[0]      | CLKOUT enable        | Advertise asymmetric pause | Advertise symmetric pause  |

### 4.4.2 Functions and Related CMODE Pins

The following table lists the pin and bit settings according to the device function and CMODE pin used to configure it.

**Table 50. Device Functions and Associated CMODE Pins**

| Function             | CMODE Pin | Bit     | Associated Register, Bit                        | Result                                                                                                                                                           |
|----------------------|-----------|---------|-------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PHY Address[4:0]     | 3 to 0    | 3 and 2 |                                                 | Sets the PHY address.                                                                                                                                            |
| MAC mode             | 4         | 3       | Register 23, bit 12                             | 0 = RGMII.<br>1 = GMII.                                                                                                                                          |
| Link speed downshift | 1         | 2       | Register 20E, bit 4                             | 0 = Link only according to the auto-negotiation resolution.<br>1 = Enable link speed downshift feature.                                                          |
| Speed and duplex     | 1         | 1 and 0 | Register 4, bits 8:5 and Register 9, bits 9:8   | 00 = 10/100/1000BASE-T FDX/HDX.<br>01 = 10/100/1000BASE-T FDX; 10/100BASE-T HDX.<br>10 = 1000BASE-T FDX only.<br>11 = 10/100BASE-T FDX/HDX.                      |
| RGMII clock skew     | 2         | 1 and 0 | Register 23, bit 8 and Register 28E, bits 15:12 | 00 = No skew on RX_CLK and TX_CLK.<br>01 = 1.4 ns skew on RX_CLK and TX_CLK.<br>10 = 1.7 ns skew on RX_CLK and TX_CLK.<br>11 = 2.0 ns skew on RX_CLK and TX_CLK. |

**Table 50. Device Functions and Associated CMODE Pins (*continued*)**

| Function                         | CMODE Pin | Bit     | Associated Register, Bit | Result                                                                                                                                                                                                                                                                                                                                                 |
|----------------------------------|-----------|---------|--------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Advertise asymmetric pause       | 0         | 1       | Register 4, bit 11       | 0 = Not advertised.<br>1 = Advertised.                                                                                                                                                                                                                                                                                                                 |
| Advertise symmetric pause        | 0         | 0       | Register 4, bit 10       | 0 = Not advertised.<br>1 = Advertised.                                                                                                                                                                                                                                                                                                                 |
| CLKOUT enable                    | 0         | 2       | Register 18, bit 0       | 0 = Disabled.<br>1 = Enabled.                                                                                                                                                                                                                                                                                                                          |
| ActiPHY                          | 2         | 2       | Register 23, bit 5       | 0 = Disabled.<br>1 = Enabled.                                                                                                                                                                                                                                                                                                                          |
| LED combine/<br>separate         | 4         | 0       | Register 17E, bits 3:0   | 1 = Link, Link10, Link100, Link1000, Link10/100, Link10/1000, and Link100/1000 LEDs blink or flash when activity is present. Also, Duplex LED blinks or flashes when collision is present.<br><br>0 = Link, Link10, Link100, Link1000, Link10/100, Link10/1000, and Link100/1000 LEDs indicate status only. Also, Duplex indicates duplex status only. |
| MAC resistor calibration setting | 3         | 1 and 0 | Register 19E, bits 15:14 | 00 = 50 Ω.<br>01 = 60 Ω.<br>10 = 30 Ω.<br>11 = 45 Ω.                                                                                                                                                                                                                                                                                                   |
| LED3 control                     | 4         | 2 and 1 | Register 16E, bits 15:12 | 00 = Link10/Activity.<br>01 = Duplex/Collision.                                                                                                                                                                                                                                                                                                        |

### 4.4.3 CMODE Resistor Values

To affect the VSC8641 device configuration, find the parameter in [Table 49](#), page 68 or in [Table 50](#), page 68, and connect the associated pin to the resistor specified in the following table. This sets the bits as shown.

**Table 51. CMODE Resistor Values and Resultant Bit Settings**

| With CMODE Pin Tied To | With 1% Resistor Value | Set Bit 3 (MSB) to: | Set Bit 2 to: | Set Bit 1 to: | Set Bit 0 (LSB) to: |
|------------------------|------------------------|---------------------|---------------|---------------|---------------------|
| VSS                    | 0                      | 0                   | 0             | 0             | 0                   |
| VSS                    | 2.26 kΩ                | 0                   | 0             | 0             | 1                   |
| VSS                    | 4.02 kΩ                | 0                   | 0             | 1             | 0                   |
| VSS                    | 5.90 kΩ                | 0                   | 0             | 1             | 1                   |
| VSS                    | 8.25 kΩ                | 0                   | 1             | 0             | 0                   |
| VSS                    | 12.1 kΩ                | 0                   | 1             | 0             | 1                   |
| VSS                    | 16.9 kΩ                | 0                   | 1             | 1             | 0                   |
| VSS                    | 22.6 kΩ                | 0                   | 1             | 1             | 1                   |
| VDD33                  | 0                      | 1                   | 0             | 0             | 0                   |
| VDD33                  | 2.26 kΩ                | 1                   | 0             | 0             | 1                   |
| VDD33                  | 4.02 kΩ                | 1                   | 0             | 1             | 0                   |
| VDD33                  | 5.90 kΩ                | 1                   | 0             | 1             | 1                   |

**Table 51. CMODE Resistor Values and Resultant Bit Settings (continued)**

| With CMODE Pin Tied To | With 1% Resistor Value | Set Bit 3 (MSB) to: | Set Bit 2 to: | Set Bit 1 to: | Set Bit 0 (LSB) to: |
|------------------------|------------------------|---------------------|---------------|---------------|---------------------|
| VDD33                  | 8.25 k $\Omega$        | 1                   | 1             | 0             | 0                   |
| VDD33                  | 12.1 k $\Omega$        | 1                   | 1             | 0             | 1                   |
| VDD33                  | 16.9 k $\Omega$        | 1                   | 1             | 1             | 0                   |
| VDD33                  | 22.6 k $\Omega$        | 1                   | 1             | 1             | 1                   |

Using resistors with the CMODE pins can be optional in designs that access the device's MDC/MDIO pins. In designs that do this, all configurations otherwise affected on the device by using the CMODE pins can be changed using the regular device register settings, and all the CMODE pins can be pulled to VSS (ground). However, the PHYADDR[4:0] still requires CMODE configuration.

## 4.5 EEPROM

The VSC8641 device EEPROM interface makes it possible to set up the device to self-configure its internal registers based on the information programmed into and stored in an external device. To accomplish this, the EEPROM is read on power-up or de-assertion of the NRESET bit. For field configuration, the EEPROM can also be accessed using VSC8641 device registers 21E and 22E.

The EEPROM used to interface to the VSC8641 device must have a two-wire interface. A device such as the Atmel part AT24CXXX is suggested.

As defined by the interface, data is clocked from the VSC8641 device on the falling edge of EECLK. The device determines that an external EEPROM is present if EEDAT is connected to a 4.7 k $\Omega$  external pull-up resistor. The EEDAT pin can be left floating or grounded to indicate that no EEPROM is present.

### 4.5.1 EEPROM Contents Description

When an EEPROM is present, the VSC8641 device looks for the command header, 0xBDBD at address 0 and 1 of the EEPROM. The address is incremented by 256 until the header is found. If the header is not found or no EEPROM is connected, the VSC8641 device bypasses the EEPROM read step.

When an EEPROM is present, the VSC8641 device waits for an acknowledgement for approximately three seconds (in accordance with the ATMEL EEPROM protocol). If there is no acknowledgement for three seconds, the VSC8641 device aborts its attempt to connect to the EEPROM and reverts to its otherwise normal operating mode.

After the header value is found, the two-byte address value shown in the following table indicates the EEPROM word address where the base address location for the device is located. At the base address location, the next set of bytes indicates where the configuration data contents to be programmed into the VSC8641 device are located. At the programming location, the first two bytes represent the total number of bytes (11 bits long, with MSB first) where the Total\_Number\_Bytes[10:0] is equal to the number of SMI writes multiplied by 3 (one byte for SMI port and register address and two bytes

for data). Data is read from the EEPROM sequentially until all SMI write commands are completed.

**Table 52. EEPROM Configuration Contents**

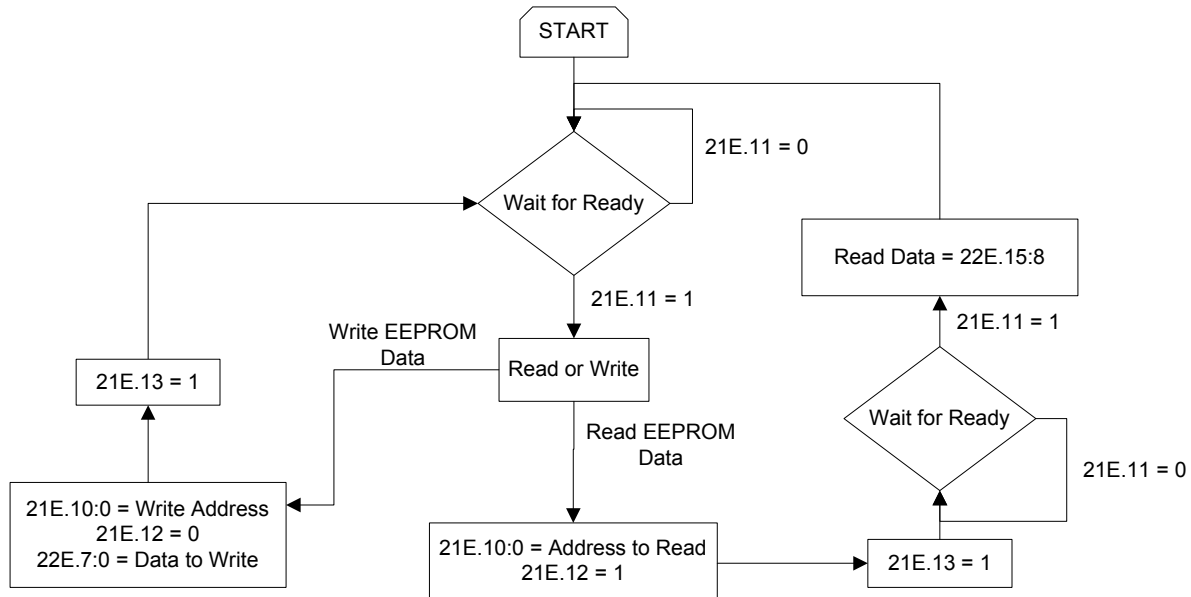
| 10-bit Address | Content (Bits 7:0)                             |
|----------------|------------------------------------------------|
| 0              | 0xBD                                           |
| 1              | 0xBD                                           |
| 2              | PHY_ADDR[4:0], Base_Address_Location[10:8]     |
| 3              | Base_Address_Location[7:0] (K)                 |
|                | Address length not specified                   |
|                | Address length not specified                   |
| K              | 00000, Config_Location[10:8]                   |
| K+1            | Config_Location[7:0] (X)                       |
|                | Address length not specified                   |
|                | Address length not specified                   |
| X              | 00000, Total_Number_Bytes[10:8]                |
| X+1            | Total_Number_Bytes[7:0] (M)                    |
| X+2            | Register address a                             |
| X+3            | Data[15:8] to be written to register address a |
| X+4            | Data[7:0] to be written to register address a  |
| X+5            | Register address b                             |
| X+6            | Data[15:8] to be written to register address b |
| X+7            | Data[7:0] to be written to register address b  |
|                | Address length not specified                   |
| X+(M-2)        | Register address x                             |
| X+(M-1)        | Data[15:8] to be written to register address x |
| X+M            | Data[7:0] to be written to register address x  |
|                | Address length not specified                   |
|                | Address length not specified                   |
| Max Address    |                                                |

## 4.5.2 Read/Write Access to the EEPROM

The VSC8641 device also has the ability to read from and write to an EEPROM such as an ATMEL AT24CXXX that is directly connected to its EECLK and EEDAT pins. If it is required to be able to write to the EEPROM, refer to the EEPROM's specific datasheet to ensure that write protection on the EEPROM is not set.

The following illustration shows the interaction of the VSC8641 device and the EEPROM.

**Figure 18. EEPROM Read and Write Register Flow**



To read a value from a specific address of the EEPROM:

1. Read the VSC8641 device register bit 21E.11 and ensure that it is set.
2. Write the EEPROM address to be read to register bits 21E.10:0.
3. Set both register bits 21E.12 and 21E.13 both to 1.
4. When register bit 21E.11 changes to 1, read the 8-bit data value found at register bits 22E.15:8. This is the contents of the address just read by the PHY.

To write a value to a specific address of the EEPROM:

1. Read the VSC8641 device register bit 21E.11 and ensure that it is set.
2. Write the address to be written to register bits 21E.10:0.
3. Set register bit 21E.12 to 0.
4. Set register bits 22E.7:0 with the 8-bit value to be written to the EEPROM.
5. Set register bit 21E.13 to 1.
6. To avoid collisions during read and write transactions, always wait until register bit 21E.11 changes to 1 before performing another EEPROM read or write operation.

## 5 Electrical Specifications

This section provides the DC characteristics, AC characteristics, recommended operating conditions, and stress ratings for the VSC8641 device. It includes information on the various timing functions of the device.

### 5.1 DC Characteristics

In addition to any parameter-specific conditions, the specifications listed in the following table may be considered valid only in the environment characterized by the specifications listed as recommended operating conditions for the VSC8641 device. For more information about the recommended operating conditions, see [“Operating Conditions,”](#) page 91.

#### 5.1.1 VDDIO at 3.3 V

In addition to any parameter-specific conditions, the specifications listed in the following table may be considered valid only when all of these apply:

- $V_{DDIO}$  is 3.3 V
- $V_{DD33}$  is 3.3 V
- $V_{DD12}$  is 1.2 V
- $V_{DD12A}$  is 1.2 V
- $V_{DDREG}$  is 3.3 V

**Table 53. DC Characteristics for VDD33, VDDIOMAC, or VDDIOMICRO at 3.3 V**

| Parameter                          | Symbol      | Minimum | Maximum | Unit    | Condition                  |
|------------------------------------|-------------|---------|---------|---------|----------------------------|
| Output high voltage                | $V_{OH}$    | 2.4     | 3.6     | V       | $I_{OH} = -4$ mA           |
| Output low voltage                 | $V_{OL}$    | 0       | 0.5     | V       | $I_{OL} = 4$ mA            |
| Input high voltage                 | $V_{IH}$    | 2.0     | 5.0     | V       | For JTAG pins              |
| Input high voltage                 | $V_{IH}$    | 1.7     | 3.6     | V       | For GMII mode              |
| Input high voltage                 | $V_{IH}$    | 2.1     | 3.6     | V       | For all other input pins   |
| Input low voltage                  | $V_{IL}$    | -0.3    | 0.9     | V       |                            |
| Input leakage current              | $I_{ILEAK}$ | -43     | 43      | $\mu$ A | Internal resistor included |
| Output leakage current             | $I_{OLEAK}$ | -43     | 43      | $\mu$ A | Internal resistor included |
| Output low current drive strength  | $I_{OL}$    |         | 11      | mA      |                            |
| Output high current drive strength | $I_{OH}$    | -20     |         | mA      |                            |

### 5.1.2 VDDIO at 2.5 V

In addition to any parameter-specific conditions, the specifications listed in the following table may be considered valid only when all of these apply:

- $V_{DDIO}$  is 2.5 V
- $V_{DD33}$  is 3.3 V
- $V_{DD12}$  is 1.2 V
- $V_{DD12A}$  is 1.2 V
- $V_{DDREG}$  is 3.3 V

**Table 54. DC Characteristics for VDDIOMAC or VDDIOMICRO at 2.5 V**

| Parameter                          | Symbol      | Minimum | Maximum | Unit    | Condition                  |
|------------------------------------|-------------|---------|---------|---------|----------------------------|
| Output high voltage                | $V_{OH}$    | 2.0     | 2.8     | V       | $I_{OH} = -1.0$ mA         |
| Output low voltage                 | $V_{OL}$    | -0.3    | 0.4     | V       | $I_{OL} = 1.0$ mA          |
| Input high voltage                 | $V_{IH}$    | 1.7     | 3.0     | V       | For GMII input             |
| Input high voltage                 | $V_{IH}$    | 2.0     | 3.0     | V       | For all other pins         |
| Input low voltage                  | $V_{IL}$    | -0.3    | 0.7     | V       |                            |
| Input leakage current              | $I_{ILEAK}$ | -35     | 35      | $\mu$ A | Internal resistor included |
| Output leakage current             | $I_{OLEAK}$ | -35     | 35      | $\mu$ A | Internal resistor included |
| Output low current drive strength  | $I_{OL}$    |         | 9       | mA      |                            |
| Output high current drive strength | $I_{OH}$    | -11     |         | mA      |                            |

## 5.2 Current Consumption

The current consumption values listed in this section are based on nominal values and the PHY operating with full-duplex enabled and a 64-bit random data pattern at 100% utilization. Values are grouped by the type of link and whether the on-chip switching regulator is enabled.

### 5.2.1 Consumption with 1000BASE-T Link

The following table shows the current consumption values with a 1000BASE-T link and the on-chip switching regulator enabled.

**Table 55. Current Consumption: 1000BASE-T, Regulator Enabled**

| Parameter                        | Symbol       | Typical                             | Unit |
|----------------------------------|--------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V | $I_{VDD33}$  | 115 (RGMII mode)<br>114 (GMII mode) | mA   |
| Current with $V_{DDREG}$         | $I_{VDDREG}$ | 75 (RGMII mode)<br>76 (GMII mode)   | mA   |

**Table 55. Current Consumption: 1000BASE-T, Regulator Enabled (*continued*)**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 32 (RGMII mode)<br>29 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 23 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 734 (RGMII mode)<br>722 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 686 (RGMII mode)<br>679 (GMII mode) | mW   |

The following table shows the current consumption values with a 1000BASE-T link and the on-chip switching regulator disabled.

**Table 56. Current Consumption: 1000BASE-T, Regulator Disabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 115 (RGMII mode)<br>114 (GMII mode) | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 136 (RGMII mode)<br>135 (GMII mode) | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 34 (RGMII mode)<br>36 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 32 (RGMII mode)<br>29 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 23 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 689 (RGMII mode)<br>677 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 641 (RGMII mode)<br>634 (GMII mode) | mW   |

## 5.2.2 Consumption with 100BASE-TX Link

The following table shows the current consumption values with a 100BASE-TX link and the on-chip switching regulator enabled.

**Table 57. Current Consumption: 100BASE-TX, Regulator Enabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 94 (RGMII mode)<br>92 (GMII mode)   | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 35 (RGMII mode)<br>35 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 5 (RGMII mode)<br>6 (GMII mode)     | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 3 (RGMII mode)<br>4 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 442 (RGMII mode)<br>438 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 433 (RGMII mode)<br>428 (GMII mode) | mW   |

The following table shows the current consumption values with a 100BASE-TX link and the on-chip switching regulator disabled.

**Table 58. Current Consumption: 100BASE-TX, Regulator Disabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 94 (RGMII mode)<br>92 (GMII mode)   | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 55 (RGMII mode)<br>53 (GMII mode)   | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 24 (RGMII mode)<br>25 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 5 (RGMII mode)<br>6 (GMII mode)     | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 3 (RGMII mode)<br>4 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 422 (RGMII mode)<br>417 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 413 (RGMII mode)<br>407 (GMII mode) | mW   |

### 5.2.3 Consumption with 10BASE-T Link

The following table shows the current consumption values with a 10BASE-T link and the on-chip switching regulator enabled.

**Table 59. Current Consumption: 10BASE-T, Regulator Enabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 155 (RGMII mode)<br>152 (GMII mode) | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 19 (RGMII mode)<br>19 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 573 (RGMII mode)<br>563 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 573 (RGMII mode)<br>563 (GMII mode) | mW   |

The following table shows the current consumption values with a 10BASE-T link and the on-chip switching regulator disabled.

**Table 60. Current Consumption: 10BASE-T, Regulator Disabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 155 (RGMII mode)<br>152 (GMII mode) | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 24 (RGMII mode)<br>17 (GMII mode)   | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 18 (RGMII mode)<br>25 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 562 (RGMII mode)<br>552 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 562 (RGMII mode)<br>552 (GMII mode) | mW   |

## 5.2.4 Consumption with No Link and ActiPHY Enabled

The following table shows the current consumption values with no link, ActiPHY enabled, and the on-chip switching regulator enabled.

**Table 61. Current Consumption: No Link, ActiPHY Enabled, Regulator Enabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 21 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 21 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 12 (RGMII mode)<br>2 (GMII mode)    | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 8 (RGMII mode)<br>1 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 178 (RGMII mode)<br>146 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 158 (RGMII mode)<br>142 (GMII mode) | mW   |

The following table shows the current consumption values with no link, ActiPHY enabled, and the on-chip switching regulator disabled.

**Table 62. Current Consumption: No Link, ActiPHY Enabled, Regulator Disabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 21 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 27 (RGMII mode)<br>27 (GMII mode)   | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 20 (RGMII mode)<br>21 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 12 (RGMII mode)<br>2 (GMII mode)    | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 8 (RGMII mode)<br>1 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 165 (RGMII mode)<br>134 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 146 (RGMII mode)<br>129 (GMII mode) | mW   |

## 5.2.5 Consumption with No Link and ActiPHY Disabled

The following table shows the current consumption values with no link, ActiPHY disabled, and the on-chip switching regulator enabled.

**Table 63. Current Consumption: No Link, ActiPHY Disabled, Regulator Enabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 107 (RGMII mode)<br>104 (GMII mode) | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 22 (RGMII mode)<br>22 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 12 (RGMII mode)<br>2 (GMII mode)    | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 8 (RGMII mode)<br>1 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 466 (RGMII mode)<br>423 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 446 (RGMII mode)<br>419 (GMII mode) | mW   |

The following table shows the current consumption values with no link, ActiPHY disabled, and the on-chip switching regulator disabled.

**Table 64. Current Consumption: No Link, ActiPHY Disabled, Regulator Disabled**

| Parameter                             | Symbol           | Typical                             | Unit |
|---------------------------------------|------------------|-------------------------------------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 107 (RGMII mode)<br>104 (GMII mode) | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 27 (RGMII mode)<br>27 (GMII mode)   | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 23 (RGMII mode)<br>23 (GMII mode)   | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 12 (RGMII mode)<br>2 (GMII mode)    | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 8 (RGMII mode)<br>1 (GMII mode)     | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | < 1 (RGMII mode)<br>< 1 (GMII mode) | mA   |
| Total power at 3.3 V                  |                  | 453 (RGMII mode)<br>410 (GMII mode) | mW   |
| Total power at 2.5 V                  |                  | 433 (RGMII mode)<br>406 (GMII mode) | mW   |

## 5.2.6 Consumption in Power-Down Mode

The following table shows the current consumption values in power-down mode (register address 0.11 = 1) with the regulator enabled.

**Table 65. Current Consumption: Power-Down, Regulator Enabled**

| Parameter                             | Symbol           | Typical | Unit |
|---------------------------------------|------------------|---------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 15      | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 15      | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 0       | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 0       | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 0       | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Total power at 3.3 V                  |                  | 99      | mW   |

The following table shows the current consumption values in power-down mode (register address 0.11 = 1) with the regulator disabled.

**Table 66. Current Consumption: Power-Down, Regulator Disabled**

| Parameter                             | Symbol           | Typical | Unit |
|---------------------------------------|------------------|---------|------|
| Current with $V_{DD33}$ at 3.3 V      | $I_{VDD33}$      | 15      | mA   |
| Current with $V_{DDREG}$              | $I_{VDDREG}$     | 0       | mA   |
| Current with $V_{DD12}$ at 1.2 V      | $I_{VDD12}$      | 12      | mA   |
| Current with $V_{DD12A}$ at 1.2 V     | $I_{VDD12A}$     | 20      | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V   | $I_{VDDIOMAC}$   | 0       | mA   |
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Total power at 3.3 V                  |                  | 87.9    | mW   |

## 5.2.7 Consumption in Reset State

The following table shows the current consumption values in the reset state (NRESET pin pulled low).

**Table 67. Current Consumption: Reset State**

| Parameter                           | Symbol         | Typical | Unit |
|-------------------------------------|----------------|---------|------|
| Current with $V_{DD33}$ at 3.3 V    | $I_{VDD33}$    | 7       | mA   |
| Current with $V_{DDREG}$            | $I_{VDDREG}$   | 0       | mA   |
| Current with $V_{DD12}$ at 1.2 V    | $I_{VDD12}$    | 0       | mA   |
| Current with $V_{DD12A}$ at 1.2 V   | $I_{VDD12A}$   | 0       | mA   |
| Current with $V_{DDIOMAC}$ at 3.3 V | $I_{VDDIOMAC}$ | 0       | mA   |

**Table 67. Current Consumption: Reset State (continued)**

| Parameter                             | Symbol           | Typical | Unit |
|---------------------------------------|------------------|---------|------|
| Current with $V_{DDIOMAC}$ at 2.5 V   | $I_{VDDIOMAC}$   | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 3.3 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Current with $V_{DDIOMICRO}$ at 2.5 V | $I_{VDDIOMICRO}$ | 0       | mA   |
| Total power at 3.3 V                  |                  | 23.1    | mW   |

## 5.3 AC Characteristics

The AC specifications are grouped according to specific device pins and associated timing characteristics.

### 5.3.1 Reference Clock Input

The following table lists the specifications for the reference clock input frequency including various frequencies, duty cycle, and accuracy.

**Table 68. AC Characteristics for REFCLK Input**

| Parameter                                 | Symbol       | Minimum | Typical | Maximum | Unit |
|-------------------------------------------|--------------|---------|---------|---------|------|
| Frequency with 25 MHz input               | $f_{CLK25}$  |         | 25      |         | MHz  |
| Frequency with 125 MHz input              | $f_{CLK125}$ |         | 125     |         | MHz  |
| Frequency accuracy                        | $f_{TOL}$    |         |         | 50      | ppm  |
| Duty cycle                                | $\%DUTY$     | 40      |         | 60      | %    |
| Rise time with 25 MHz input (20% to 80%)  | $t_{R25}$    |         |         | 4       | ns   |
| Rise time with 125 MHz input (20% to 80%) | $t_{R125}$   |         |         | 1       | ns   |

When using the 25 MHz crystal clock input option, the additional specifications in the following table are required.

**Table 69. AC Characteristics for REFCLK Input with 25 MHz Clock Input**

| Parameter                            | Minimum | Typical | Maximum | Unit     |
|--------------------------------------|---------|---------|---------|----------|
| Crystal parallel load capacitance    | 18      |         | 20      | pF       |
| Crystal equivalent series resistance |         | 10      | 30      | $\Omega$ |

### 5.3.2 Clock Output

The specifications in the following table show the AC characteristics for the clock output of the VSC8641 device.

**Table 70. AC Characteristics for the CLKOUT Pin**

| Parameter        | Symbol    | Minimum | Typical | Maximum | Unit | Condition            |
|------------------|-----------|---------|---------|---------|------|----------------------|
| CLKOUT frequency | $f_{CLK}$ |         | 125.00  |         | MHz  | 125 MHz output clock |

**Table 70. AC Characteristics for the CLKOUT Pin (*continued*)**

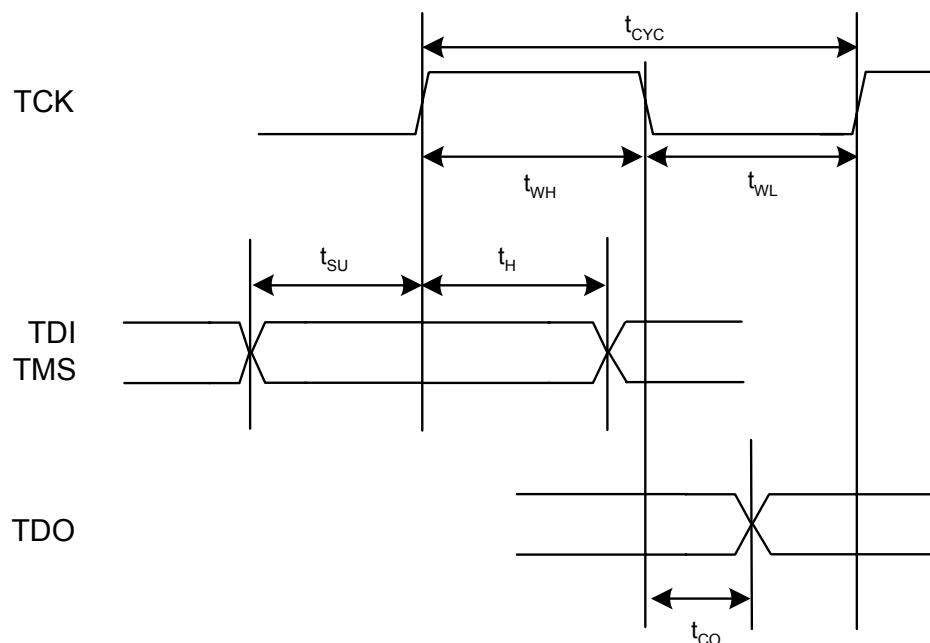
| Parameter                              | Symbol          | Minimum | Typical | Maximum | Unit | Condition                                  |
|----------------------------------------|-----------------|---------|---------|---------|------|--------------------------------------------|
| CLKOUT cycle time                      | $t_{CYC}$       |         | 8.0     |         | ns   | 125 MHz output clock                       |
| Frequency stability                    | $f_{STABILITY}$ |         |         | 50      | ppm  |                                            |
| Duty cycle                             | $\%_{DUTY}$     | 44      | 50      | 56      | %    |                                            |
| Clock rise and fall times (20% to 80%) | $t_R$ and $t_F$ |         |         | 1       | ns   |                                            |
| Total jitter                           | $J_{CLK}$       |         | 217     | 600     | ps   | Measured peak-to-peak, time interval error |

### 5.3.3 JTAG Interface

The following table lists the characteristics for the JTAG testing feature. For information about the JTAG interface timing, see [Figure 19](#), page 83.

**Table 71. AC Characteristics for the JTAG Interface**

| Parameter                 | Symbol    | Minimum | Maximum | Unit |
|---------------------------|-----------|---------|---------|------|
| TCK frequency             | $f_{CLK}$ |         | 10      | MHz  |
| TCK cycle time            | $t_{CYC}$ | 100     |         | ns   |
| TCK time high             | $t_{WH}$  | 45      |         | ns   |
| TCK time low              | $t_{WL}$  | 45      |         | ns   |
| Setup time to TCK rising  | $t_{SU}$  | 10      |         | ns   |
| Hold time from TCK rising | $t_H$     | 10      |         | ns   |
| TCK to TDO valid          | $t_{CO}$  |         | 15      | ns   |

**Figure 19. JTAG Interface Timing**


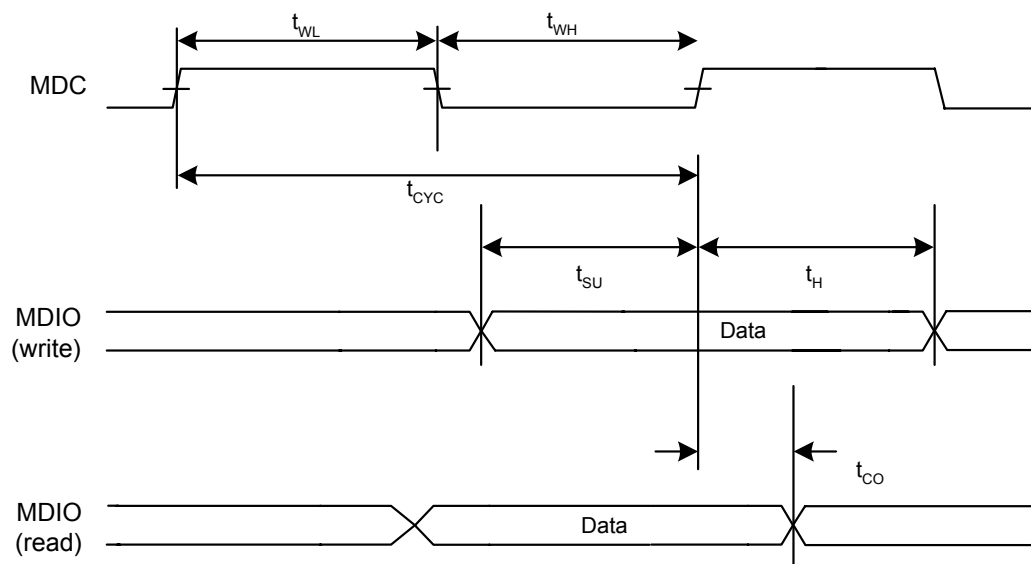
### 5.3.4 SMI Interface

Use the information in the following table when incorporating the VSC8641 device SMI interface into your own design. For information about the SMI interface timing, see [Figure 20](#), page 84.

**Table 72. AC Characteristics for the SMI Interface**

| Parameter                    | Symbol    | Minimum | Typical | Maximum                            | Unit | Condition                                                        |
|------------------------------|-----------|---------|---------|------------------------------------|------|------------------------------------------------------------------|
| MDC frequency <sup>(1)</sup> | $f_{CLK}$ |         | 2.5     | 12.5                               | MHz  |                                                                  |
| MDC cycle time               | $t_{CYC}$ | 80      | 400     |                                    | ns   |                                                                  |
| MDC time high                | $t_{WH}$  | 20      | 50      |                                    | ns   |                                                                  |
| MDC time low                 | $t_{WL}$  | 20      | 50      |                                    | ns   |                                                                  |
| Setup to MDC rising          | $t_{SU}$  | 10      |         |                                    | ns   |                                                                  |
| Hold from MDC rising         | $t_H$     | 10      |         |                                    | ns   |                                                                  |
| MDC rise time                | $t_R$     |         |         | 100<br>$t_{CYC} \times 10\%^{(1)}$ | ns   | For MDC = 0 – 1 MHz<br>For MDC = 1 MHz – $f_{CLK}(MAX)$          |
| MDC fall time                | $t_F$     |         |         | 100<br>$t_{CYC} \times 10\%^{(1)}$ | ns   |                                                                  |
| MDC to MDIO valid            | $t_{CO}$  |         | 10      | 300                                | ns   | Time dependant on value of external pull-up resistor on MDIO pin |

- For  $f_{CLK}$  above 1 MHz, the maximum rise time and fall time is in relation to the frequency of the MDC clock period. For example, if  $f_{CLK}$  is 2 MHz, the maximum clock rise time and fall time is 50 ns.

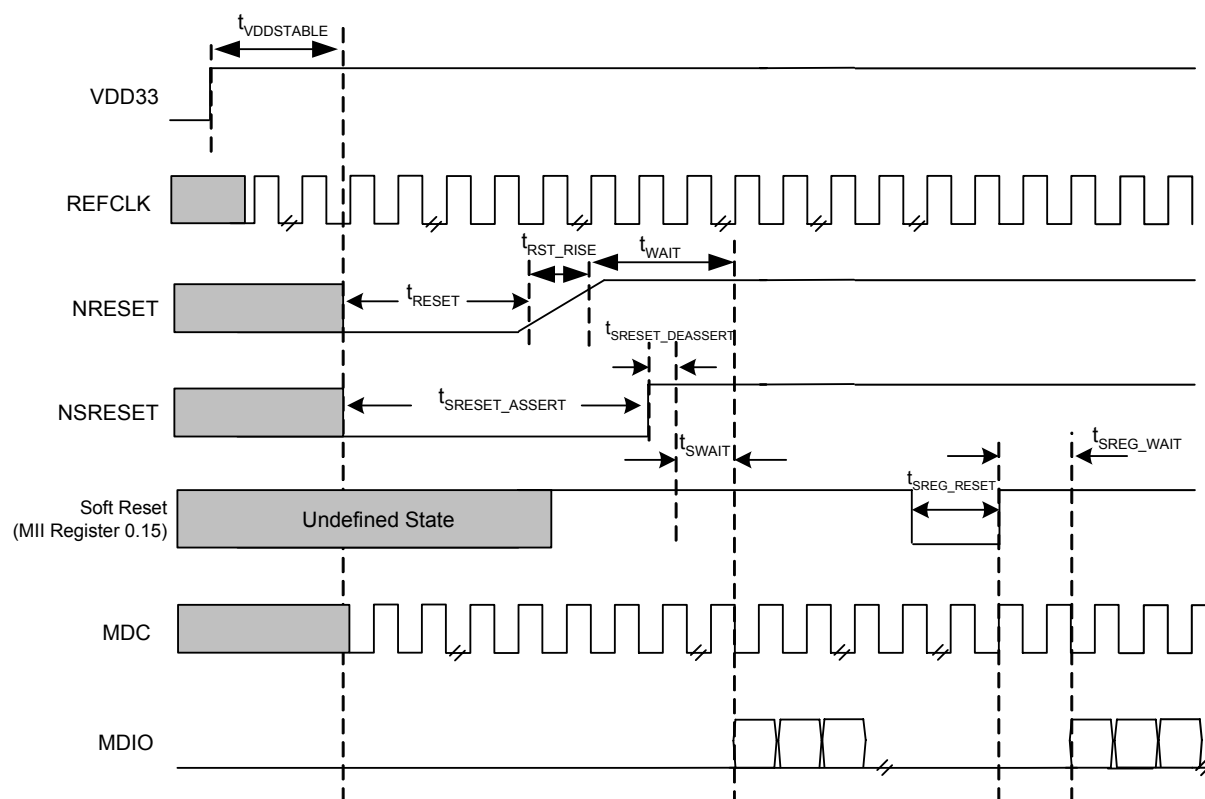
**Figure 20. SMI Interface Timing**


### 5.3.5 Device Reset

The following specifications apply to the device reset functionality. For information about the reset timing, see [Figure 21](#), page 85.

**Table 73. AC Characteristics for Device Reset**

| Parameter                                                                                  | Symbol                 | Minimum | Maximum | Unit    | Condition                                                     |
|--------------------------------------------------------------------------------------------|------------------------|---------|---------|---------|---------------------------------------------------------------|
| NRESET assertion time                                                                      | $t_{RESET}$            | 100     |         | ns      |                                                               |
| Wait time between NRESET de-assert and access of the SMI interface                         | $t_{WAIT}$             | 20      |         | ms      | Register 21E.14 = 0                                           |
|                                                                                            |                        | 220     |         | ms      | Register 21E.14 = 1                                           |
| Soft reset (pin) assertion                                                                 | $t_{SRESET\_ASSERT}$   | 4       |         | ms      |                                                               |
| Soft reset (pin) de-assertion                                                              | $t_{SRESET\_DEASSERT}$ | 4       |         | ms      |                                                               |
| Reset rise time                                                                            | $t_{RST\_RISE}$        | 0       |         | ms      | If REG_EN pin = 0                                             |
|                                                                                            |                        | 25      |         | ms      | If REG_EN pin = 1<br>Measured from a 10% level to a 90% level |
| Supply stable time                                                                         | $t_{VDDSTABLE}$        | 10      |         | ms      |                                                               |
| Wait time between soft reset pin de-assert and access of the SMI interface                 | $t_{SWAIT}$            | 4       |         | $\mu$ s | Registers 28.1 = 1, 21E.14 = 0                                |
|                                                                                            |                        | 300     |         | $\mu$ s | Registers 28.1 = 0, 21E.14 = 0                                |
|                                                                                            |                        | 200     |         | ms      | Registers 28.1 = 0, 21E.14 = 1                                |
|                                                                                            |                        | 200     |         | ms      | Registers 28.1 = 1, 21E.14 = 1                                |
| Soft reset MII register 0.15 assertion                                                     | $t_{SREG\_RESET}$      | 100     |         | ns      |                                                               |
| Wait time between Soft Reset (MII Register 0.15) de-assert and access to the SMI interface | $t_{SREG\_WAIT}$       | 4       |         | $\mu$ s | Registers 18.1 = 1, 21E.14 = 0                                |
|                                                                                            |                        | 300     |         | $\mu$ s | Registers 18.1 = 0, 21E.14 = 0                                |
|                                                                                            |                        | 200     |         | ms      | Registers 18.1 = 0, 21E.14 = 1                                |
|                                                                                            |                        | 200     |         | ms      | Registers 18.1 = 1, 21E.14 = 1                                |

**Figure 21. Reset Timing**


**Note** The NRESET and NSRESET are mutually exclusive.

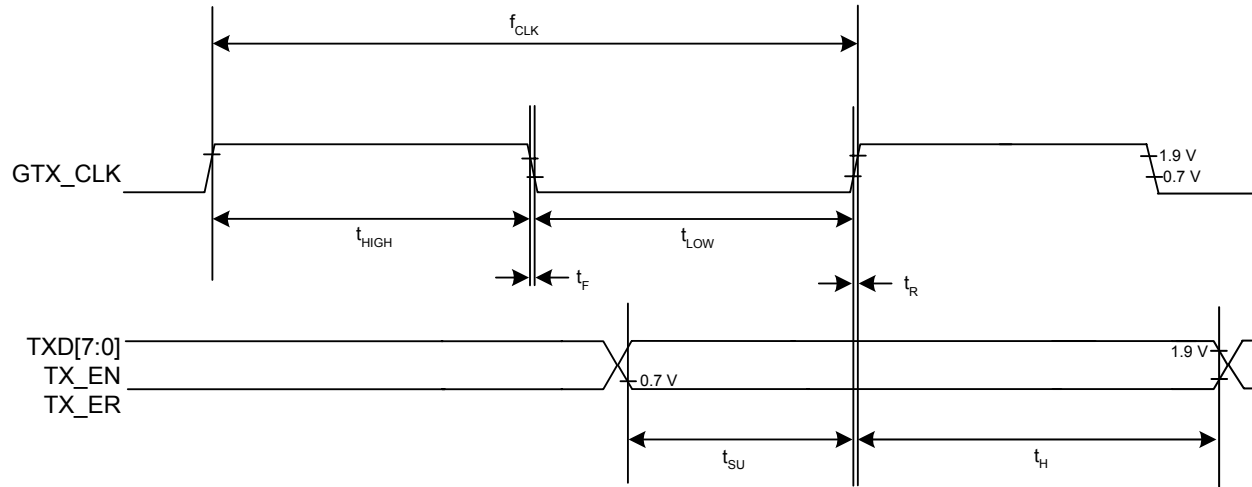
### 5.3.6 GMII Transmit

The following table lists the characteristics when using the device in GMII transmit mode. For information about the GMII transmit timing, see [Figure 22](#), page 86.

**Table 74. AC Characteristics for GMII Transmit**

| Parameter                   | Symbol                            | Minimum | Typical | Maximum | Unit | Condition                    |
|-----------------------------|-----------------------------------|---------|---------|---------|------|------------------------------|
| Clock frequency             | f <sub>CLK</sub>                  |         | 125     |         | MHz  |                              |
| Frequency offset tolerance  | f <sub>TOL</sub>                  | -100    |         | 100     | ppm  |                              |
| Pulse width high            | t <sub>HIGH</sub>                 | 2.5     |         |         | ns   |                              |
| Pulse width low             | t <sub>LOW</sub>                  | 2.5     |         |         | ns   |                              |
| Setup to GTX_CLK rising     | t <sub>SU</sub>                   | 2.0     |         |         | ns   |                              |
| Hold from GTX_CLK rising    | t <sub>H</sub>                    | 0       |         |         | ns   |                              |
| GTX_CLK rise and fall times | t <sub>R</sub> and t <sub>F</sub> |         |         | 1.0     | ns   | Measured from 0.7 V to 1.9 V |

**Figure 22. GMII Transmit Timing**



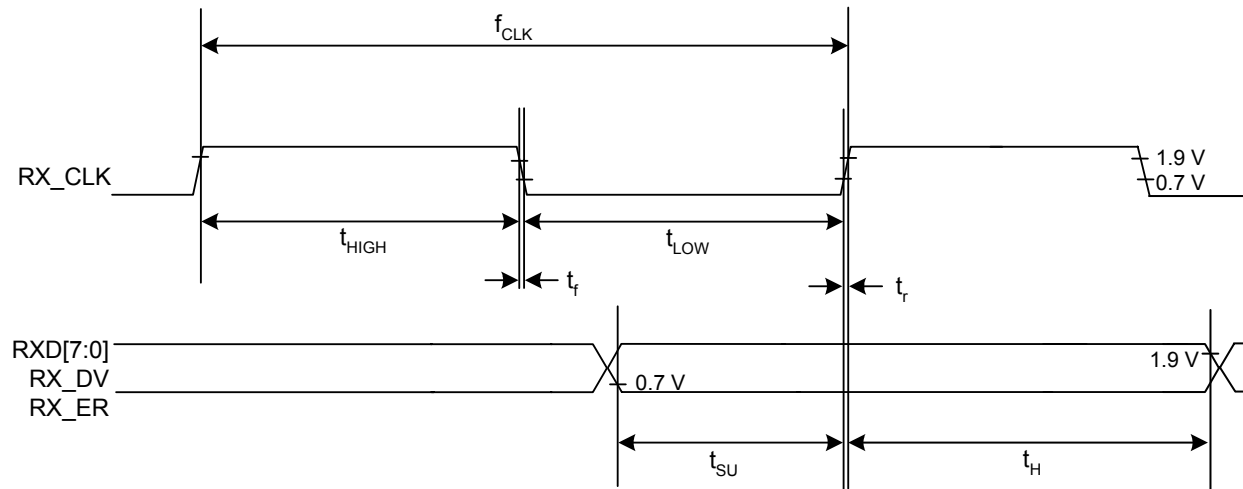
### 5.3.7 GMII Receive

The following table lists the characteristics when using the device in GMII receive mode. For information about the GMII receive timing, see [Figure 23](#), page 87.

**Table 75. AC Characteristics for GMII Transmit**

| Parameter                  | Symbol          | Minimum | Typical | Maximum | Unit | Condition                    |
|----------------------------|-----------------|---------|---------|---------|------|------------------------------|
| Clock frequency            | $f_{CLK}$       |         | 125     |         | MHz  |                              |
| Frequency offset tolerance | $f_{TOL}$       | -100    |         | 100     | ppm  |                              |
| Pulse width high           | $t_{HIGH}$      | 2.5     |         |         | ns   |                              |
| Pulse width low            | $t_{LOW}$       | 2.5     |         |         | ns   |                              |
| Setup to RX_CLK rising     | $t_{SU}$        | 2.5     |         |         | ns   |                              |
| Hold from RX_CLK rising    | $t_H$           | 0.5     |         |         | ns   |                              |
| RX_CLK rise and fall times | $t_R$ and $t_F$ |         |         | 1.0     | ns   | Measured from 0.7 V to 1.9 V |

**Figure 23. GMII Receive Timing**



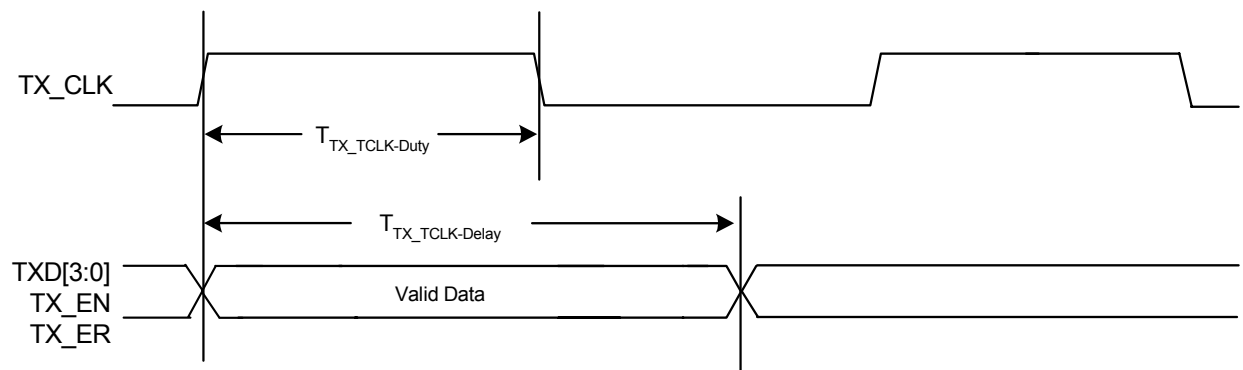
### 5.3.8 MII Transmit

The following table lists the characteristics when using the device in MII transmit mode. For information about the MII transmit timing, see [Figure 24](#), page 87.

**Table 76. AC Characteristics for MII Transmit**

| Parameter                              | Symbol      | Minimum | Maximum | Unit |
|----------------------------------------|-------------|---------|---------|------|
| TX_CLK to TXD[3:0], TX_EN, TX_ER Delay | $t_{DELAY}$ | 0       | 25      | ns   |
| TX_CLK Duty Cycle                      | $t_{DUTY}$  | 35      | 65      | %    |

**Figure 24. MII Transmit Timing**



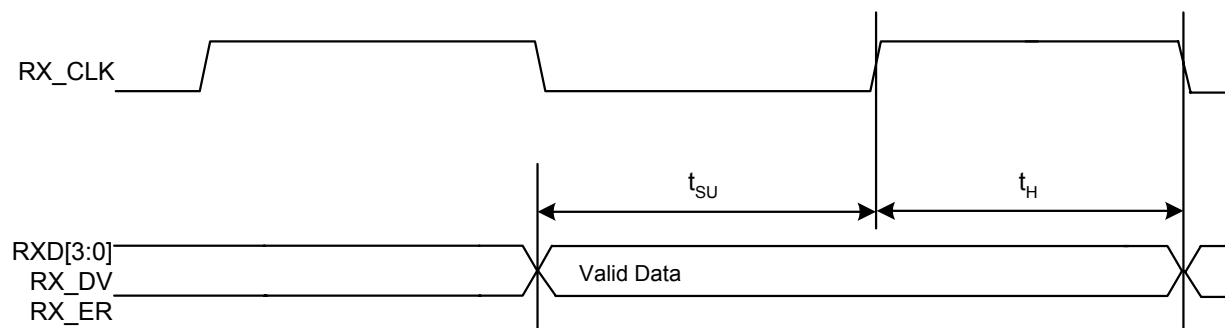
### 5.3.9 MII Receive

The following table lists the characteristics when using the device in MII receive mode. For information about the MII receive timing, see [Figure 25](#), page 88.

**Table 77. AC Characteristics for MII Receive**

| Parameter               | Symbol   | Minimum | Unit |
|-------------------------|----------|---------|------|
| Setup to RX_CLK rising  | $t_{SU}$ | 10      | ns   |
| Hold from RX_CLK rising | $t_H$    | 10      | ns   |

**Figure 25. MII Receive Timing**



### 5.3.10 RGMII Uncompensated

The following table lists the characteristics when using the device in RGMII uncompensated mode. For information about the RGMII uncompensated timing, see [Figure 26](#), page 89.

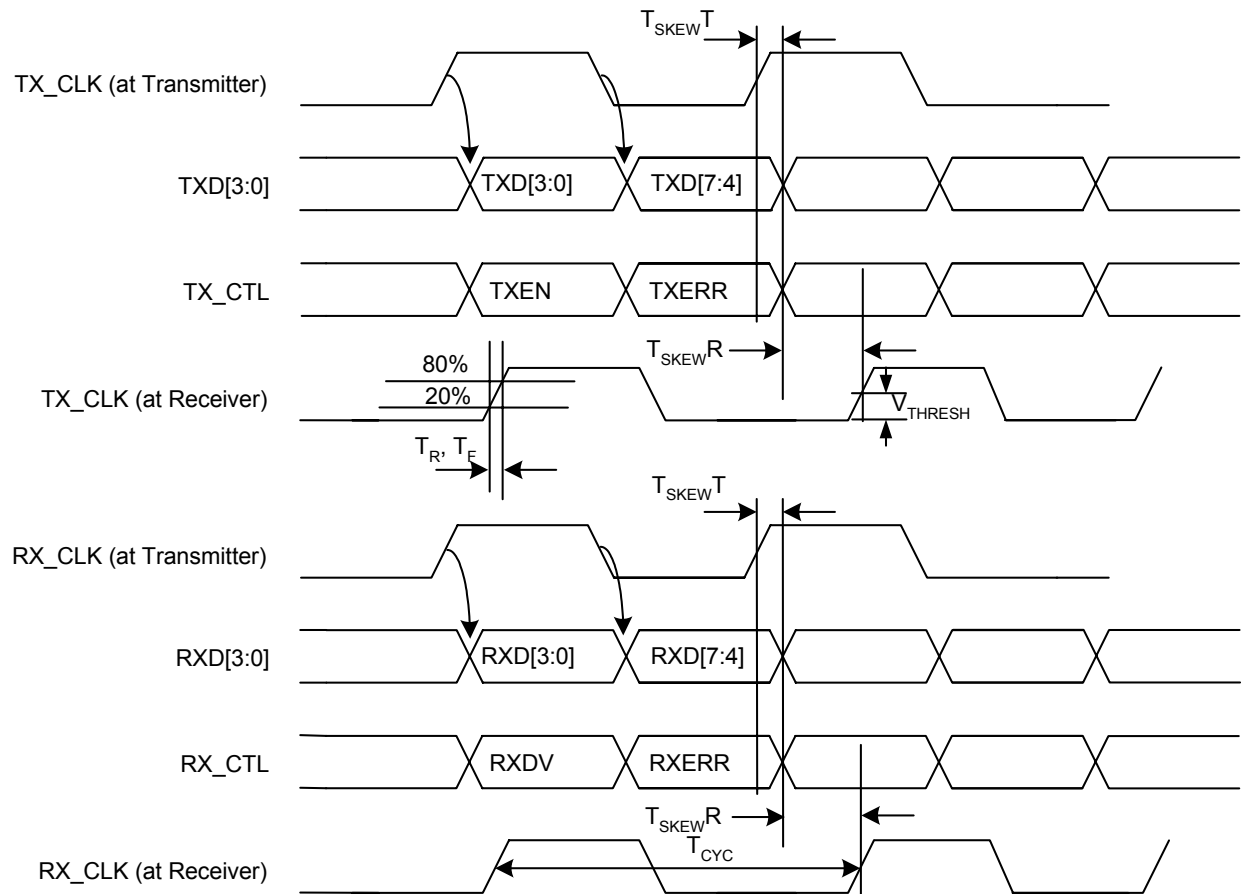
**Table 78. AC Characteristics for RGMII Uncompensated**

| Parameter                               | Symbol           | Minimum | Typical          | Maximum | Unit | Condition                                                                     |
|-----------------------------------------|------------------|---------|------------------|---------|------|-------------------------------------------------------------------------------|
| Clock frequency                         |                  |         | 125<br>25<br>2.5 |         | MHz  | 1000BASE-T operation<br>100BASE-TX operation<br>10BASE-T operation            |
| 1000BASE-T duty cycle                   | $t_{DUTY1000}$   | 45      | 50               | 55      | %    | At room temperature and nominal supply and register 28E.13:12 set to 10 or 11 |
| 1000BASE-T duty cycle                   | $t_{DUTY1000}$   | 40      | 50               | 60      | %    | Register 28E.13:12 set to 00 or 01                                            |
| 10/100BASE-T duty cycle                 | $t_{DUTY10/100}$ | 40      | 50               | 60      | %    |                                                                               |
| Data to clock output skew (at PHY)      | $t_{SKEW}^T$     | -500    | 0                | 500     | ps   |                                                                               |
| Data to clock output skew (at receiver) | $t_{SKEW}^R$     | 1.0     | 1.8              | 2.6     | ns   |                                                                               |

**Table 78. AC Characteristics for RGMII Uncompensated (*continued*)**

| Parameter                  | Symbol          | Minimum | Typical      | Maximum | Unit   | Condition                                                    |
|----------------------------|-----------------|---------|--------------|---------|--------|--------------------------------------------------------------|
| TX_CLK switching threshold | $V_{THRESH}$    |         | 1.25<br>1.65 |         | V<br>V | $V_{DDIOMAC} = 2.5\text{ V}$<br>$V_{DDIOMAC} = 3.3\text{ V}$ |
| TX_CLK rise and fall times | $t_R$ and $t_F$ |         |              | 750     | ps     |                                                              |

**Figure 26. RGMII Uncompensated Timing**



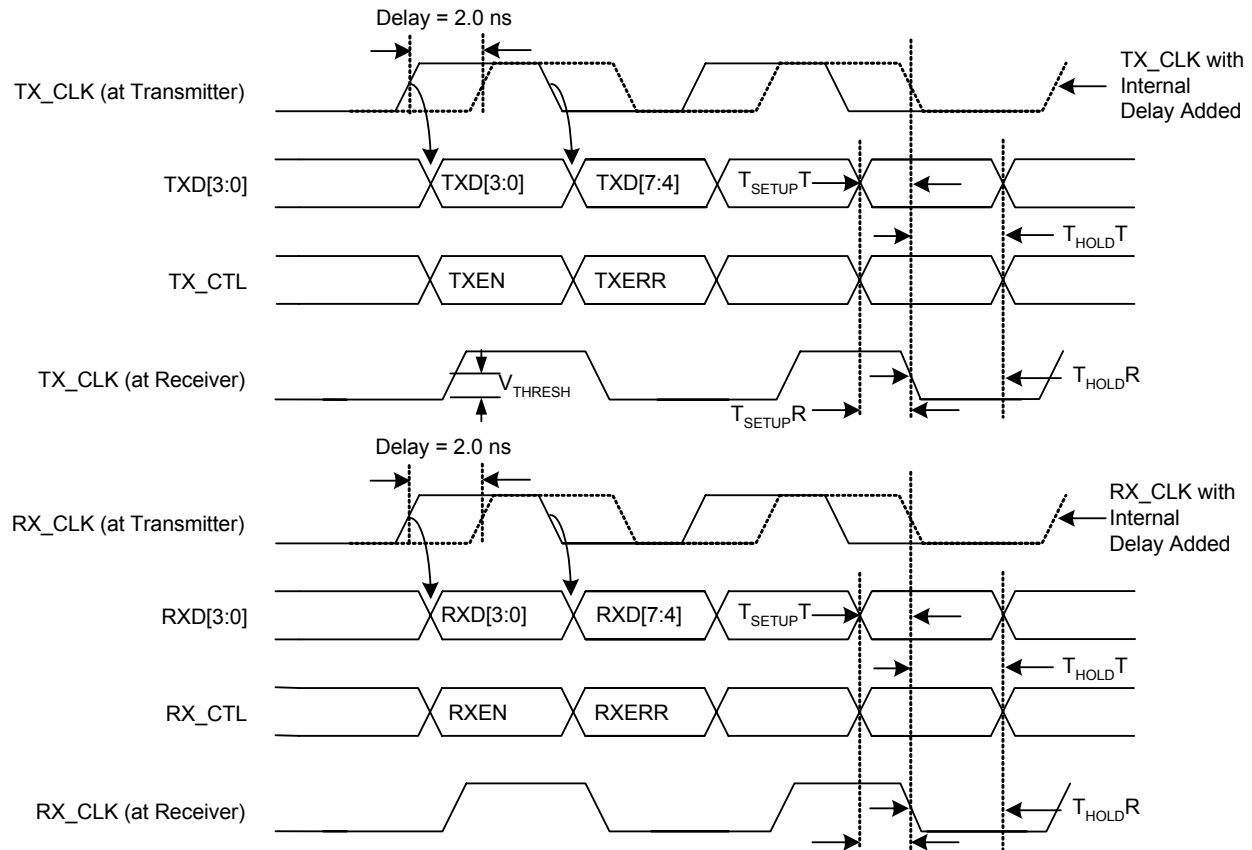
### 5.3.11 RGMII Compensated

The following table lists the characteristics when using the device in RGMII compensated mode. For information about the RGMII compensated timing, see [Figure 27](#), page 91.

**Table 79. AC Characteristics for RGMII Compensated**

| Parameter                                                   | Symbol              | Minimum | Typical | Maximum | Unit | Condition                            |
|-------------------------------------------------------------|---------------------|---------|---------|---------|------|--------------------------------------|
| Data to clock output setup (at PHY integrated delay)        | $t_{\text{SETUP}T}$ | 1.2     | 2.0     | 3       | ns   |                                      |
| Data to clock output setup (at receiver integrated delay)   | $t_{\text{SETUP}R}$ | 1.0     | 2.0     | 3       | ns   |                                      |
| Data to clock output hold (at transmitter integrated delay) | $t_{\text{HOLD}T}$  | 1.2     | 2.0     | 3       | ns   |                                      |
| Data to clock output hold (at PHY integrated delay)         | $t_{\text{HOLD}R}$  | 1.0     | 2.0     | 3       | ns   |                                      |
| TX_CLK switching threshold                                  | $V_{\text{THRESH}}$ |         | 1.25    |         | V    | $V_{\text{DDIOMAC}} = 2.5 \text{ V}$ |
|                                                             |                     |         | 1.65    |         | V    | $V_{\text{DDIOMAC}} = 3.3 \text{ V}$ |

**Figure 27. RGMII Compensated Timing**



## 5.4 Operating Conditions

The following table lists the recommended operating conditions for the VSC8641 device.

**Table 80. Recommended Operating Conditions**

| Parameter                                         | Symbol          | Minimum | Typical | Maximum | Unit |
|---------------------------------------------------|-----------------|---------|---------|---------|------|
| Power supply voltage for $V_{DDIOMICRO}$ at 2.5 V | $V_{DDIOMICRO}$ | 2.37    | 2.5     | 2.63    | V    |
| Power supply voltage for $V_{DDIOMICRO}$ at 3.3 V | $V_{DDIOMICRO}$ | 3.0     | 3.3     | 3.6     | V    |
| Power supply voltage for $V_{DDIOMAC}$ at 2.5 V   | $V_{DDIOMAC}$   | 2.37    | 2.5     | 2.63    | V    |
| Power supply voltage for $V_{DDIOMAC}$ at 3.3 V   | $V_{DDIOMAC}$   | 3.0     | 3.3     | 3.6     | V    |
| Power supply voltage for $V_{DD33}$               | $V_{DD33}$      | 3.0     | 3.3     | 3.6     | V    |
| Power supply voltage for $V_{DDREG}$              | $V_{DDREG}$     | 3.0     | 3.3     | 3.6     | V    |
| Power supply voltage for $V_{DD12}$               | $V_{DD12}$      | 1.14    | 1.2     | 1.26    | V    |

**Table 80. Recommended Operating Conditions (*continued*)**

| Parameter                                       | Symbol             | Minimum | Typical | Maximum | Unit |
|-------------------------------------------------|--------------------|---------|---------|---------|------|
| Power supply voltage for V <sub>DD12A</sub>     | V <sub>DD12A</sub> | 1.14    | 1.2     | 1.26    | V    |
| VSC8641 operating temperature <sup>(1)</sup>    | T                  | 0       |         | 90      | °C   |
| VSC8641-03 operating temperature <sup>(1)</sup> | T                  | −40     |         | 90      | °C   |

1. Lower limit of specification is ambient temperature, and upper limit is case temperature.

## 5.5 Stress Ratings

This section contains the stress ratings for the VSC8641 device.

**Warning** Stresses listed in the following table may be applied to devices one at a time without causing permanent damage. Functionality at or exceeding the values listed is not implied. Exposure to these values for extended periods may affect device reliability.

**Table 81. Stress Ratings**

| Parameter                                             | Symbol                 | Minimum | Maximum               | Unit |
|-------------------------------------------------------|------------------------|---------|-----------------------|------|
| DC input voltage on V <sub>DDIOMICRO</sub> supply pin | V <sub>DDIOMICRO</sub> | −0.5    | 4.0                   | V    |
| DC input voltage on V <sub>DDIOMAC</sub> supply pin   | V <sub>DDIOMAC</sub>   | −0.5    | 4.0                   | V    |
| DC input voltage on V <sub>DD33</sub> supply pin      | V <sub>DD33</sub>      | −0.5    | 4.0                   | V    |
| DC input voltage on V <sub>DDREG</sub> supply pin     | V <sub>DDREG</sub>     | −0.5    | 4.0                   | V    |
| DC input voltage on V <sub>DD12</sub> supply pin      | V <sub>DD12</sub>      | −0.5    | 1.5                   | V    |
| DC input voltage on V <sub>DD12A</sub> supply pin     | V <sub>DD12A</sub>     | −0.5    | 1.5                   | V    |
| DC input voltage on JTAG pins, 5 V tolerant           | V <sub>DD</sub> (5 V)  | −0.5    | 5.5                   | V    |
| DC input voltage on any non-supply pin                | V <sub>DD</sub> (PIN)  | −0.5    | V <sub>DD</sub> + 0.5 | V    |
| Storage temperature                                   | T <sub>S</sub>         | −65     | 150                   | °C   |
| Electrostatic discharge voltage, charged device model | V <sub>ESD_CDM</sub>   | −500    | 500                   | V    |
| Electrostatic discharge voltage, human body model     | V <sub>ESD_HBM</sub>   | −1750   | 1750                  | V    |

**Warning** This device can be damaged by electrostatic discharge (ESD) voltage. Vitesse recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures may adversely affect reliability of the device.

## 6 Pin Descriptions

The VSC8641 device is available in two package types. VSC8641XJF is an 88-pin package. VSC8641XKO and VSC8641XKO-03 are 100-pin packages.

This section contains the pin descriptions. The pin information is also provided as attached Microsoft Excel files. This allows you to copy the information electronically. In Adobe Reader, double-click the attachment icon.

The following table contains notations for definitions of the various pin types.

**Table 82. Pin Type Symbols**

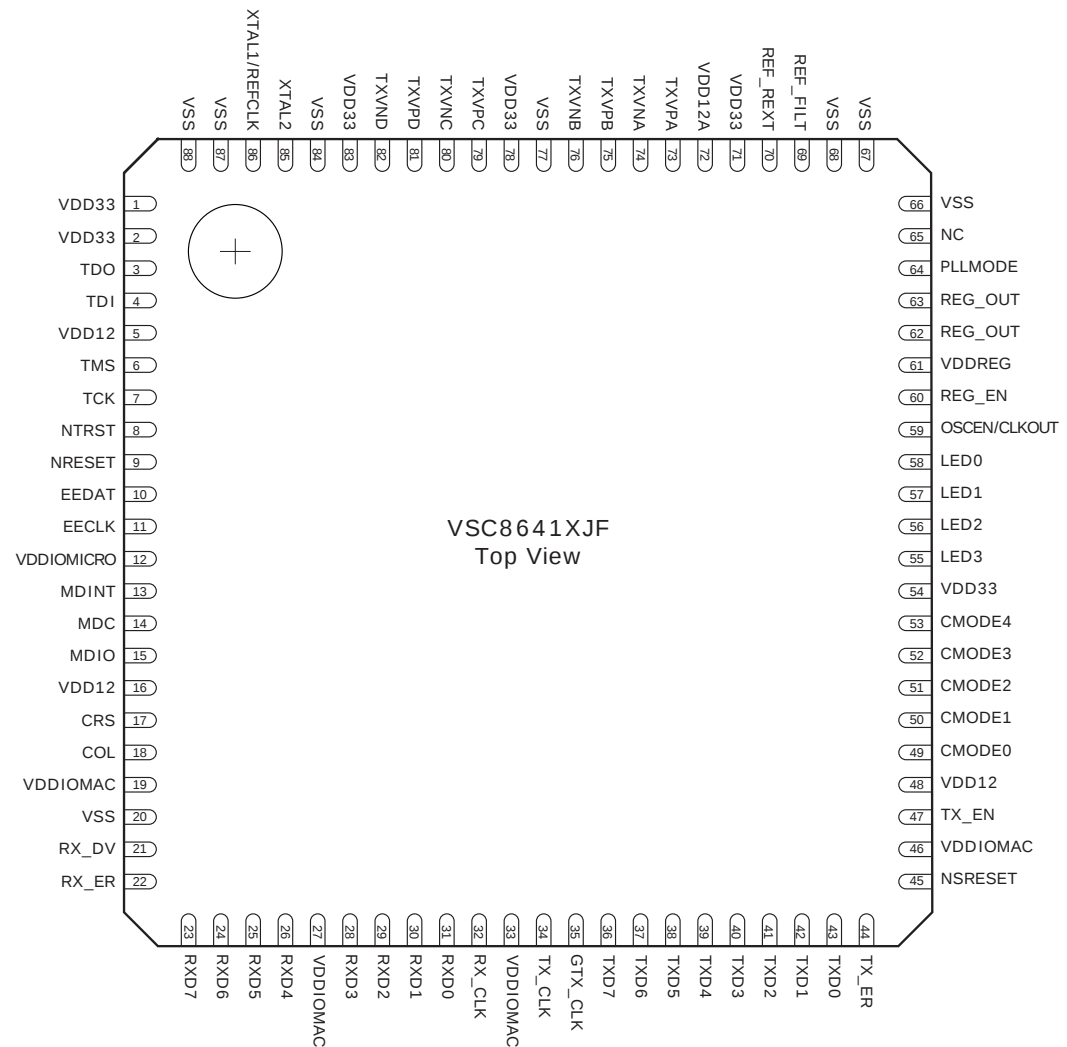
| Symbol             | Pin Type                     | Description                                                                               |
|--------------------|------------------------------|-------------------------------------------------------------------------------------------|
| I                  | Input                        | Input with no on-chip pull-up or pull-down resistor.                                      |
| I/O                | Input and Output             | Input and output signal with no on-chip pull-up or pull-down resistor.                    |
| I <sub>PU</sub>    | Input with pull-up           | Input with on-chip 100 k $\Omega$ pull-up resistor to VDDIO.                              |
| I <sub>PD</sub>    | Input with pull-down         | Input with on-chip 100 k $\Omega$ pull-down resistor to VSS.                              |
| I <sub>PD</sub> /O | Bidirectional with pull-down | Input and output signal with on-chip 100 k $\Omega$ pull-down resistor to VSS.            |
| I <sub>PU</sub> /O | Bidirectional with pull-up   | Input and output signal with on-chip 100 k $\Omega$ pull-up resistor to VDDIO or VDD33.   |
| O                  | Output                       | Output signal.                                                                            |
| O <sub>ZC</sub>    | Impedance controlled output  | Integrated (on-chip) source series terminated, output signal.                             |
| OD                 | Open drain                   | Open drain output.                                                                        |
| OS                 | Open source                  | Open source output.                                                                       |
| A <sub>DIFF</sub>  | Analog differential          | Analog differential signal pair for twisted pair interface.                               |
| A <sub>BIAS</sub>  | Analog bias                  | Analog bias pin.                                                                          |
| I <sub>A</sub>     | Analog input                 | Analog Input for sensing variable voltage levels.                                         |
| I <sub>PU5V</sub>  | Input with pull-up           | Input with on-chip 100 k $\Omega$ pull-up resistor to VDD33. These pins are 5 V tolerant. |
| O <sub>CRYST</sub> | Crystal output               | Crystal clock output pin. If not used, leave unconnected.                                 |
| NC                 | No connect                   | No connect pins must be left floating.                                                    |

## 6.1 Pin Diagram (VSC8641XJF)

The following illustration shows the pin diagram for the VSC8641XJF device.

**Note** The exposed pad is internally connected to ground and should be connected to VSS on the board as well.

**Figure 28. Pin Diagram for VSC8641XJF**



## 6.2 Pins By Function (VSC8641XJF)

This section contains the functional pin descriptions for the VSC8641XJF device.

### 6.2.1 Twisted Pair Interface

The following table lists the device pins associated with the device two-wire, twisted pair interface.

**Table 83. Twisted Pair Interface Pins**

| Pin | Name  | Type              | Description                     |
|-----|-------|-------------------|---------------------------------|
| 73  | TXVPA | A <sub>DIFF</sub> | TX/RX channel A positive signal |
| 74  | TXVNA | A <sub>DIFF</sub> | TX/RX channel A negative signal |
| 75  | TXVPB | A <sub>DIFF</sub> | TX/RX channel B positive signal |
| 76  | TXVNB | A <sub>DIFF</sub> | TX/RX channel B negative signal |
| 79  | TXVPC | A <sub>DIFF</sub> | TX/RX channel C positive signal |
| 80  | TXVNC | A <sub>DIFF</sub> | TX/RX channel C negative signal |
| 81  | TXVPD | A <sub>DIFF</sub> | TX/RX channel D positive signal |
| 82  | TXVND | A <sub>DIFF</sub> | TX/RX channel D negative signal |

### 6.2.2 GMII/RGMII MAC Interface

The following table lists the device pins associated with the GMII/RGMII MAC interface. Note that the pins in this table are referenced to VDDIO<sub>MAC</sub> and can be set to a 2.5 V or 3.3 V power supply.

**Table 84. GMII/RGMII MAC Interface Pins**

| Pin | Name   | Type            | Description                                                                                                                                                                                                                                                           |
|-----|--------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23  | RXD7   | O <sub>ZC</sub> | GMII Mode:<br>Receive data [7:4] pins. These pins are synchronously output on the rising edge of RX_CLK.<br><br>RGMII Mode:<br>Not used. Leave unconnected.                                                                                                           |
| 24  | RXD6   |                 |                                                                                                                                                                                                                                                                       |
| 25  | RXD5   |                 |                                                                                                                                                                                                                                                                       |
| 26  | RXD4   |                 |                                                                                                                                                                                                                                                                       |
| 28  | RXD3   | O <sub>ZC</sub> | GMII Mode:<br>Receive data [3:0] pins. These pins are synchronously output on the rising edge of RX_CLK.<br><br>RGMII Mode:<br>Multiplexed receive data. Bits[3:0] are synchronously output on the rising edge of RX_CLK and bits[7:4] on the falling edge of RX_CLK. |
| 29  | RXD2   |                 |                                                                                                                                                                                                                                                                       |
| 30  | RXD1   |                 |                                                                                                                                                                                                                                                                       |
| 31  | RXD0   |                 |                                                                                                                                                                                                                                                                       |
| 32  | RX_CLK | O <sub>ZC</sub> | Receive clock. Receive data is sourced from the PHY synchronously on the rising edge of RX_CLK and is the recovered clock from the media.                                                                                                                             |

**Table 84. GMII/RGMII MAC Interface Pins (*continued*)**

| Pin                  | Name                         | Type            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------------------|------------------------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 22                   | RX_ER                        | O <sub>ZC</sub> | <p>GMII Mode: (RX_ER)<br/>Receive error. This output signals a receive error from the PHY and is synchronously output on the rising edge of RX_CLK.</p> <p>RGMII Mode: (RX_CTL)<br/>Multiplexed receive data valid, receive error. This output is sampled by the MAC on opposite edges of RX_CLK to indicate two receive conditions from the PHY:</p> <ol style="list-style-type: none"> <li>1. On the rising edge of RX_CLK, this output serves as RXDV, signaling valid data is available on the RXD input data bus.</li> <li>2. On the falling edge of RX_CLK, this output signals a receive error from the PHY, based on a logical derivative of RXDV and RXER, per the RGMII specification.</li> </ol> |
| 21                   | RX_DV                        | O <sub>ZC</sub> | <p>GMII Mode:<br/>Receive data valid. This output signals a receive data valid from the PHY and is synchronously output on the rising edge of RX_CLK.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 36<br>37<br>38<br>39 | TXD7<br>TXD6<br>TXD5<br>TXD4 | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit data [7:4] pins. These pins are synchronously input on the rising edge of GTX_CLK.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 40<br>41<br>42<br>43 | TXD3<br>TXD2<br>TXD1<br>TXD0 | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit data [3:0] pins. These pins are synchronously input on the rising edge of GTX_CLK.</p> <p>RGMII Mode:<br/>Multiplexed transmit data. Bits[3:0] are synchronously input on the rising edge of GTX_CLK and bits[7:4] on the falling edge of GTX_CLK.</p>                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 34                   | TX_CLK                       | O <sub>ZC</sub> | Transmit clock. This clock is 2.5 MHz for 10 Mbps mode or 25 MHz for 100 Mbps mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 35                   | GTX_CLK                      | I               | <p>GMII Mode:<br/>Gigabit transmit clock. This clock is 125 MHz for 1000 Mbps mode, with a <math>\pm 50</math> ppm tolerance. If left unconnected, this pin requires a pull-down resistor to ground.</p> <p>RGMII Mode:<br/>The transmit clock is 125 MHz for 1000 Mbps mode, 25 MHz for 100 Mbps mode, or 2.5 MHz for 10 Mbps mode, with a <math>\pm 50</math> ppm tolerance.</p>                                                                                                                                                                                                                                                                                                                          |

**Table 84. GMII/RGMII MAC Interface Pins (*continued*)**

| Pin | Name    | Type            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|---------|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 44  | TX_ER   | I <sub>PD</sub> | <p>GMII Mode: (TX_ER)<br/>Transmit error. This input is sampled by the PHY on the rising edge of GTX_CLK, indicating a transmit error from the MAC.</p> <p>RGMII Mode: (TX_CTL)<br/>Multiplexed transmit enable, transmit error. This input is sampled by the PHY on opposite edges of GTX_CLK to indicate two transmit conditions of the MAC:</p> <ol style="list-style-type: none"> <li>1. On the rising edge of GTX_CLK, this input serves as TXEN, indicating valid data is available on the TXD input data bus.</li> <li>2. On the falling edge of GTX_CLK, this input signals a transmit error from the MAC, based on a logical derivative of TXEN and TXER, per the RGMII specification.</li> </ol> |
| 47  | TX_EN   | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit enable. This input is sampled by the PHY on the rising edge of GTX_CLK, indicating valid data is available on the TXD input data bus.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 17  | CRS     | O <sub>ZC</sub> | <p>GMII Mode:<br/>Transmit carrier sense. This output is asserted when a valid carrier is detected on the copper media interface.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 18  | COL     | O <sub>ZC</sub> | <p>GMII Mode:<br/>Transmit collision. This output is asserted when a collision is detected on the copper media interface in half duplex operation. For full-duplex operation, this output is driven low.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 45  | NSRESET | I <sub>PU</sub> | <p>Soft Reset. Active low input that places the device in a low-power state. Although the device is powered down, the sticky serial management interface registers retain their value.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |

**Table 84. GMII/RGMII MAC Interface Pins (continued)**

| Pin | Name         | Type               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|--------------|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 59  | OSCEN/CLKOUT | I <sub>PU</sub> /O | <p>OSCEN. This pin is sampled on the rising edge of NRESET. If HIGH (or left floating), then the on-chip oscillator circuit is enabled. If LOW, the oscillator circuit is disabled and the device must be supplied with a 25 MHz or 125 MHz reference clock to the REFCLK pin.</p> <p>CLKOUT. After NRESET is deasserted and OSCEN state is established, this pin becomes the clock output. The clock output can be enabled or disabled through a CMODE pin setting. Also, it can generate a reference clock frequency of 125 MHz. This pin is not active when NRESET is asserted. When disabled, the pin is held low.</p> |

### 6.2.3 Serial Management Interface (SMI)

The following table lists the device pins associated with the device serial management interface (SMI). Note that the pins in this table except NRESET are referenced to VDDIO<sub>MICRO</sub> and can be set to a 2.5 V, or 3.3 V power supply. The NRESET pin is referenced to VDD33.

**Table 85. SMI Pins**

| Pin | Name  | Type               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----|-------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 14  | MDC   | I <sub>PU</sub>    | Management data clock. A 0 MHz to 12.5 MHz reference input is used to clock serial MDIO data into and out of the PHY.                                                                                                                                                                                                                                                                                                                                                          |
| 15  | MDIO  | I/O                | Management data input/output pin. Serial data is written or read from this pin bidirectionally between the PHY and station manager, synchronously on the positive edge of MDC. One external pull-up resistor is required at the station manager, and its value depends on the MDC clock frequency and the total sum of the capacitive loads from the MDIO pins.                                                                                                                |
| 13  | MDINT | OS/OD              | Management interrupt signal. After reset, the device configures this pin, along with others from other devices, as active-low (open drain) or active-high (open source) based on the polarity of an external 10 kΩ resistor connection. These pins can be tied together in a wired-OR configuration with only a single pull-up or pull-down resistor.                                                                                                                          |
| 10  | EEDAT | I <sub>PD</sub> /O | (Optional) EEPROM serial I/O data. Used to configure PHYs in a system without a station manager. Connect to the SDA pin of the ATMEL "AT24CXXX" serial EEPROM device family. The VSC8641 determines that an external EEPROM is present by monitoring the EEDAT pin at power-up or when NRESET is de-asserted. If EEDAT has a 4.7 kΩ external pull-up resistor, the VSC8641 assumes an EEPROM is present. The EEDAT pin can be left floating or grounded to indicate no EEPROM. |

**Table 85. SMI Pins (continued)**

| Pin | Name   | Type            | Description                                                                                                                                                                      |
|-----|--------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11  | EECLK  | O <sub>ZC</sub> | (Optional) EEPROM Serial Output Clock. Used to configure PHYs in a system without a station manager. Connect to the SCL pin of the ATMEL "AT24CXXX" serial EEPROM device family. |
| 9   | NRESET | I <sub>PU</sub> | Device Reset. Active low input that powers down the device and sets the register bits to their default state.                                                                    |

## 6.2.4 JTAG

The following table lists the device pins associated with the device JTAG testing facility.

**Table 86. JTAG Pins**

| Pin | Name  | Type              | Description                                                                                   |
|-----|-------|-------------------|-----------------------------------------------------------------------------------------------|
| 4   | TDI   | I <sub>PU5V</sub> | JTAG test serial data input.                                                                  |
| 3   | TDO   | O                 | JTAG test serial data output.                                                                 |
| 6   | TMS   | I <sub>PU5V</sub> | JTAG test mode select.                                                                        |
| 7   | TCK   | I <sub>PU5V</sub> | JTAG test clock input.                                                                        |
| 8   | NTRST | I <sub>PU5V</sub> | JTAG reset. If JTAG is not used, then tie this pin to VSS (ground) with a pull-down resistor. |

## 6.2.5 Miscellaneous

The following table lists the device pins associated with a particular interface or facility on the device.

**Table 87. Miscellaneous Pins**

| Pin                        | Name                                           | Type               | Description                                                                                                                                                                                                                                                                                                                                                 |
|----------------------------|------------------------------------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 53<br>52<br>51<br>50<br>49 | CMODE4<br>CMODE3<br>CMODE2<br>CMODE1<br>CMODE0 | I <sub>A</sub>     | Configuration mode (CMODE) pins. For more information, see "CMODE," page 68.                                                                                                                                                                                                                                                                                |
| 86                         | XTAL1/REFCLK                                   | I                  | Crystal oscillator input. If OSCEN=high, then a 25 MHz parallel resonant crystal with $\pm 50$ ppm frequency tolerance should be connected across XTAL1 and XTAL2. A 33 pF capacitor should also tie the XTAL1 pin to ground. Reference clock input. If OSCEN=low, the clock input frequency can either be 25 MHz (PLLMODE=0) or 125 MHz (PLLMODE is high). |
| 85                         | XTAL2                                          | O <sub>CRYST</sub> | Crystal oscillator output. The crystal should be connected across XTAL1 and XTAL2. A 33 pF capacitor should also tie the XTAL2 pin to ground. If not using a crystal oscillator, this output pin can be left floating if driving XTAL1/REFCLK with a reference clock.                                                                                       |

**Table 87. Miscellaneous Pins (continued)**

| Pin                  | Name                         | Type              | Description                                                                                                                                                                                                                                                                                                                                                                                       |
|----------------------|------------------------------|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 64                   | PLLMODE                      | I                 | PLL mode input select. Sampled on power-up or reset. If PLLMODE is low, then REFCLK must be 25 MHz. If PLLMODE is high, then REFCLK must be 125 MHz. If a crystal or an external 25 MHz clock is used, PLLMODE must be pulled low. If an external 125 MHz clock is used, PLLMODE must be pulled high.                                                                                             |
| 55<br>56<br>57<br>58 | LED3<br>LED2<br>LED1<br>LED0 | O                 | LED direct-drive outputs. All LED pins are active-low. For more information about LED operation, see <a href="#">“LED Interface,”</a> page 31.                                                                                                                                                                                                                                                    |
| 70                   | REF_REXT                     | A <sub>BIAS</sub> | Reference external connects to an external 2 k $\Omega$ (1%) resistor to analog ground.                                                                                                                                                                                                                                                                                                           |
| 69                   | REF_FILT                     | A <sub>BIAS</sub> | Reference filter connects to an external 1 $\mu$ F capacitor to analog ground.                                                                                                                                                                                                                                                                                                                    |
| 60                   | REG_EN                       | I                 | Regulator enable. Active high input enables the on-chip switching regulator and generates a 1.2 V supply voltage.                                                                                                                                                                                                                                                                                 |
| 62, 63               | REG_OUT                      | A <sub>BIAS</sub> | Regulator output. When REG_EN is enabled, REG_OUT supplies a 1.2 V supply that has been regulated from the 3.3 V supply. When connecting to the 1.2 V supply pins, additional requirements are a 4.7 $\mu$ H to 5.1 $\mu$ H inductor in series as well as 10 $\mu$ F and 1 $\mu$ F capacitors to ground. The on-chip switching regulator is optional, and 1.2 V power can be supplied externally. |
| 65                   | NC                           | NC                | No connect. Do not connect them together or to ground. Leave these pins unconnected (floating).                                                                                                                                                                                                                                                                                                   |

## 6.2.6 Power Supply

The following table lists the device power supply pins.

**Table 88. Power Supply Pins**

| Pin                                                     | Name       | Type           | Description                                                         |
|---------------------------------------------------------|------------|----------------|---------------------------------------------------------------------|
| 1, 2, 54, 71, 78, 83                                    | VDD33      | 3.3 V          | General 3.3 V supply.                                               |
| 61                                                      | VDDREG     | 3.3 V          | On-chip switching regulator 3.3 V supply.                           |
| 12                                                      | VDDIOMICRO | 3.3 V<br>2.5 V | I/O micro power supply.                                             |
| 19, 27, 33, 46                                          | VDDIOMAC   | 3.3 V<br>2.5 V | I/O MAC power supply.                                               |
| 5, 16, 48                                               | VDD12      | 1.2 V          | Internal digital core voltage.                                      |
| 72                                                      | VDD12A     | 1.2 V          | 1.2 V analog power requiring additional PCB power supply filtering. |
| PAD <sup>(1)</sup><br>20, 66, 67, 68, 77,<br>84, 87, 88 | VSS        | 0 V            | General device ground.                                              |

1. Exposed pad on the bottom of the package.

## 6.2.7 Power Supply and Associated Function

Although certain function pins may not be used for a specific application, all power supply pins must be connected to their respective voltage input.

**Table 89. Power Supply Pins and Associated Function Pins**

| Pins       | Nominal Voltage | Associated Function Pins                                                                                                 |
|------------|-----------------|--------------------------------------------------------------------------------------------------------------------------|
| VDD33      | 3.3 V           | LED[2:0], CLKOUT, NRESET, JTAG (5), XTAL1, XTAL2, CMODE, TXVP, TXVN, REF_FILT, REF_REXT, OSCEN, PLLMODE, REG_EN, REF_CLK |
| VDDIOMICRO | 2.5 V, 3.3 V    | MDC, MDIO, MDINT, EECLK, EEDAT                                                                                           |
| VDDIOMAC   | 2.5 V, 3.3 V    | RXD, RX_CTL, RX_CLK, TXD, TX_CTL, TX_CLK, NSRESET                                                                        |

## 6.3 Pins by Number (VSC8641XJF)

This section provides a numeric list of the VSC8641XJF pins.

|    |            |
|----|------------|
| 1  | VDD33      |
| 2  | VDD33      |
| 3  | TDO        |
| 4  | TDI        |
| 5  | VDD12      |
| 6  | TMS        |
| 7  | TCK        |
| 8  | NTRST      |
| 9  | NRESET     |
| 10 | EEDAT      |
| 11 | EECLK      |
| 12 | VDDIOMICRO |
| 13 | MDINT      |
| 14 | MDC        |
| 15 | MDIO       |
| 16 | VDD12      |
| 17 | CRS        |
| 18 | COL        |
| 19 | VDDIOMAC   |
| 20 | VSS        |
| 21 | RX_DV      |
| 22 | RX_ER      |
| 23 | RXD7       |
| 24 | RXD6       |
| 25 | RXD5       |
| 26 | RXD4       |
| 27 | VDDIOMAC   |
| 28 | RXD3       |
| 29 | RXD2       |
| 30 | RXD1       |
| 31 | RXD0       |
| 32 | RX_CLK     |
| 33 | VDDIOMAC   |
| 34 | TX_CLK     |
| 35 | GTX_CLK    |
| 36 | TXD7       |
| 37 | TXD6       |
| 38 | TXD5       |

|    |               |
|----|---------------|
| 39 | TXD4          |
| 40 | TXD3          |
| 41 | TXD2          |
| 42 | TXD1          |
| 43 | TXD0          |
| 44 | TX_ER         |
| 45 | NSRESET       |
| 46 | VDDIOMAC      |
| 47 | TX_EN         |
| 48 | VDD12         |
| 49 | CMODE0        |
| 50 | CMODE1        |
| 51 | CMODE2        |
| 52 | CMODE3        |
| 53 | CMODE4        |
| 54 | VDD33         |
| 55 | LED3          |
| 56 | LED2          |
| 57 | LED1          |
| 58 | LED0          |
| 59 | OSCEN /CLKOUT |
| 60 | REG_EN        |
| 61 | VDDREG        |
| 62 | REG_OUT       |
| 63 | REG_OUT       |
| 64 | PLLMODE       |
| 65 | NC            |
| 66 | VSS           |
| 67 | VSS           |
| 68 | VSS           |
| 69 | REF_FILT      |
| 70 | REF_REXT      |
| 71 | VDD33         |
| 72 | VDD12A        |
| 73 | TXVPA         |
| 74 | TXVNA         |
| 75 | TXVPB         |
| 76 | TXVNB         |

|    |              |
|----|--------------|
| 77 | VSS          |
| 78 | VDD33        |
| 79 | TXVPC        |
| 80 | TXVNC        |
| 81 | TXVPD        |
| 82 | TXVND        |
| 83 | VDD33        |
| 84 | VSS          |
| 85 | XTAL2        |
| 86 | XTAL1/REFCLK |
| 87 | VSS          |
| 88 | VSS          |

## 6.4 Pins by Name (VSC8641XJF)

This section provides an alphabetical list of the VSC8641XJF pins.

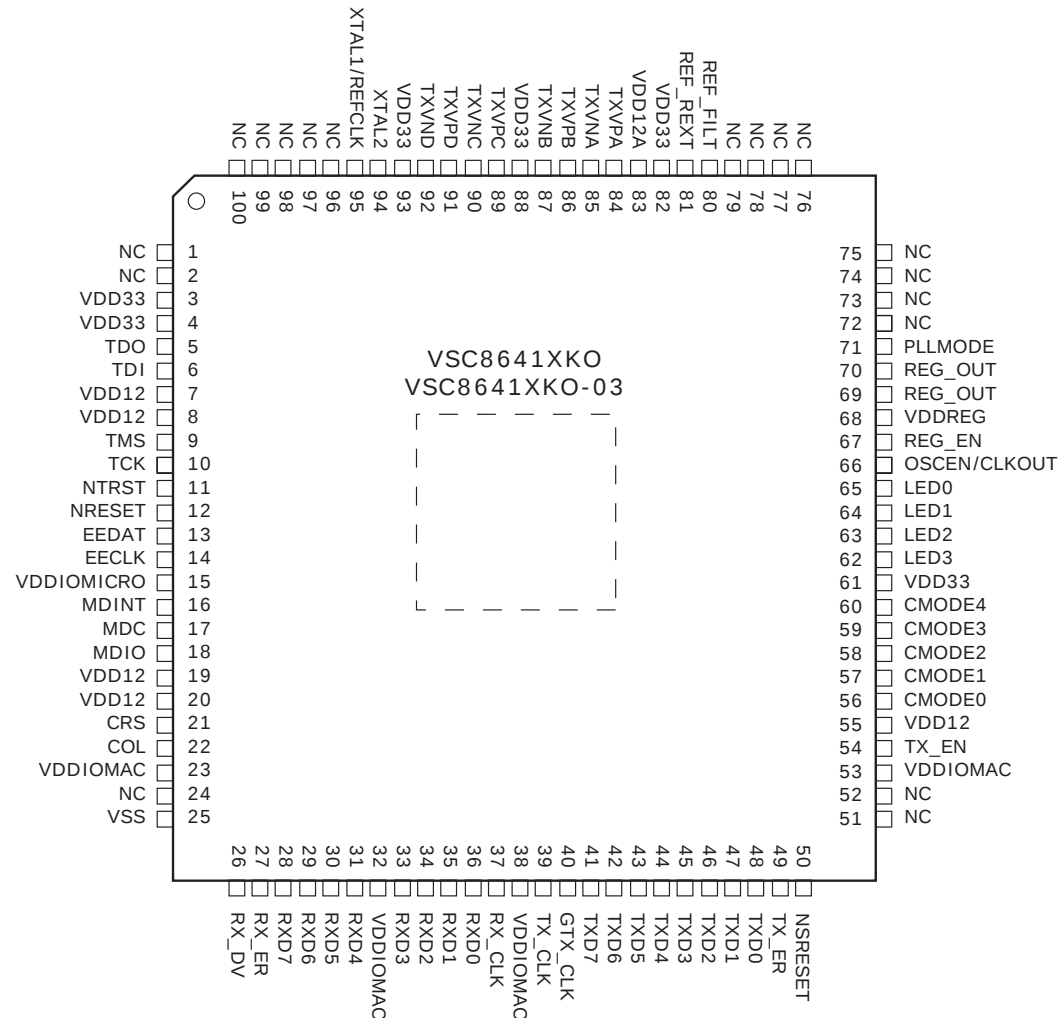
|                |    |          |    |              |    |
|----------------|----|----------|----|--------------|----|
| CMODE0         | 49 | RXD7     | 23 | VDDIOMICRO   | 12 |
| CMODE1         | 50 | TCK      | 7  | VDDREG       | 61 |
| CMODE2         | 51 | TDI      | 4  | VSS          | 20 |
| CMODE3         | 52 | TDO      | 3  | VSS          | 66 |
| CMODE4         | 53 | TMS      | 6  | VSS          | 67 |
| COL            | 18 | TX_CLK   | 34 | VSS          | 68 |
| CRS            | 17 | TX_EN    | 47 | VSS          | 77 |
| EECLK          | 11 | TX_ER    | 44 | VSS          | 84 |
| EEDAT          | 10 | TXD0     | 43 | VSS          | 87 |
| GTX_CLK        | 35 | TXD1     | 42 | VSS          | 88 |
| LED0           | 58 | TXD2     | 41 | XTAL1/REFCLK | 86 |
| LED1           | 57 | TXD3     | 40 | XTAL2        | 85 |
| LED2           | 56 | TXD4     | 39 |              |    |
| LED3           | 55 | TXD5     | 38 |              |    |
| MDC            | 14 | TXD6     | 37 |              |    |
| MDINT          | 13 | TXD7     | 36 |              |    |
| MDIO           | 15 | TXVNA    | 74 |              |    |
| NC             | 65 | TXVNB    | 76 |              |    |
| NRESET         | 9  | TXVNC    | 80 |              |    |
| NSRESET        | 45 | TXVND    | 82 |              |    |
| NTRST          | 8  | TXVPA    | 73 |              |    |
| OSCEEN /CLKOUT | 59 | TXVPB    | 75 |              |    |
| PLLMODE        | 64 | TXVPC    | 79 |              |    |
| REF_FILT       | 69 | TXVPD    | 81 |              |    |
| REF_REXT       | 70 | VDD12    | 5  |              |    |
| REG_EN         | 60 | VDD12    | 16 |              |    |
| REG_OUT        | 62 | VDD12    | 48 |              |    |
| REG_OUT        | 63 | VDD33    | 1  |              |    |
| RX_CLK         | 32 | VDD33    | 2  |              |    |
| RX_DV          | 21 | VDD33    | 54 |              |    |
| RX_ER          | 22 | VDD33    | 71 |              |    |
| RXD0           | 31 | VDD33    | 78 |              |    |
| RXD1           | 30 | VDD33    | 83 |              |    |
| RXD2           | 29 | VDD12A   | 72 |              |    |
| RXD3           | 28 | VDDIOMAC | 19 |              |    |
| RXD4           | 26 | VDDIOMAC | 27 |              |    |
| RXD5           | 25 | VDDIOMAC | 33 |              |    |
| RXD6           | 24 | VDDIOMAC | 46 |              |    |

## 6.5 Pin Diagram (VSC8641XKO, VSC8641XKO-03)

The following illustration shows the pin diagram for the VSC8641XKO and VSC8641XKO-03 devices.

**Note** The exposed pad is internally connected to ground and should be connected to VSS on the board as well.

**Figure 29. Pin Diagram for VSC8641XKO and VSC8641XKO-03**



## 6.6 Pins by Function (VSC8641XKO, VSC8641XKO-03)

This section contains the functional pin descriptions for the VSC8641XKO and VSC8641XKO-03 devices.

### 6.6.1 Twisted Pair Interface

The following table lists the device pins associated with the device two-wire, twisted pair interface.

**Table 90. Twisted Pair Interface Pins**

| Pin | Name  | Type              | Description                     |
|-----|-------|-------------------|---------------------------------|
| 84  | TXVPA | A <sub>DIFF</sub> | TX/RX channel A positive signal |
| 85  | TXVNA | A <sub>DIFF</sub> | TX/RX channel A negative signal |
| 86  | TXVPB | A <sub>DIFF</sub> | TX/RX channel B positive signal |
| 87  | TXVNB | A <sub>DIFF</sub> | TX/RX channel B negative signal |
| 89  | TXVPC | A <sub>DIFF</sub> | TX/RX channel C positive signal |
| 90  | TXVNC | A <sub>DIFF</sub> | TX/RX channel C negative signal |
| 91  | TXVPD | A <sub>DIFF</sub> | TX/RX channel D positive signal |
| 92  | TXVND | A <sub>DIFF</sub> | TX/RX channel D negative signal |

### 6.6.2 GMII/RGMII MAC Interface

The following table lists the device pins associated with the GMII/RGMII MAC interface. Note that the pins in this table are referenced to VDDIO<sub>MAC</sub> and can be set to a 2.5 V or 3.3 V power supply.

**Table 91. GMII/RGMII MAC Interface Pins**

| Pin | Name   | Type            | Description                                                                                                                                                                                                                                                           |
|-----|--------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 28  | RXD7   | O <sub>ZC</sub> | GMII Mode:<br>Receive data [7:4] pins. These pins are synchronously output on the rising edge of RX_CLK.<br><br>RGMII Mode:<br>Not used. Leave unconnected.                                                                                                           |
| 29  | RXD6   |                 |                                                                                                                                                                                                                                                                       |
| 30  | RXD5   |                 |                                                                                                                                                                                                                                                                       |
| 31  | RXD4   |                 |                                                                                                                                                                                                                                                                       |
| 33  | RXD3   | O <sub>ZC</sub> | GMII Mode:<br>Receive data [3:0] pins. These pins are synchronously output on the rising edge of RX_CLK.<br><br>RGMII Mode:<br>Multiplexed receive data. Bits[3:0] are synchronously output on the rising edge of RX_CLK and bits[7:4] on the falling edge of RX_CLK. |
| 34  | RXD2   |                 |                                                                                                                                                                                                                                                                       |
| 35  | RXD1   |                 |                                                                                                                                                                                                                                                                       |
| 36  | RXD0   |                 |                                                                                                                                                                                                                                                                       |
| 37  | RX_CLK | O <sub>ZC</sub> | Receive clock. Receive data is sourced from the PHY synchronously on the rising edge of RX_CLK and is the recovered clock from the media.                                                                                                                             |

**Table 91. GMII/RGMII MAC Interface Pins (*continued*)**

| Pin | Name    | Type            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----|---------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 27  | RX_ER   | O <sub>ZC</sub> | <p>GMII Mode: (RX_ER)<br/>Receive error. This output signals a receive error from the PHY and is synchronously output on the rising edge of RX_CLK.</p> <p>RGMII Mode: (RX_CTL)<br/>Multiplexed receive data valid, receive error. This output is sampled by the MAC on opposite edges of RX_CLK to indicate two receive conditions from the PHY:</p> <ol style="list-style-type: none"> <li>1. On the rising edge of RX_CLK, this output serves as RXDV, signaling valid data is available on the RXD input data bus.</li> <li>2. On the falling edge of RX_CLK, this output signals a receive error from the PHY, based on a logical derivative of RXDV and RXER, per the RGMII specification.</li> </ol> |
| 26  | RX_DV   | O <sub>ZC</sub> | <p>GMII Mode:<br/>Receive data valid. This output signals a receive data valid from the PHY and is synchronously output on the rising edge of RX_CLK.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 41  | TXD7    | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit data [7:4] pins. These pins are synchronously input on the rising edge of GTX_CLK.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 42  | TXD6    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 43  | TXD5    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 44  | TXD4    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 45  | TXD3    | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit data [3:0] pins. These pins are synchronously input on the rising edge of GTX_CLK.</p> <p>RGMII Mode:<br/>Multiplexed transmit data. Bits[3:0] are synchronously input on the rising edge of GTX_CLK and bits[7:4] on the falling edge of GTX_CLK.</p>                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 46  | TXD2    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 47  | TXD1    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 48  | TXD0    |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 39  | TX_CLK  | O <sub>ZC</sub> | Transmit clock. This clock is 2.5 MHz for 10 Mbps mode or 25 MHz for 100 Mbps mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 40  | GTX_CLK | I               | <p>GMII Mode:<br/>Gigabit transmit clock. This clock is 125 MHz for 1000 Mbps mode, with a <math>\pm 50</math> ppm tolerance. If left unconnected, this pin requires a pull-down resistor to ground.</p> <p>RGMII Mode:<br/>The transmit clock is 125 MHz for 1000 Mbps mode, 25 MHz for 100 Mbps mode, or 2.5 MHz for 10 Mbps mode, with a <math>\pm 50</math> ppm tolerance.</p>                                                                                                                                                                                                                                                                                                                          |

**Table 91. GMII/RGMII MAC Interface Pins (*continued*)**

| Pin | Name    | Type            | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|---------|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 49  | TX_ER   | I <sub>PD</sub> | <p>GMII Mode: (TX_ER)<br/>Transmit error. This input is sampled by the PHY on the rising edge of GTX_CLK, indicating a transmit error from the MAC.</p> <p>RGMII Mode: (TX_CTL)<br/>Multiplexed transmit enable, transmit error. This input is sampled by the PHY on opposite edges of GTX_CLK to indicate two transmit conditions of the MAC:</p> <ol style="list-style-type: none"> <li>1. On the rising edge of GTX_CLK, this input serves as TXEN, indicating valid data is available on the TXD input data bus.</li> <li>2. On the falling edge of GTX_CLK, this input signals a transmit error from the MAC, based on a logical derivative of TXEN and TXER, per the RGMII specification.</li> </ol> |
| 54  | TX_EN   | I <sub>PD</sub> | <p>GMII Mode:<br/>Transmit enable. This input is sampled by the PHY on the rising edge of GTX_CLK, indicating valid data is available on the TXD input data bus.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 21  | CRS     | O <sub>ZC</sub> | <p>GMII Mode:<br/>Transmit carrier sense. This output is asserted when a valid carrier is detected on the copper media interface.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 22  | COL     | O <sub>ZC</sub> | <p>GMII Mode:<br/>Transmit collision. This output is asserted when a collision is detected on the copper media interface in half duplex operation. For full-duplex operation, this output is driven low.</p> <p>RGMII Mode:<br/>Not used. Leave unconnected.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 50  | NSRESET | I <sub>PU</sub> | <p>Soft Reset. Active low input that places the device in a low-power state. Although the device is powered down, the sticky serial management interface registers retain their value.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |

**Table 91. GMII/RGMII MAC Interface Pins (*continued*)**

| Pin | Name         | Type               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|--------------|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 66  | OSCEN/CLKOUT | I <sub>PU</sub> /O | <p>OSCEN. This pin is sampled on the rising edge of NRESET. If HIGH (or left floating), then the on-chip oscillator circuit is enabled. If LOW, the oscillator circuit is disabled and the device must be supplied with a 25 MHz or 125 MHz reference clock to the REFCLK pin.</p> <p>CLKOUT. After NRESET is deasserted and OSCEN state is established, this pin becomes the clock output. The clock output can be enabled or disabled through a CMODE pin setting. Also, it can generate a reference clock frequency of 125 MHz. This pin is not active when NRESET is asserted. When disabled, the pin is held low.</p> |

### 6.6.3 Serial Management Interface (SMI)

The following table lists the device pins associated with the device serial management interface (SMI). Note that the pins in this table except NRESET are referenced to VDDIO<sub>MICRO</sub> and can be set to a 2.5 V, or 3.3 V power supply. The NRESET pin is referenced to VDD33.

**Table 92. SMI Pins**

| Pin | Name   | Type               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-----|--------|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 17  | MDC    | I <sub>PU</sub>    | Management data clock. A 0 MHz to 12.5 MHz reference input is used to clock serial MDIO data into and out of the PHY.                                                                                                                                                                                                                                                                                                                                                                        |
| 18  | MDIO   | I/O                | Management data input/output pin. Serial data is written or read from this pin bidirectionally between the PHY and station manager, synchronously on the positive edge of MDC. One external pull-up resistor is required at the station manager, and its value depends on the MDC clock frequency and the total sum of the capacitive loads from the MDIO pins.                                                                                                                              |
| 16  | MDINT  | OS/OD              | Management interrupt signal. After reset, the device configures this pin, along with others from other devices, as active-low (open drain) or active-high (open source) based on the polarity of an external 10 kΩ resistor connection. These pins can be tied together in a wired-OR configuration with only a single pull-up or pull-down resistor.                                                                                                                                        |
| 13  | EEDAT  | I <sub>PD</sub> /O | <p>(Optional) EEPROM serial I/O data. Used to configure PHYs in a system without a station manager. Connect to the SDA pin of the ATMEL "AT24CXXX" serial EEPROM device family.</p> <p>The VSC8641 determines that an external EEPROM is present by monitoring the EEDAT pin at power-up or when NRESET is de-asserted. If EEDAT has a 4.7 kΩ external pull-up resistor, the VSC8641 assumes an EEPROM is present. The EEDAT pin can be left floating or grounded to indicate no EEPROM.</p> |
| 14  | EECLK  | O <sub>ZC</sub>    | (Optional) EEPROM Serial Output Clock. Used to configure PHYs in a system without a station manager. Connect to the SCL pin of the ATMEL "AT24CXXX" serial EEPROM device family.                                                                                                                                                                                                                                                                                                             |
| 12  | NRESET | I <sub>PU</sub>    | Device Reset. Active low input that powers down the device and sets the register bits to their default state.                                                                                                                                                                                                                                                                                                                                                                                |

## 6.6.4 JTAG

The following table lists the device pins associated with the device JTAG testing facility.

**Table 93. JTAG Pins**

| Pin | Name  | Type              | Description                                                                                   |
|-----|-------|-------------------|-----------------------------------------------------------------------------------------------|
| 6   | TDI   | I <sub>PU5V</sub> | JTAG test serial data input.                                                                  |
| 5   | TDO   | O                 | JTAG test serial data output.                                                                 |
| 9   | TMS   | I <sub>PU5V</sub> | JTAG test mode select.                                                                        |
| 10  | TCK   | I <sub>PU5V</sub> | JTAG test clock input.                                                                        |
| 11  | NTRST | I <sub>PU5V</sub> | JTAG reset. If JTAG is not used, then tie this pin to VSS (ground) with a pull-down resistor. |

## 6.6.5 Miscellaneous

The following table lists the device pins associated with a particular interface or facility on the device.

**Table 94. Miscellaneous Pins**

| Pin                        | Name                                           | Type               | Description                                                                                                                                                                                                                                                                                                                                                 |
|----------------------------|------------------------------------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 60<br>59<br>58<br>57<br>56 | CMODE4<br>CMODE3<br>CMODE2<br>CMODE1<br>CMODE0 | I <sub>A</sub>     | Configuration mode (CMODE) pins. For more information, see <a href="#">“CMODE,”</a> page 68.                                                                                                                                                                                                                                                                |
| 95                         | XTAL1/REFCLK                                   | I                  | Crystal oscillator input. If OSCEN=high, then a 25 MHz parallel resonant crystal with $\pm 50$ ppm frequency tolerance should be connected across XTAL1 and XTAL2. A 33 pF capacitor should also tie the XTAL1 pin to ground. Reference clock input. If OSCEN=low, the clock input frequency can either be 25 MHz (PLLMODE=0) or 125 MHz (PLLMODE is high). |
| 94                         | XTAL2                                          | O <sub>CRYST</sub> | Crystal oscillator output. The crystal should be connected across XTAL1 and XTAL2. A 33 pF capacitor should also tie the XTAL2 pin to ground. If not using a crystal oscillator, this output pin can be left floating if driving XTAL1/REFCLK with a reference clock.                                                                                       |
| 71                         | PLLMODE                                        | I                  | PLL mode input select. Sampled on power-up or reset. If PLLMODE is low, then REFCLK must be 25 MHz. If PLLMODE is high, then REFCLK must be 125 MHz. If a crystal or an external 25 MHz clock is used, PLLMODE must be pulled low. If an external 125 MHz clock is used, PLLMODE must be pulled high.                                                       |
| 62<br>63<br>64<br>65       | LED3<br>LED2<br>LED1<br>LED0                   | O                  | LED direct-drive outputs. All LED pins are active-low. For more information about LED operation, see <a href="#">“LED Interface,”</a> page 31.                                                                                                                                                                                                              |
| 81                         | REF_REXT                                       | A <sub>BIAS</sub>  | Reference external connects to an external 2 k $\Omega$ (1%) resistor to analog ground.                                                                                                                                                                                                                                                                     |
| 80                         | REF_FILT                                       | A <sub>BIAS</sub>  | Reference filter connects to an external 1 $\mu$ F capacitor to analog ground.                                                                                                                                                                                                                                                                              |

**Table 94. Miscellaneous Pins (continued)**

| Pin                                                                                           | Name    | Type              | Description                                                                                                                                                                                                                                                                                                                                                                                       |
|-----------------------------------------------------------------------------------------------|---------|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 67                                                                                            | REG_EN  | I                 | Regulator enable. Active high input enables the on-chip switching regulator and generates a 1.2 V supply voltage.                                                                                                                                                                                                                                                                                 |
| 69, 70                                                                                        | REG_OUT | A <sub>BIAS</sub> | Regulator output. When REG_EN is enabled, REG_OUT supplies a 1.2 V supply that has been regulated from the 3.3 V supply. When connecting to the 1.2 V supply pins, additional requirements are a 4.7 $\mu$ H to 5.1 $\mu$ H inductor in series as well as 10 $\mu$ F and 1 $\mu$ F capacitors to ground. The on-chip switching regulator is optional, and 1.2 V power can be supplied externally. |
| 1, 2,<br>24, 51,<br>52, 72,<br>73, 74,<br>75, 76,<br>77, 78,<br>79, 96,<br>97, 98,<br>99, 100 | NC      | NC                | No connect. Do not connect them together or to ground. Leave these pins unconnected (floating).                                                                                                                                                                                                                                                                                                   |

## 6.6.6 Power Supply

The following table lists the device power supply pins.

**Table 95. Power Supply Pins**

| Pin                    | Name       | Type           | Description                                                         |
|------------------------|------------|----------------|---------------------------------------------------------------------|
| 3, 4, 61, 82, 88, 93   | VDD33      | 3.3 V          | General 3.3 V supply.                                               |
| 68                     | VDDREG     | 3.3 V          | On-chip switching regulator 3.3 V supply.                           |
| 15                     | VDDIOMICRO | 3.3 V<br>2.5 V | I/O micro power supply.                                             |
| 23, 32, 38, 53         | VDDIOMAC   | 3.3 V<br>2.5 V | I/O MAC power supply.                                               |
| 7, 8, 19, 20, 55       | VDD12      | 1.2 V          | Internal digital core voltage.                                      |
| 83                     | VDD12A     | 1.2 V          | 1.2 V analog power requiring additional PCB power supply filtering. |
| 25, PAD <sup>(1)</sup> | VSS        | 0 V            | General device ground.                                              |

1. Exposed pad on the bottom of the package.

### 6.6.7 Power Supply and Associated Function

Although certain function pins may not be used for a specific application, all power supply pins must be connected to their respective voltage input.

**Table 96. Power Supply Pins and Associated Function Pins**

| Pins       | Nominal Voltage | Associated Function Pins                                                                                                 |
|------------|-----------------|--------------------------------------------------------------------------------------------------------------------------|
| VDD33      | 3.3 V           | LED[2:0], CLKOUT, NRESET, JTAG (5), XTAL1, XTAL2, CMODE, TXVP, TXVN, REF_FILT, REF_REXT, OSCEN, PLLMODE, REG_EN, REF_CLK |
| VDDIOMICRO | 2.5 V, 3.3 V    | MDC, MDIO, MDINT, EECLK, EEDAT                                                                                           |
| VDDIOMAC   | 2.5 V, 3.3 V    | RXD, RX_CTL, RX_CLK, TXD, TX_CTL, TX_CLK, NSRESET                                                                        |

## 6.7 Pins by Number (VSC8641XKO, VSC8641XKO-03)

This section provides a numeric list of the VSC8641XKO and VSC8641XKO-03 pins.

|    |            |    |              |     |              |
|----|------------|----|--------------|-----|--------------|
| 1  | NC         | 39 | TX_CLK       | 77  | NC           |
| 2  | NC         | 40 | GTX_CLK      | 78  | NC           |
| 3  | VDD33      | 41 | TXD7         | 79  | NC           |
| 4  | VDD33      | 42 | TXD6         | 80  | REF_FILT     |
| 5  | TDO        | 43 | TXD5         | 81  | REF_REXT     |
| 6  | TDI        | 44 | TXD4         | 82  | VDD33        |
| 7  | VDD12      | 45 | TXD3         | 83  | VDD12A       |
| 8  | VDD12      | 46 | TXD2         | 84  | TXVPA        |
| 9  | TMS        | 47 | TXD1         | 85  | TXVNA        |
| 10 | TCK        | 48 | TXD0         | 86  | TXVPB        |
| 11 | NTRST      | 49 | TX_ER        | 87  | TXVNB        |
| 12 | NRESET     | 50 | NSRESET      | 88  | VDD33        |
| 13 | EEDAT      | 51 | NC           | 89  | TXVPC        |
| 14 | EECLK      | 52 | NC           | 90  | TXVNC        |
| 15 | VDDIOMICRO | 53 | VDDIOMAC     | 91  | TXVPD        |
| 16 | MDINT      | 54 | TX_EN        | 92  | TXVND        |
| 17 | MDC        | 55 | VDD12        | 93  | VDD33        |
| 18 | MDIO       | 56 | CMODE0       | 94  | XTAL2        |
| 19 | VDD12      | 57 | CMODE1       | 95  | XTAL1/REFCLK |
| 20 | VDD12      | 58 | CMODE2       | 96  | NC           |
| 21 | CRS        | 59 | CMODE3       | 97  | NC           |
| 22 | COL        | 60 | CMODE4       | 98  | NC           |
| 23 | VDDIOMAC   | 61 | VDD33        | 99  | NC           |
| 24 | NC         | 62 | LED3         | 100 | NC           |
| 25 | VSS        | 63 | LED2         |     |              |
| 26 | RX_DV      | 64 | LED1         |     |              |
| 27 | RX_ER      | 65 | LED0         |     |              |
| 28 | RXD7       | 66 | OSCEN/CLKOUT |     |              |
| 29 | RXD6       | 67 | REG_EN       |     |              |
| 30 | RXD5       | 68 | VDDREG       |     |              |
| 31 | RXD4       | 69 | REG_OUT      |     |              |
| 32 | VDDIOMAC   | 70 | REG_OUT      |     |              |
| 33 | RXD3       | 71 | PLLMODE      |     |              |
| 34 | RXD2       | 72 | NC           |     |              |
| 35 | RXD1       | 73 | NC           |     |              |
| 36 | RXD0       | 74 | NC           |     |              |
| 37 | RX_CLK     | 75 | NC           |     |              |
| 38 | VDDIOMAC   | 76 | NC           |     |              |

## 6.8 Pins by Name (VSC8641XKO, VSC8641XKO-03)

This section provides an alphabetical list of the VSC8641XKO and VSC8641XKO-03 pins.

|         |     |              |    |              |    |
|---------|-----|--------------|----|--------------|----|
| CMODE0  | 56  | NTRST        | 11 | TXVND        | 92 |
| CMODE1  | 57  | OSCEN/CLKOUT | 66 | TXVPA        | 84 |
| CMODE2  | 58  | PLLMODE      | 71 | TXVPB        | 86 |
| CMODE3  | 59  | REF_FILT     | 80 | TXVPC        | 89 |
| CMODE4  | 60  | REF_REXT     | 81 | TXVPD        | 91 |
| COL     | 22  | REG_EN       | 67 | VDD12        | 7  |
| CRS     | 21  | REG_OUT      | 69 | VDD12        | 8  |
| EECLK   | 14  | REG_OUT      | 70 | VDD12        | 19 |
| EEDAT   | 13  | RX_CLK       | 37 | VDD12        | 20 |
| GTX_CLK | 40  | RX_DV        | 26 | VDD12        | 55 |
| LED0    | 65  | RX_ER        | 27 | VDD33        | 3  |
| LED1    | 64  | RXD0         | 36 | VDD33        | 4  |
| LED2    | 63  | RXD1         | 35 | VDD33        | 61 |
| LED3    | 62  | RXD2         | 34 | VDD33        | 82 |
| MDC     | 17  | RXD3         | 33 | VDD33        | 88 |
| MDINT   | 16  | RXD4         | 31 | VDD33        | 93 |
| MDIO    | 18  | RXD5         | 30 | VDD12A       | 83 |
| NC      | 1   | RXD6         | 29 | VDDIOMAC     | 23 |
| NC      | 2   | RXD7         | 28 | VDDIOMAC     | 32 |
| NC      | 24  | TCK          | 10 | VDDIOMAC     | 38 |
| NC      | 51  | TDI          | 6  | VDDIOMAC     | 53 |
| NC      | 52  | TDO          | 5  | VDDIOMICRO   | 15 |
| NC      | 72  | TMS          | 9  | VDDREG       | 68 |
| NC      | 73  | TX_CLK       | 39 | VSS          | 25 |
| NC      | 74  | TX_EN        | 54 | XTAL1/REFCLK | 95 |
| NC      | 75  | TX_ER        | 49 | XTAL2        | 94 |
| NC      | 76  | TXD0         | 48 |              |    |
| NC      | 77  | TXD1         | 47 |              |    |
| NC      | 78  | TXD2         | 46 |              |    |
| NC      | 79  | TXD3         | 45 |              |    |
| NC      | 96  | TXD4         | 44 |              |    |
| NC      | 97  | TXD5         | 43 |              |    |
| NC      | 98  | TXD6         | 42 |              |    |
| NC      | 99  | TXD7         | 41 |              |    |
| NC      | 100 | TXVNA        | 85 |              |    |
| NRESET  | 12  | TXVNB        | 87 |              |    |
| NSRESET | 50  | TXVNC        | 90 |              |    |

## 7 Package Information

The VSC8641 device is available in two package types. VSC8641XJF is a lead(Pb)-free, 88-pin, plastic quad flat no-lead (QFN) package with an exposed pad, 10 mm × 10 mm body size, 0.4 mm pin pitch, and 0.9 mm maximum height. VSC8641XKO and VSC8641XKO-03 are packaged in a 100-pin, plastic low-profile quad flat package (LQFP) with an exposed pad, 12 mm × 12 mm body size, 1.4 mm body thickness, 0.4 mm pin pitch, and 1.6 mm maximum height.

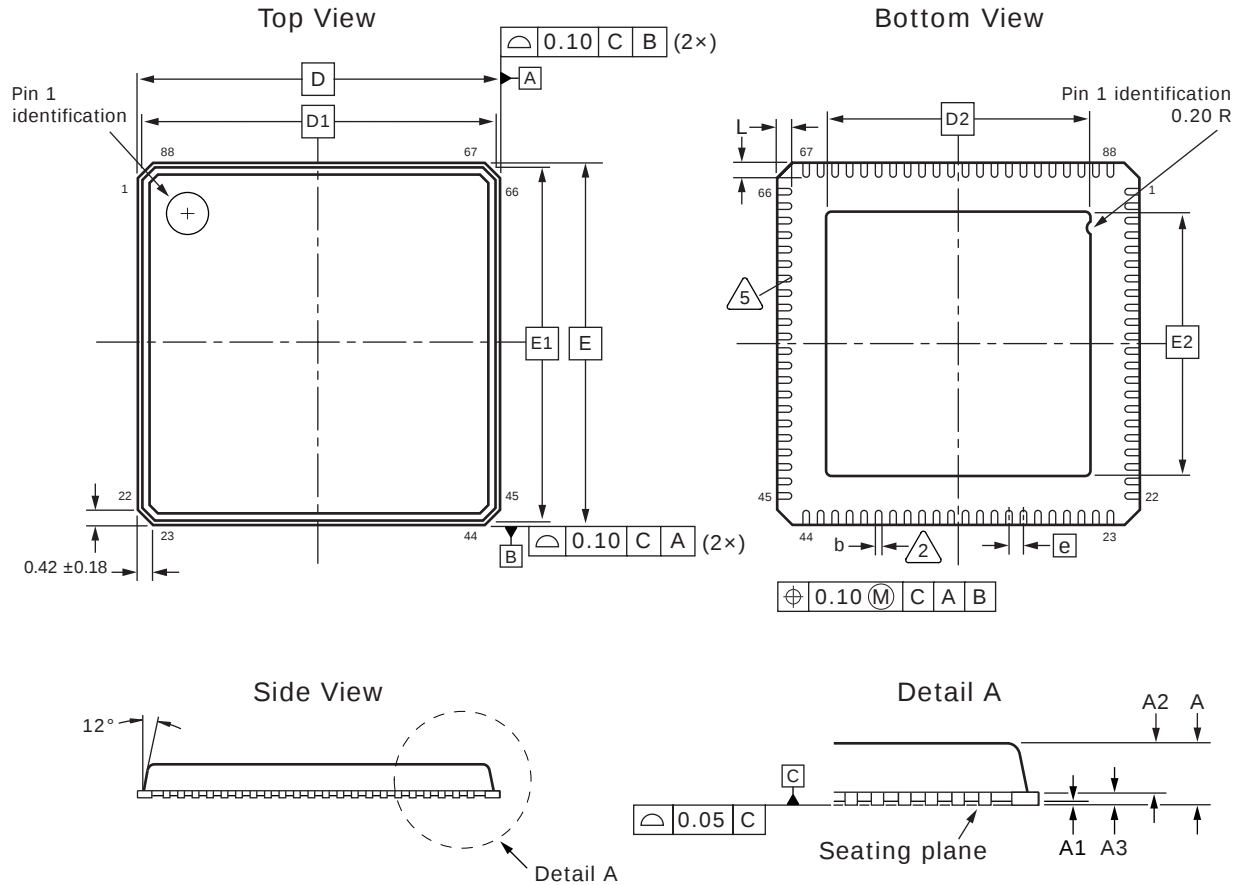
Lead(Pb)-free products from Vitesse comply with the temperatures and profiles defined in the joint IPC and JEDEC standard IPC/JEDEC J-STD-020. For more information, see the IPC and JEDEC standard.

This section provides the package drawings, thermal specifications, and moisture sensitivity ratings for the devices.

### 7.1 Package Drawings

The following illustrations show the package drawings for the devices. The drawings contain the top view, bottom view, side view, detail views, dimensions, tolerances, and notes.

**Figure 30. Package Drawing for VSC8641XJF**



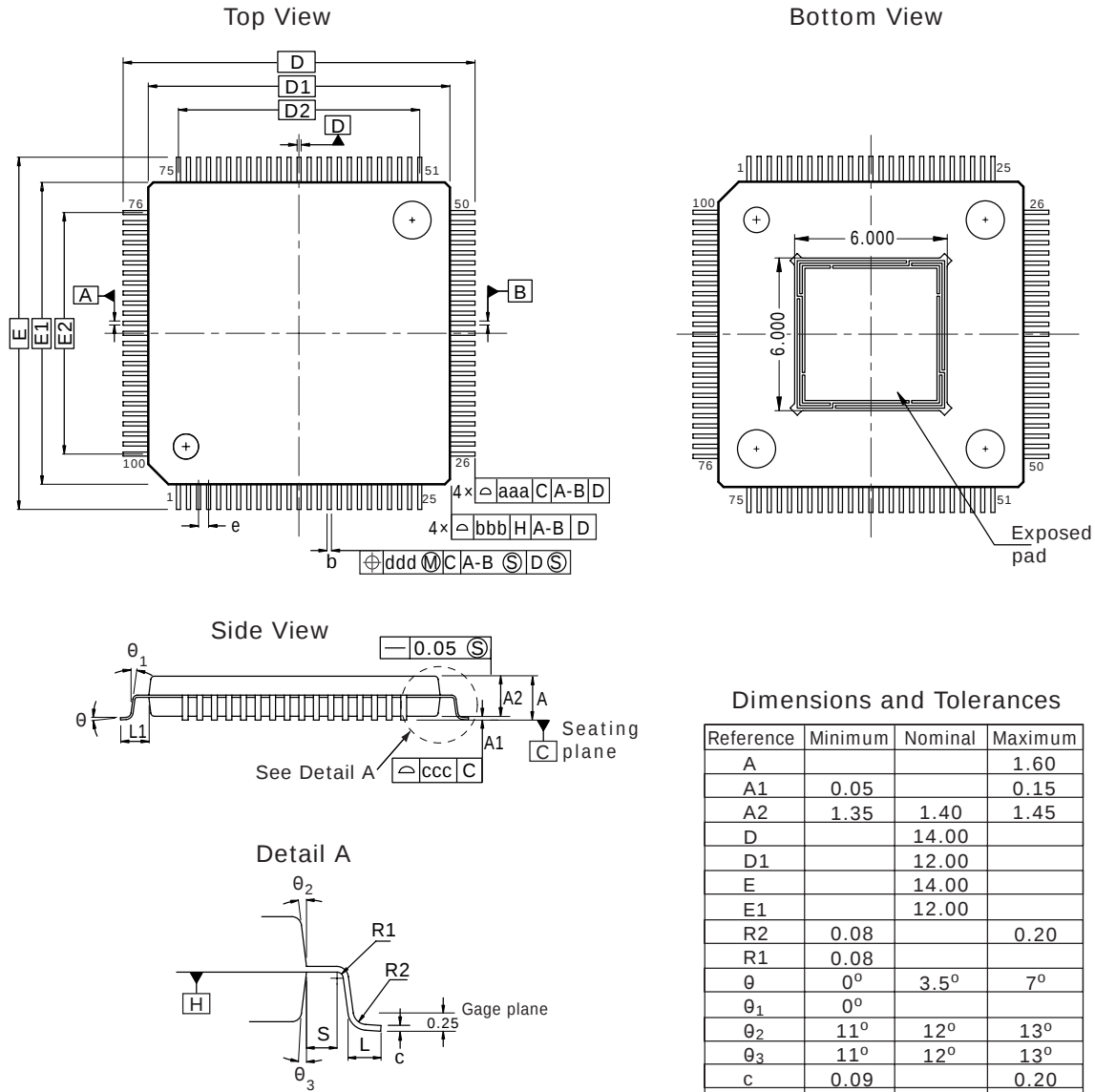
### Notes

1. All dimensions and tolerances are in millimeters (mm).
2. Dimension applies to plated terminal and is measured 0.13 mm to 0.23 mm from the terminal tip.
3. Package warpage maximum is 0.08 mm.
4. Package corners are  $R0.175 \pm 0.025$  mm.
5. Embedded lead radius is 0.065 mm.

### Dimensions and Tolerances

| Reference | Minimum | Nominal   | Maximum |
|-----------|---------|-----------|---------|
| A         |         |           | 0.90    |
| A1        |         | 0.01      | 0.05    |
| A2        |         | 0.65      | 0.70    |
| A3        |         | 0.20 REF  |         |
| D         |         | 10.00 BSC |         |
| E         |         | 10.00 BSC |         |
| D1        |         | 9.75 BSC  |         |
| E1        |         | 9.75 BSC  |         |
| D2        | 7.10    | 7.30      | 7.50    |
| E2        | 7.10    | 7.30      | 7.50    |
| e         |         | 0.40 BSC  |         |
| b         | 0.13    | 0.18      | 0.23    |
| L         | 0.30    | 0.40      | 0.50    |

**Figure 31. Package Drawing for VSC8641XKO and VSC8641XKO-03**



**Dimensions and Tolerances**

| Reference  | Minimum | Nominal | Maximum |
|------------|---------|---------|---------|
| A          |         |         | 1.60    |
| A1         | 0.05    |         | 0.15    |
| A2         | 1.35    | 1.40    | 1.45    |
| D          |         | 14.00   |         |
| D1         |         | 12.00   |         |
| E          |         | 14.00   |         |
| E1         |         | 12.00   |         |
| R2         | 0.08    |         | 0.20    |
| R1         | 0.08    |         |         |
| $\theta$   | 0°      | 3.5°    | 7°      |
| $\theta_1$ | 0°      |         |         |
| $\theta_2$ | 11°     | 12°     | 13°     |
| $\theta_3$ | 11°     | 12°     | 13°     |
| c          | 0.09    |         | 0.20    |
| L          | 0.45    | 0.60    | 0.75    |
| L1         |         | 1.00    |         |
| S          | 0.20    |         |         |
| b          | 0.13    | 0.16    | 0.23    |
| e          |         | 0.40    |         |
| D2         |         | 9.60    |         |
| E2         |         | 9.60    |         |
| aaa        |         | 0.20    |         |
| bbb        |         | 0.20    |         |
| ccc        |         | 0.08    |         |
| ddd        |         | 0.07    |         |

**Notes**

1. All dimensions and tolerances are in millimeters (mm).
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Dimension b does not include dambar protrusion. Allowable dambar protrusion does not cause the lead width to exceed the maximum b dimension by more than 0.08 mm.

## 7.2 Thermal Specifications

Thermal specifications for this device are based on the JEDEC standard EIA/JESD51-2 and have been modeled using a four-layer test board with two signal layers, a power plane, and a ground plane (2s2p PCB). For more information, see the JEDEC standard.

**Table 97. Thermal Resistances**

| Part Order Number | $\theta_{JC}$                             | $\theta_{JB}$ | $\theta_{JA}$ (°C/W) vs. Airflow (ft/min) |     |      |
|-------------------|-------------------------------------------|---------------|-------------------------------------------|-----|------|
|                   |                                           |               | 0                                         | 100 | 200  |
| VSC8641XJF        | 7 <sup>(1)</sup><br>3.2 <sup>(2)</sup>    | 16.7          | 24                                        | 22  | 19.5 |
| VSC8641XKO        | 14.7 <sup>(1)</sup><br>6.4 <sup>(2)</sup> | 19            | 29                                        | 26  | 25   |
| VSC8641XKO-03     | 14.7 <sup>(1)</sup><br>6.4 <sup>(2)</sup> | 19            | 29                                        | 26  | 25   |

1. Simulated on the top of the mold compound with the exposed pad soldered to a ground pad on the PCB.
2. Calculated on the exposed pad soldered to a ground pad on the PCB.

To achieve results similar to the modeled thermal resistance measurements, the guidelines for board design described in the JEDEC standard EIA/JESD51 series must be applied. For information about specific applications, see the following:

EIA/JESD51-5, *Extension of Thermal Test Board Standards for Packages with Direct Thermal Attachment Mechanisms*

EIA/JESD51-7, *High Effective Thermal Conductivity Test Board for Leaded Surface Mount Packages*

EIA/JESD51-9, *Test Boards for Area Array Surface Mount Package Thermal Measurements*

EIA/JESD51-10, *Test Boards for Through-Hole Perimeter Leaded Package Thermal Measurements*

EIA/JESD51-11, *Test Boards for Through-Hole Area Array Leaded Package Thermal Measurements*

## 7.3 Moisture Sensitivity

This device is rated moisture sensitivity level 3 or better as specified in the joint IPC and JEDEC standard IPC/JEDEC J-STD-020. For more information, see the IPC and JEDEC standard.

## 8 Design Considerations

This section explains various issues associated with the VSC8641 device.

### 8.1 RX\_CLK Can Reach as High as 55% Duty Cycle

Issue: When register 23, bit 8 = 0 (no internal clock skew) for RGMII, then the RX\_CLK duty cycle has been measured as high as 55%.

Implications: There is a possibility that the duty cycle can go beyond this value, which then violates what is specified in the datasheet. This has only been observed when the skew setting is set to 0.

Workaround: Avoid using an RGMII skew setting of 0.

### 8.2 First SMI Write Fails after Software Reset

Issue: After applying software reset (using either register 0, bit 15 or the NSRESET pin), the first subsequent SMI write operation into register 4 (auto-negotiation advertisement) or register 9 (1000BASE-T control) does not work. This issue only occurs if the first SMI write after software reset is into register 4 or 9. This issue does not occur if any kind of SMI transaction (either read or write) is applied to any register between the time of the software reset and the SMI write into register 4 or 9.

Implications: The PHY may operate unexpectedly, because settings for registers 4 and 9 remain at the reset value. There are no such implications after either hardware reset or power-down events.

Workaround: Writing "0x0000" into register 31 after every software reset avoids this issue, and subsequent SMI writes into register 4 or 9 succeed.

### 8.3 Link-Up Issue In Forced 100BASE-TX Mode

Issue: While in the forced 100BASE-TX mode with the automatic crossover detection feature (HP Auto-MDIX) enabled, it can take up to several minutes for the link-up process between the VSC8641 device and a link partner that also has its automatic crossover detection feature enabled. The problem has not been observed in any other operation modes.

Implications: While working against some link partners, such as those by Marvell, it can take up to several minutes for the link-up process to complete.

Workaround: When forcing 100BASE-TX mode, use the following script to alter the internal method that the VSC8641 uses to perform crossover detection. For more information, see *PHY API Software and Programmers Guide*, which is available on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

```
PhyWrite (PortNo, reg_num(dec), 16_bit_unsigned_data(hex))  
PhyWriteMsk (PortNo, reg_num(dec), 16_bit_unsigned_data(hex), mask(hex))
```

```
PhyWrite (PortNo, 31, 0x52B5); // Select internal register page
PhyWrite (PortNo, 16, 0xA7F8); // Request read of internal register
PhyWriteMsk (PortNo, 17, 0x0018, 0x0018); // Set for forced 100BASE-TX
PhyWriteMsk (PortNo, 18, 0, 0); // Necessary read & re-write register 18
PhyWrite (PortNo, 16, 0x87F8); // Write back modified internal register
PhyWrite (PortNo, 31, 0); // Select main register page
```

When returning from forced 100BASE-TX mode to auto-negotiation mode, use the following script to restore the standard method that VSC8641 uses to perform crossover detection:

```
PhyWrite (PortNo, 31, 0x52B5); // Select internal register page
PhyWrite (PortNo, 16, 0xA7F8); // Request read of internal register
PhyWriteMsk (PortNo, 17, 0x0000, 0x0018); // Set for auto-negotiation
PhyWriteMsk (PortNo, 18, 0, 0); // Necessary read & re-write register 18
PhyWrite (PortNo, 16, 0x87F8); // Write-back modified internal register
PhyWrite (PortNo, 31, 0); // Select main register page
```

**Note** It is not important which order is used for writes to the SMI register with respect to writes to Register 0, which disable and enable the auto-negotiation feature.

## 8.4 Default 10Base-T Settings Are Marginal and Cause MAU Test Failure

Issue: Default 10Base-T settings are marginal for PHY silicon and magnetic module variations.

Implications: It often causes the output 10Base-T signal to violate the IEEE waveform templates.

Workaround: During device initialization, use the following script. For more information, see *PHY API Software and Programmers Guide*, which is available on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

```
PhyWrite (PortNo, reg_num(dec), 16_bit_unsigned_data(hex))
PhyRead (PortNo, reg_num(dec))
~ -- Logical NOT
& -- Logical AND
| -- Logical OR
= -- Assign value to variable

PhyWrite (PortNo, 31, 0x52b5); // Select internal register page
PhyWrite (PortNo, 18, 0x9e); // Necessary write of internal register
PhyWrite (PortNo, 17, 0xdd39); // Necessary write of internal register
PhyWrite (PortNo, 16, 0x87aa); // Necessary write of internal register
PhyWrite (PortNo, 16, 0xa7b4); // Necessary write of internal register
reg = PhyRead (PortNo, 18); // Read internal reg. and assign it to var.
PhyWrite (PortNo, 18, reg); // Necessary write of internal register

reg = PhyRead (PortNo, 17); // Read internal reg. and assign it to var.
reg = (reg & ~0x003f) | 0x003c; // Modify variable value
PhyWrite (PortNo, 17, reg); // Write back modified internal register
```

```
PhyWrite (PortNo, 16, 0x87b4); // Necessary write of internal register
PhyWrite (PortNo, 16, 0xa794); // Necessary write of internal register
reg = PhyRead (PortNo, 18); // Read internal reg. and assign it to var.
PhyWrite (PortNo, 18, reg); // Necessary write of internal register

reg = PhyRead (PortNo, 17); // Read internal reg. and assign it to var.
reg = (reg & ~0x003f) | 0x003e; // Modify variable value
PhyWrite (PortNo, 17, reg); // Write back modified internal register

PhyWrite (PortNo, 16, 0x8794); // Necessary write of internal register
PhyWrite (PortNo, 18, 0xf7); // Necessary write of internal register
PhyWrite (PortNo, 17, 0xbe36); // Necessary write of internal register
PhyWrite (PortNo, 16, 0x879e); // Necessary write of internal register
PhyWrite (PortNo, 16, 0xa7a0); // Necessary write of internal register
reg = PhyRead (PortNo, 18); // Read internal reg. and assign it to var.
PhyWrite (PortNo, 18, reg); // Necessary write of internal register

reg = PhyRead (PortNo, 17); // Read internal reg. and assign it to var.
reg = (reg & ~0x003f) | 0x0034; // Modify variable value
PhyWrite (PortNo, 17, reg); // Write back modified internal register

PhyWrite (PortNo, 16, 0x87a0); // Necessary write of internal register

PhyWrite (PortNo, 18, 0x3c); // Necessary write of internal register
PhyWrite (PortNo, 17, 0xf3cf); // Necessary write of internal register
PhyWrite (PortNo, 16, 0x87a2); // Necessary write of internal register

PhyWrite (PortNo, 18, 0x3c); // Necessary write of internal register
PhyWrite (PortNo, 17, 0xf3cf); // Necessary write of internal register
PhyWrite (PortNo, 16, 0x87a4); // Necessary write of internal register

PhyWrite (PortNo, 18, 0x3c); // Necessary write of internal register
PhyWrite (PortNo, 17, 0xd287); // Necessary write of internal register
PhyWrite (PortNo, 16, 0x87a6); // Necessary write of internal register

PhyWrite (PortNo, 16, 0xa7a8); // Necessary write of internal register
reg = PhyRead (PortNo, 18); // Read internal reg. and assign it to var.
PhyWrite (PortNo, 18, reg); // Necessary write of internal register

reg = PhyRead (PortNo, 17); // Read internal reg. and assign it to var.
reg = (reg & ~0x0fff) | 0x0125; // Modify variable value
PhyWrite (PortNo, 17, reg); // Write back modified internal register

PhyWrite (PortNo, 16, 0x87a8); // Necessary write of internal register

PhyWrite (PortNo, 31, 0); // Select main register page
```

## 8.5 On-Chip Pull-up Resistor Violation

**Issue:** According to the IEEE standard 802.3, the MDIO pin on a slave device should be an open-drain pad type and drive a low value onto the MDIO shared bus. The MDIO shared bus should be pulled high with a pull-up resistor on the PCB or SMI bus master. The VSC8641 device includes a 100 k $\Omega$  pull-up on-chip resistor that violates this IEEE specification.

**Implication:** The VSC8641 device requires an off-chip and on-chip pull-up resistor for the interface to operate correctly. The typical value of the off-chip resistor is relatively small at <1 k $\Omega$ , which maintains a short rise time of the MDIO signal. Adding a 100 k $\Omega$  pull-up on-chip resistor in parallel with the off-chip pull-up resistor, does not have any practical implications.

**Workaround:** No workaround is needed.

## 8.6 Setting the Internal RGMII Timing Compensation Value

**Issue:** There are two inter-related registers to control the internal RGMII skew timing compensation. The finest level of control is through register 28E.15:12, which has four settings (0 ns, 1.4 ns, 1.7 ns, and 2.0 ns) for either Rx or Tx. Alternatively, register 23.8 provides a simpler level of control (0 ns or 1.7 ns for both Rx and Tx) for compatibility with legacy Vitesse PHY software. A write to either register automatically affects the other so that they are logically consistent. However, this relationship means the legacy control of register 23.8 can potentially overwrite the finer-level controls in register 28E.

**Implication:** If you intend to use the skew compensation settings in 28E, always write to this register after, not before, a write to register 23. For example, suppose register 23.8 is set to 1 (1.7 ns) and then register 28E.15:12 is set to 0101 (1.4 ns); the resulting delay is 1.4 ns. A subsequent write to register 23, even if bit 8 is kept as 1, automatically changes register 28E to 1010 (1.7 ns).

**Workaround:** Before performing a write to register 23, first read and store the settings in register 28E. After writing to register 23, write the stored value back to register 28E.

## 8.7 10BASE-T Harmonics at 30 MHz and 50 MHz Marginally Violate Specification

**Issue:** The IEEE 802.3 specification states that in 10BASE-T mode, when the DO circuit is driven by an all-ones, Manchester-encoded signal, any harmonic measured on the TD circuit must be at least 27 dB below the fundamental. In VSC8641, this specification is marginally violated at 30 MHz and 50 MHz when this measurement is made under corner conditions. Under nominal conditions, this measurement meets the IEEE specification limits.

**Implications:** This violation has no practical implication on the performance of the device. 10BASE-T mode has been validated to work without any issues with cables far exceeding the IEEE-specified, worst-case limits.

**Workaround:** None required.

## 8.8 Voltage Overshoot When Using On-Chip Switching Regulator

**Issue:** The device's on-chip switching regulator generates notable voltage overshoot.

**Implications:** The voltage overshoot from the on-chip switching regulator may lead to device performance issues such as CRC errors, jitter, or both.

**Workaround:** When using the on-chip regulator, dampen the overshoot by adding a snubber circuit on the output of the regulator pins (REG\_OUT). This circuit consists of a 15  $\Omega$  resistor and 0.001  $\mu$ F capacitor connected in series to the REG\_OUT pins and ground. For more information about the regulator circuitry connection, see *VSC8641 Design and Layout Guide*, which is available on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

## 8.9 Long Link-Up Times Caused by Noise on the Twisted Pair Interface

**Issue:** The VSC8641 may experience longer link-up times during the link-up auto-negotiation process when there is signal noise coming from the link partner on the other side of a cable.

**Implications:** Normally, the VSC8641 device successfully links during auto-negotiation when there is signal noise coming from the link partner. However, on rare occasions when the VSC8641 device uses the same cable as the link partner, the link-up time can be significantly increased for successful auto-negotiation.

**Workaround:** During device initialization, it is strongly recommended that the following software script is implemented. For more information, see *PHY API Software and Programmers Guide*, which is available on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

```
PhyWrite (PortNo, reg_num(dec), 16_bit_unsigned_data(hex))
PhyRead (PortNo, reg_num(dec))
~ -- Logical NOT
& -- Logical AND
```

```
| -- Logical OR
= -- Assign value to variable

PHY_Write (PortNo, 31, 0x52b5); // Select internal register page
PHY_Write (PortNo, 16, 0xa7fa); // Necessary write of internal register
reg = PHY_Read (PortNo, 18); // Read internal register and assign it to
var.
PHY_Write (PortNo, 18, reg); // Necessary write of internal register
reg = PHY_Read (PortNo, 17); // Read internal register and assign it to
var.
reg = (reg | 0x0008); // Modify variable value
PHY_Write (PortNo, 17, reg); // Write back modified internal register
PHY_Write (PortNo, 16, 0x87fa) // Necessary write of internal register
PHY_Write (PortNo, 31, 0x0000); // Select main register page
```

## 8.10 High VDD33 and Low VDDIOMAC Supply

Issue: If VDD33 is set to the maximum allowed 3.3 V supply and VDDIOMAC is set to the minimum allowed 3.3 V supply, the VSC8641 device can experience performance issues. This issue generally occurs in a lab environment and not in typical applications.

Implications: When VDDIOMAC is set to 3.3 V, VDD33 and VDDIOMAC cannot be sourced by two different 3.3 V supplies.

Workaround: If using VDDIOMAC in 3.3 V mode, use the same 3.3 V source supply as the VDD33, using a proper filtering scheme. For more information, see *VSC8641 Design and Layout Guide*, which is available on the Vitesse Web site at [www.vitesse.com](http://www.vitesse.com).

## 9 Ordering Information

The VSC8641 device is offered with two operating temperature ranges. The range for VSC8641 is 0 °C ambient to 90 °C case, and the range for VSC8641-03 is –40 °C ambient to 90 °C case.

The VSC8641 device is available in two package types. VSC8641XJF is a lead(Pb)-free, 88-pin, plastic quad flat no-lead (QFN) package with an exposed pad, 10 mm × 10 mm body size, 0.4 mm pin pitch, and 0.9 mm maximum height. VSC8641XKO and VSC8641XKO-03 are packaged in a 100-pin, plastic low-profile quad flat package (LQFP) with an exposed pad, 12 mm × 12 mm body size, 1.4 mm body thickness, 0.4 mm pin pitch, and 1.6 mm maximum height.

Lead(Pb)-free products from Vitesse comply with the temperatures and profiles defined in the joint IPC and JEDEC standard IPC/JEDEC J-STD-020. For more information, see the IPC and JEDEC standard.

The following table lists the ordering information for the VSC8641 devices.

**Table 98. Ordering Information**

| Part Order Number | Description                                                                                                                                                                                                       |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VSC8641XJF        | Lead(Pb)-free, 88-pin, plastic QFN with an exposed pad, 10 mm × 10 mm body size, 0.4 mm pin pitch, and 0.9 mm maximum height. The operating temperature is 0 °C ambient to 90 °C case.                            |
| VSC8641XKO        | Lead(Pb)-free, 100-pin, plastic LQFP with an exposed pad, 12 mm × 12 mm body size, 1.4 mm body thickness, 0.4 mm pin pitch, and 1.6 mm maximum height. The operating temperature is 0 °C ambient to 90 °C case.   |
| VSC8641XKO-03     | Lead(Pb)-free, 100-pin, plastic LQFP with an exposed pad, 12 mm × 12 mm body size, 1.4 mm body thickness, 0.4 mm pin pitch, and 1.6 mm maximum height. The operating temperature is –40 °C ambient to 90 °C case. |